# Am186™ED/EDLV

# High Performance, 80C186- and 80C188-Compatible, 16-Bit Embedded Microcontrollers

## DISTINCTIVE CHARACTERISTICS

- E86<sup>™</sup> family 80C186- and 80C188-compatible microcontroller with enhanced bus interface
  - Lower system cost with higher performance
  - 3.3-V ± 0.3-V operation (Am186EDLV microcontrollers)
- Programmable DRAM Controller
  - Supports zero-wait-state operation with 50-ns DRAM at 40 MHz, 60-ns @ 33 MHz, 70-ns @ 25 MHz
  - Includes programmable CAS-before-RAS refresh capability
- High performance
  - 20-, 25-, 33-, and 40-MHz operating frequencies
  - Zero-wait-state operation at 40 MHz with 70-ns static memory
  - 1-Mbyte memory address space
  - 64-Kbyte I/O space
- Enhanced features provide improved memory access and remove the requirement for a 2x clock input
  - Nonmultiplexed address bus
  - Processor operates at the clock input frequency
  - 8-bit or 16-bit programmable bus sizing including 8-bit boot option
- Enhanced integrated peripherals
  - 32 programmable I/O (PIO) pins
  - Two full-featured asynchronous serial ports allow full-duplex, 7-bit, 8-bit, or 9-bit data transfers

- Serial port hardware handshaking with CTS, RTS, ENRX, and RTR selectable for each port
- Improved serial port operation enhances 9-bit DMA support
- Independent serial port baud rate generators
- DMA to and from the serial ports
- Watchdog timer can generate NMI or reset
- A pulse-width demodulation option
- A data strobe, true asynchronous bus interface option included for DEN
- Reset configuration register
- Familiar 80C186 peripherals
  - Two independent DMA channels
  - Programmable interrupt controller with up to 8 external and 8 internal interrupts
  - Three programmable 16-bit timers
  - Programmable memory and peripheral chip-select logic
  - Programmable wait state generator
  - Power-save clock divider
  - Software-compatible with the 80C186 and 80C188 microcontrollers with widely available native development tools, applications, and system software
- A compatible evolution of the Am186EM, Am186ES, and Am186ER microcontrollers
  - Available in the following packages:
  - 100-pin, thin quad flat pack (TQFP)
  - 100-pin, plastic quad flat pack (PQFP)

## **GENERAL DESCRIPTION**

The Am186<sup>™</sup>ED/EDLV microcontrollers are part of the AMD E86<sup>™</sup> family of embedded microcontrollers and microprocessors based on the x86 architecture. The Am186ED/EDLV microcontrollers are the ideal upgrade for 80C186/188 designs requiring 80C186/188 compatibility, increased performance, serial communications, a direct bus interface, and more than 64K of memory.

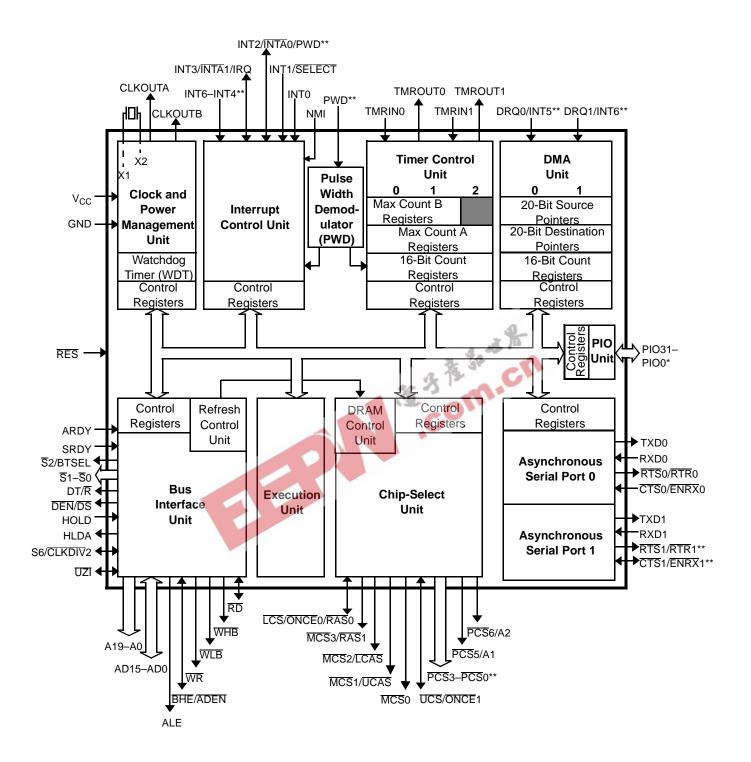
The Am186ED/EDLV microcontrollers integrate a complete DRAM controller to take advantage of low DRAM costs. This reduces memory subsystem costs while maintaining SRAM performance.The Am186ED/EDLV microcontrollers also integrate the functions of a CPU, nonmultiplexed address bus, three timers, watchdog timer, chip selects, interrupt controller, two DMA controllers, two asynchronous serial ports, programmable bus sizing, and programmable I/O (PIO) pins on one chip. Compared to the 80C186/188 microcontrollers, the Am186ED/EDLV microcontrollers enable designers to reduce the size, power consumption, and cost of embedded systems, while increasing reliability, functionality, and performance.

The Am186ED/EDLV microcontrollers have been designed to meet the most common requirements of embedded products developed for the communications, office automation, mass storage, and general embedded markets. Specific applications include PBXs, multiplexers, modems, disk drives, hand-held and desktop terminals, fax machines, printers, photocopiers, and industrial controls.

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## Am186ED/EDLV MICROCONTROLLERS BLOCK DIAGRAM



#### Notes:

\*All PIO signals are shared with other physical pins. See the pin descriptions beginning on page 21 and Table 2 on page 29 for information on shared functions.

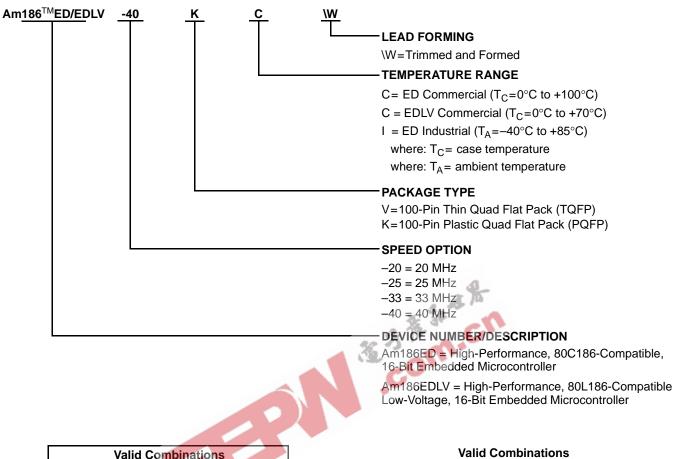
\*\* RTS1/RTR1 and CTS1/ENRX1 are multiplexed with PCS3 and PCS2, respectively. See the pin descriptions beginning on page 21.



### **ORDERING INFORMATION**

### **Standard Products**

AMD standard products are available in several packages and operating ranges. The order number (valid combination) is formed by a combination of the elements below.



Valid Combina	ations
Am186ED-20 Am186ED-25 Am186ED-33 Am186ED-40	VC\W or KC\W
Am186ED–20 Am186ED–25	KI\W <sup>1</sup>
Am186EDLV–20 Am186EDLV–25	VC\W or KC\W

#### Note:

The industrial version of the Am186ED is offered only in the PQFP package.

Valid combinations list configurations planned to be supported in volume for this device. Consult the local AMD sales office to confirm availability of specific valid combinations and to check on newly released combinations.

Note: The industrial version of the Am186ED as well as the Am186EDLV are available in 20 and 25 MHz operating frequencies only.

The Am186ED and Am186EDLV microcontrollers are all functionally the same except for their DC characteristics and available frequencies.

Note: There is no 188 version of the Am186ED/ EDLV. The same 8-bit external bus capabilities can be achieved using the 8-bit boot capability and programmable bus sizing options.

## TABLE OF CONTENTS

GENERAL DESCRIPTION       1         AM186ED/EDLV MICROCONTROLLERS BLOCK DIAGRAM       2         ORDERING INFORMATION       3         Standard Products       3         RELATED AMD PRODUCTS       9         E86™ Family Devices       9         Related Documents       10         Third-Party Development Support Products       10         Customer Service       10         KEY FEATURES AND BENEFITS       10         Application Considerations       11         COMPARING THE AM186ED/EDLV TO THE AM186ES/ESLV MICROCONTROLLERS       12         Integrated DRAM Controller       12         Integrated DRAM Controller       13         Option to Overlap DRAM with PCS       13         Additional Serial Port Mode for DMA Support of 9-bit Protocols       13         Option to Boot from 8- or 16-bit Memory       13         Improved External Bus Master Support       13         PSRAM Controller Removed       13         TQFP CONNECTION DIAGRAMS AND PINOUTS       14         TQFP PIN DESIGNATIONS       15         Sorted by Pin Number       15         Sorted by Pin Name       16         PQFP CONNECTION DIAGRAMS AND PINOUTS       17         Top Side View—100-Pin Plastic Quad Flat Pack (PQ
ORDERING INFORMATION       3         Standard Products       3         RELATED AMD PRODUCTS       9         Rélated Documents       10         Third-Party Development Support Products       10         Customer Service       10         KEY FEATURES AND BENEFITS       10         Application Considerations       11         COMPARING THE AM186ED/EDLV TO THE AM186ES/ESLV MICROCONTROLLERS       12         Integrated DRAM Controller       12         Enhanced Refresh Control Unit       13         Option to Overlap DRAM with PCS       13         Additional Serial Port Mode for DMA Support of 9-bit Protocols       13         Option to Boot from 8- or 16-bit Memory       13         Improved External Bus Master Support       13         PSRAM Controller Removed       13         TQFP CONNECTION DIAGRAMS AND PINOUTS       14         TQFP PIN DESIGNATIONS       15         Sorted by Pin Name       16         PQFP CONNECTION DIAGRAMS AND PINOUTS       17         Top Side View—100-Pin Thin Quad Flat Pack (PQFP)       17         Top Side View—100-Pin Plastic Quad Flat Pack (PQFP)       17         PQFP PIN DESIGNATIONS       18         Sorted by Pin Number       18         Sor
Standard Products       3         RELATED AMD PRODUCTS       9         E86™ Family Devices       9         Related Documents       10         Third-Party Development Support Products       10         Customer Service       10         KEY FEATURES AND BENEFITS       10         Application Considerations       11         COMPARING THE AM186ED/EDLV TO THE AM186ES/ESLV MICROCONTROLLERS       12         Integrated DRAM Controller       12         Enhanced Refresh Control Unit       13         Option to Overlap DRAM with PCS       13         Additional Serial Port Mode for DMA Support of 9-bit Protocols       13         Option to Boot from 8- or 16-bit Memory       13         Improved External Bus Master Support       13         PSRAM Controller Removed       13         TQFP CONNECTION DIAGRAMS AND PINOUTS       14         TQFP PIN DESIGNATIONS       15         Sorted by Pin Number       15         Sorted by Pin Name       16         PQFP PIN DESIGNATIONS       17         Top Side View—100-Pin Plastic Quad Flat Pack (PQFP)       17         PQFP PIN DESIGNATIONS       18         Sorted by Pin Number       18         Sorted by Pin Number       18
RELATED AMD PRODUCTS       9         E86 <sup>™</sup> Family Devices       9         Related Documents       10         Third-Party Development Support Products       10         Customer Service       10         KEY FEATURES AND BENEFITS       10         Application Considerations       11         COMPARING THE AM186ED/EDLV TO THE AM186ES/ESLV MICROCONTROLLERS       12         Integrated DRAM Controller       12         Enhanced Refresh Control Unit       13         Option to Overlap DRAM with PCS       13         Additional Serial Port Mode for DMA Support of 9-bit Protocols       13         Option to Boot from 8- or 16-bit Memory       13         Improved External Bus Master Support       13         PSRAM Controller Removed       13         TQFP CONNECTION DIAGRAMS AND PINOUTS       14         Top Side View—100-Pin Thin Quad Flat Pack (TQFP)       14         TQFP PIN DESIGNATIONS       15         Sorted by Pin Name       16         PQFP CONNECTION DIAGRAMS AND PINOUTS       17         Top Side View—100-Pin Plastic Quad Flat Pack (PQFP)       17         Top Side View—100-Pin Plastic Quad Flat Pack (PQFP)       17         PQFP PIN DESIGNATIONS       18         Sorted by Pin Number       18 </td
E86 <sup>™</sup> Family Devices       9         Related Documents       10         Third-Party Development Support Products       10         Customer Service       10         KEY FEATURES AND BENEFITS       10         Application Considerations       11         COMPARING THE AM186ED/EDLV TO THE AM186ES/ESLV MICROCONTROLLERS       12         Integrated DRAM Controller       12         Enhanced Refresh Control Unit       13         Option to Overlap DRAM with PCS       13         Additional Serial Port Mode for DMA Support of 9-bit Protocols       13         Option to Boot from 8- or 16-bit Memory       13         Improved External Bus Master Support       13         PSRAM Controller Removed       13         TQFP CONNECTION DIAGRAMS AND PINOUTS       14         TQFP PIN DESIGNATIONS       15         Sorted by Pin Name       16         PQFP CONNECTION DIAGRAMS AND PINOUTS       17         Top Side View—100-Pin Plastic Quad Flat Pack (PQFP)       17         PQFP PIN DESIGNATIONS       18         Sorted by Pin Number
Related Documents       10         Third-Party Development Support Products       10         Customer Service       10         KEY FEATURES AND BENEFITS       10         Application Considerations       11         COMPARING THE AM186ED/EDLV TO THE AM186ES/ESLV MICROCONTROLLERS       12         Integrated DRAM Controller       12         Enhanced Refresh Control Unit       13         Option to Overlap DRAM with PCS       13         Additional Serial Port Mode for DMA Support of 9-bit Protocols       13         Option to Boot from 8- or 16-bit Memory       13         Improved External Bus Master Support       13         PSRAM Controller Removed       13         TQFP CONNECTION DIAGRAMS AND PINOUTS       14         Top Side View—100-Pin Thin Quad Flat Pack (TQFP)       14         TQFP CONNECTION DIAGRAMS AND PINOUTS       15         Sorted by Pin Number       15         Sorted by Pin Name       16         PQFP CONNECTION DIAGRAMS AND PINOUTS       17         Top Side View—100-Pin Plastic Quad Flat Pack (PQFP)       17         PQFP PIN DESIGNATIONS       18         Sorted by Pin Number       18         Sorted by Pin Number       18         Sorted by Pin Number       18
Related Documents       10         Third-Party Development Support Products       10         Customer Service       10         KEY FEATURES AND BENEFITS       10         Application Considerations       11         COMPARING THE AM186ED/EDLV TO THE AM186ES/ESLV MICROCONTROLLERS       12         Integrated DRAM Controller       12         Enhanced Refresh Control Unit       13         Option to Overlap DRAM with PCS       13         Additional Serial Port Mode for DMA Support of 9-bit Protocols       13         Option to Boot from 8- or 16-bit Memory       13         Improved External Bus Master Support       13         PSRAM Controller Removed       13         TQFP CONNECTION DIAGRAMS AND PINOUTS       14         Top Side View—100-Pin Thin Quad Flat Pack (TQFP)       14         TQFP CONNECTION DIAGRAMS AND PINOUTS       15         Sorted by Pin Number       15         Sorted by Pin Name       16         PQFP CONNECTION DIAGRAMS AND PINOUTS       17         Top Side View—100-Pin Plastic Quad Flat Pack (PQFP)       17         PQFP PIN DESIGNATIONS       18         Sorted by Pin Number       18         Sorted by Pin Number       18         Sorted by Pin Number       18
Third-Party Development Support Products       10         Customer Service       10         KEY FEATURES AND BENEFITS       10         Application Considerations       11         COMPARING THE AM186ED/EDLV TO THE AM186ES/ESLV MICROCONTROLLERS       12         Integrated DRAM Controller       12         Enhanced Refresh Control Unit       13         Option to Overlap DRAM with PCS       13         Additional Serial Port Mode for DMA Support of 9-bit Protocols       13         Option to Boot from 8- or 16-bit Memory       13         Improved External Bus Master Support       13         PSRAM Controller Removed       13         TQFP CONNECTION DIAGRAMS AND PINOUTS       14         TQFP PIN DESIGNATIONS       15         Sorted by Pin Number       15         Sorted by Pin Name       16         PQFP CONNECTION DIAGRAMS AND PINOUTS       17         Top Side View—100-Pin Flastic Quad Flat Pack (PQFP)       17         Top Side View—100-Pin Plastic Quad Flat Pack (PQFP)       17         PQFP PIN DESIGNATIONS       18         Sorted by Pin Number       18         Sorted by Pin Number       18         Sorted by Pin Number       18         Sorted by Pin Name       19 </td
Customer Service       10         KEY FEATURES AND BENEFITS       10         Application Considerations       11         COMPARING THE AM186ED/EDLV TO THE AM186ES/ESLV MICROCONTROLLERS       12         Integrated DRAM Controller       12         Enhanced Refresh Control Unit       13         Option to Overlap DRAM with PCS       13         Additional Serial Port Mode for DMA Support of 9-bit Protocols       13         Option to Boot from 8- or 16-bit Memory       13         Improved External Bus Master Support       13         PSRAM Controller Removed       13         TQFP CONNECTION DIAGRAMS AND PINOUTS       14         Top Side View—100-Pin Thin Quad Flat Pack (TQFP)       14         TQFP CONNECTION DIAGRAMS AND PINOUTS       15         Sorted by Pin Number       15         Sorted by Pin Number       16         PQFP CONNECTION DIAGRAMS AND PINOUTS       17         Top Side View—100-Pin Plastic Quad Flat Pack (PQFP)       17         Top Side View—100-Pin Plastic Quad Flat Pack (PQFP)       17         PQFP PIN DESIGNATIONS       18         Sorted by Pin Number       18         Sorted by Pin Number       18         Sorted by Pin Number       18         Sorted by Pin Name       19
KEY FEATURES AND BENEFITS       10         Application Considerations       11         COMPARING THE AM186ED/EDLV TO THE AM186ES/ESLV MICROCONTROLLERS       12         Integrated DRAM Controller       12         Enhanced Refresh Control Unit       13         Option to Overlap DRAM with PCS       13         Additional Serial Port Mode for DMA Support of 9-bit Protocols       13         Option to Boot from 8- or 16-bit Memory       13         Improved External Bus Master Support       13         PSRAM Controller Removed       13         TQFP CONNECTION DIAGRAMS AND PINOUTS       14         Top Side View—100-Pin Thin Quad Flat Pack (TQFP)       14         TQFP PIN DESIGNATIONS       15         Sorted by Pin Number       15         Sorted by Pin Name       16         PQFP CONNECTION DIAGRAMS AND PINOUTS       17         Top Side View—100-Pin Plastic Quad Flat Pack (PQFP)       17         PQFP PIN DESIGNATIONS       18         Sorted by Pin Number       18         Sorted by Pin Number       18         Sorted by Pin Name       18
Application Considerations       11         COMPARING THE AM186ED/EDLV TO THE AM186ES/ESLV MICROCONTROLLERS       12         Integrated DRAM Controller       12         Enhanced Refresh Control Unit       13         Option to Overlap DRAM with PCS       13         Additional Serial Port Mode for DMA Support of 9-bit Protocols       13         Option to Boot from 8- or 16-bit Memory       13         Improved External Bus Master Support       13         PSRAM Controller Removed       13         TQFP CONNECTION DIAGRAMS AND PINOUTS       14         Top Side View—100-Pin Thin Quad Flat Pack (TQFP)       14         TQFP PIN DESIGNATIONS       15         Sorted by Pin Number       15         Sorted by Pin Name       16         PQFP CONNECTION DIAGRAMS AND PINOUTS       17         Top Side View—100-Pin Thin Quad Flat Pack (PQFP)       17         PQFP PIN DESIGNATIONS       17         Sorted by Pin Name       18         Sorted by Pin Number       18         Sorted by Pin Number       18         Sorted by Pin Name       18
COMPARING THE AM186ED/EDLV TO THE AM186ES/ESLV MICROCONTROLLERS       12         Integrated DRAM Controller       12         Enhanced Refresh Control Unit       13         Option to Overlap DRAM with PCS       13         Additional Serial Port Mode for DMA Support of 9-bit Protocols       13         Option to Boot from 8- or 16-bit Memory       13         Improved External Bus Master Support       13         PSRAM Controller Removed       13         TQFP CONNECTION DIAGRAMS AND PINOUTS       14         Top Side View—100-Pin Thin Quad Flat Pack (TQFP)       14         TQFP CONNECTION DIAGRAMS AND PINOUTS       15         Sorted by Pin Number       15         Sorted by Pin Number       16         PQFP CONNECTION DIAGRAMS AND PINOUTS       17         Top Side View—100-Pin Plastic Quad Flat Pack (PQFP)       17         PQFP PIN DESIGNATIONS       17         Top Side View—100-Pin Plastic Quad Flat Pack (PQFP)       17         PQFP PIN DESIGNATIONS       18         Sorted by Pin Number       18         Sorted by Pin Number       18         Sorted by Pin Name       19
Integrated DRAM Controller12Enhanced Refresh Control Unit13Option to Overlap DRAM with PCS13Additional Serial Port Mode for DMA Support of 9-bit Protocols13Option to Boot from 8- or 16-bit Memory13Improved External Bus Master Support13PSRAM Controller Removed13TQFP CONNECTION DIAGRAMS AND PINOUTS14Top Side View—100-Pin Thin Quad Flat Pack (TQFP)14TQFP PIN DESIGNATIONS15Sorted by Pin Number15Sorted by Pin Name16PQFP CONNECTION DIAGRAMS AND PINOUTS17Top Side View—100-Pin Plastic Quad Flat Pack (PQFP)17PQFP PIN DESIGNATIONS18Sorted by Pin Number18Sorted by Pin Name18
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Option to Overlap DRAM with PCS       13         Additional Serial Port Mode for DMA Support of 9-bit Protocols       13         Option to Boot from 8- or 16-bit Memory       13         Improved External Bus Master Support       13         PSRAM Controller Removed       13         TQFP CONNECTION DIAGRAMS AND PINOUTS       14         Top Side View—100-Pin Thin Quad Flat Pack (TQFP)       14         TQFP PIN DESIGNATIONS       15         Sorted by Pin Number       15         Sorted by Pin Name       16         PQFP CONNECTION DIAGRAMS AND PINOUTS       17         Top Side View—100-Pin Thin Quad Flat Pack (PQFP)       17         PQFP PONNECTION DIAGRAMS AND PINOUTS       17         Sorted by Pin Name       16         PQFP PONNECTION DIAGRAMS AND PINOUTS       17         Top Side View—100-Pin Plastic Quad Flat Pack (PQFP)       17         PQFP PIN DESIGNATIONS       18         Sorted by Pin Number       18         Sorted by Pin Number       18         Sorted by Pin Name       19
Additional Serial Port Mode for DMA Support of 9-bit Protocols       13         Option to Boot from 8- or 16-bit Memory       13         Improved External Bus Master Support       13         PSRAM Controller Removed       13         TQFP CONNECTION DIAGRAMS AND PINOUTS       14         Top Side View—100-Pin Thin Quad Flat Pack (TQFP)       14         TQFP PIN DESIGNATIONS       15         Sorted by Pin Number       15         Sorted by Pin Name       16         PQFP CONNECTION DIAGRAMS AND PINOUTS       17         Top Side View—100-Pin Plastic Quad Flat Pack (PQFP)       17         PQFP PIN DESIGNATIONS       18         Sorted by Pin Number       18         Sorted by Pin Name       19
Option to Boot from 8- or 16-bit Memory       13         Improved External Bus Master Support       13         PSRAM Controller Removed       13         TQFP CONNECTION DIAGRAMS AND PINOUTS       14         Top Side View—100-Pin Thin Quad Flat Pack (TQFP)       14         TQFP PIN DESIGNATIONS       15         Sorted by Pin Number       15         Sorted by Pin Name       16         PQFP CONNECTION DIAGRAMS AND PINOUTS       17         Top Side View—100-Pin Plastic Quad Flat Pack (PQFP)       17         PQFP PIN DESIGNATIONS       18         Sorted by Pin Number       18         Sorted by Pin Number       18         Sorted by Pin Number       19
Improved External Bus Master Support       13         PSRAM Controller Removed       13         TQFP CONNECTION DIAGRAMS AND PINOUTS       14         Top Side View—100-Pin Thin Quad Flat Pack (TQFP)       14         TQFP PIN DESIGNATIONS       15         Sorted by Pin Number       15         Sorted by Pin Name       16         PQFP CONNECTION DIAGRAMS AND PINOUTS       17         Top Side View—100-Pin Plastic Quad Flat Pack (PQFP)       17         PQFP PIN DESIGNATIONS       18         Sorted by Pin Number       18         Sorted by Pin Number       18         Sorted by Pin Name       19
PSRAM Controller Removed       13         TQFP CONNECTION DIAGRAMS AND PINOUTS       14         Top Side View—100-Pin Thin Quad Flat Pack (TQFP)       14         TQFP PIN DESIGNATIONS       15         Sorted by Pin Number       15         Sorted by Pin Name       16         PQFP CONNECTION DIAGRAMS AND PINOUTS       17         Top Side View—100-Pin Plastic Quad Flat Pack (PQFP)       17         PQFP PIN DESIGNATIONS       18         Sorted by Pin Number       18         Sorted by Pin Number       18         Sorted by Pin Name       19
TQFP CONNECTION DIAGRAMS AND PINOUTS       14         Top Side View—100-Pin Thin Quad Flat Pack (TQFP)       14         TQFP PIN DESIGNATIONS       15         Sorted by Pin Number       15         Sorted by Pin Name       16         PQFP CONNECTION DIAGRAMS AND PINOUTS       17         Top Side View—100-Pin Plastic Quad Flat Pack (PQFP)       17         PQFP PIN DESIGNATIONS       18         Sorted by Pin Number       18         Sorted by Pin Number       18         Sorted by Pin Name       19
Top Side View—100-Pin Thin Quad Flat Pack (TQFP)       14         TQFP PIN DESIGNATIONS       15         Sorted by Pin Number       15         Sorted by Pin Name       16         PQFP CONNECTION DIAGRAMS AND PINOUTS       17         Top Side View—100-Pin Plastic Quad Flat Pack (PQFP)       17         PQFP PIN DESIGNATIONS       18         Sorted by Pin Number       18         Sorted by Pin Name       19
TQFP PIN DESIGNATIONS       15         Sorted by Pin Number       15         Sorted by Pin Name       16         PQFP CONNECTION DIAGRAMS AND PINOUTS       17         Top Side View—100-Pin Plastic Quad Flat Pack (PQFP)       17         PQFP PIN DESIGNATIONS       18         Sorted by Pin Number       18         Sorted by Pin Name       19
TQFP PIN DESIGNATIONS       15         Sorted by Pin Number       15         Sorted by Pin Name       16         PQFP CONNECTION DIAGRAMS AND PINOUTS       17         Top Side View—100-Pin Plastic Quad Flat Pack (PQFP)       17         PQFP PIN DESIGNATIONS       18         Sorted by Pin Number       18         Sorted by Pin Name       19
Sorted by Pin Name       16         PQFP CONNECTION DIAGRAMS AND PINOUTS       17         Top Side View—100-Pin Plastic Quad Flat Pack (PQFP)       17         PQFP PIN DESIGNATIONS       18         Sorted by Pin Number       18         Sorted by Pin Name       19
Sorted by Pin Name       16         PQFP CONNECTION DIAGRAMS AND PINOUTS       17         Top Side View—100-Pin Plastic Quad Flat Pack (PQFP)       17         PQFP PIN DESIGNATIONS       18         Sorted by Pin Number       18         Sorted by Pin Name       19
PQFP CONNECTION DIAGRAMS AND PINOUTS       17         Top Side View—100-Pin Plastic Quad Flat Pack (PQFP)       17         PQFP PIN DESIGNATIONS       18         Sorted by Pin Number       18         Sorted by Pin Name       19
Top Side View—100-Pin Plastic Quad Flat Pack (PQFP)       17         PQFP PIN DESIGNATIONS       18         Sorted by Pin Number       18         Sorted by Pin Name       19
PQFP PIN DESIGNATIONS
Sorted by Pin Number
Sorted by Pin Name
LOGIC SYMBOL—AM186ED/EDLV MICROCONTROLLERS
PIN DESCRIPTIONS
Pins That Are Used by Emulators
Pin Terminology
A19–A0 (A19/PIO9, A18/PIO8, A17/PIO7)
AD15–AD8
AD 13-AD 8
AD7-AD0
ARDY
CLKOUTA
CLKOUTB
CLKOUTB
CLKOUTB         22           CTS0/ENRX0/PIO21         22           DEN/DS/PIO5         23
CLKOUTB       22         CTS0/ENRX0/PIO21       22         DEN/DS/PIO5       23         DRQ0/INT5/PIO12       23
CLKOUTB       22         CTS0/ENRX0/PIO21       22         DEN/DS/PIO5       23         DRQ0/INT5/PIO12       23         DRQ1/INT6/PIO13       23
CLKOUTB       22         CTS0/ENRX0/PIO21       22         DEN/DS/PIO5       23         DRQ0/INT5/PIO12       23
CLKOUTB       22         CTS0/ENRX0/PIO21       22         DEN/DS/PIO5       23         DRQ0/INT5/PIO12       23         DRQ1/INT6/PIO13       23
CLKOUTB       22         CTS0/ENRX0/PIO21       22         DEN/DS/PIO5       23         DRQ0/INT5/PIO12       23         DRQ1/INT6/PIO13       23         DT/R/PIO4       23
CLKOUTB       22         CTS0/ENRX0/PIO21       22         DEN/DS/PIO5       23         DRQ0/INT5/PIO12       23         DRQ1/INT6/PIO13       23         DT/R/PIO4       23         GND       23
CLKOUTB       22         CTS0/ENRX0/PIO21       22         DEN/DS/PIO5       23         DRQ0/INT5/PIO12       23         DRQ1/INT6/PIO13       23         DT/R/PIO4       23         GND       23         HLDA       23

INT2/INTA0/PWD/PIO31	. 24
INT3/INTA1/IRQ	. 24
INT4/PIO30	. 25
LCS/ONCE0/RAS0	. 25
MCS0/PIO14	. 25
MCS1/UCAS/PIO15	. 25
MCS2/LCAS/PIO24	
MCS3/RAS1/PIO25	. 26
NMI	. 26
PCS1/PIO17, PCS0/PIO16	
PCS2/CTS1/ENRX1/PIO18	
PCS3/RTS1/RTR1/PIO19	
PCS5/A1/PIO3	
PCS6/A2/PIO2	
PIO31–PIO0 (Shared)	
RD	
RES	
RTS0/RTR0/PIO20	
RXD0/PIO23	
RXD1/PIO28	
S2/BTSEL	
S1–S0 S6/CLKDIV2/PIO29	20
50/CLKDIV2/PIO29	. 30
SRDY/PIO6 TMRIN0/PIO11	. 30
TMRIN0/PIOTI	. 31
TMROUT0/PIO10	. 31
TMROUT0/PIO10 TMROUT1/PIO1	. 31 . 31
TMROUT0/PIO10 TMROUT1/PIO1 TXD0/PIO22	. 31 . 31 . 31
TMROUT0/PIO10 TMROUT1/PIO1 TXD0/PIO22 TXD1/PIO27	. 31 . 31 . 31 . 31
TMROUT0/PIO10 TMROUT1/PIO1 TXD0/PIO22 TXD1/PIO27 UCS/ONCE1	. 31 . 31 . 31 . 31 . 31 . 31
TMROUT0/PIO10 TMROUT1/PIO1 TXD0/PIO22 TXD1/PIO27 UCS/ONCE1 UZI/PIO26	. 31 . 31 . 31 . 31 . 31 . 31 . 31
TMROUT0/PI010         TMROUT1/PI01         TXD0/PI022         TXD1/PI027         UCS/ONCE1         UZI/PI026         V <sub>CC</sub>	. 31 . 31 . 31 . 31 . 31 . 31 . 31 . 31
TMROUT0/PIO10         TMROUT1/PIO1         TXD0/PIO22         TXD1/PIO27         UCS/ONCE1         UZI/PIO26         V <sub>CC</sub> WHB	. 31 . 31 . 31 . 31 . 31 . 31 . 31 . 31
TMROUT0/PIO10         TMROUT1/PIO1         TXD0/PIO22         TXD1/PIO27         UCS/ONCE1         UZI/PIO26         V <sub>CC</sub> WHB         WLB	. 31 . 31 . 31 . 31 . 31 . 31 . 31 . 31
TMROUT0/PI010         TMROUT1/PI01         TXD0/PI022         TXD1/PI027         UCS/ONCE1         UZI/PI026         V <sub>CC</sub> WHB         WLB         WR	. 31 . 31 . 31 . 31 . 31 . 31 . 31 . 31
TMROUT0/PI010         TMROUT1/PI01         TXD0/PI022         TXD1/PI027         UCS/ONCE1         UZI/PI026         V <sub>CC</sub> WHB         WLB         WR         X1	. 31 . 31 . 31 . 31 . 31 . 31 . 31 . 31
TMROUT0/PIO10         TMROUT1/PIO1         TXD0/PIO22         TXD1/PIO27         UCS/ONCE1         UZI/PIO26         V <sub>CC</sub> WHB         WLB         WR         X1         X2	. 31 . 31 . 31 . 31 . 31 . 31 . 31 . 31
TMROUT0/PIO10         TMROUT1/PIO1         TXD0/PIO22         TXD1/PIO27         UCS/ONCE1         UZI/PIO26         V <sub>CC</sub> WHB         WLB         WR         X1         X2         FUNCTIONAL DESCRIPTION	. 31 . 31 . 31 . 31 . 31 . 31 . 31 . 31
TMROUT0/PI010         TMROUT1/PI01         TXD0/PI022         TXD1/PI027         UCS/ONCE1         UZI/PI026         V <sub>CC</sub> WHB         WLB         WR         X1         X2         FUNCTIONAL DESCRIPTION         Memory Organization	. 31 . 31 . 31 . 31 . 31 . 31 . 31 . 31
TMROUT0/PI010         TMROUT1/PI01         TXD0/PI022         TXD1/PI027         UCS/ONCE1         UZI/PI026         V <sub>CC</sub> WHB         WLB         WR         X1         X2         FUNCTIONAL DESCRIPTION         Memory Organization         I/O Space	. 31 . 31 . 31 . 31 . 31 . 31 . 31 . 31
TMROUT0/PI010         TMROUT1/PI01         TXD0/PI022         TXD1/PI027         UCS/ONCE1         UZI/PI026         V <sub>CC</sub> WHB         WLB         WR         X1         X2         FUNCTIONAL DESCRIPTION         Memory Organization         I/O Space         BUS OPERATION	. 31 . 31 . 31 . 31 . 31 . 31 . 31 . 31
TMROUT0/PI010         TMROUT1/PI01         TXD0/PI022         TXD1/PI027         UCS/ONCE1         UZI/PI026         V <sub>CC</sub> WHB         WLB         WR         X1         X2         FUNCTIONAL DESCRIPTION         Memory Organization         I/O Space         BUS OPERATION         BUS INTERFACE UNIT	. 31 . 31 . 31 . 31 . 31 . 31 . 31 . 31
TMROUT0/PI010         TMROUT1/PI01         TXD0/PI022         TXD1/PI027         UCS/ONCE1         UZI/PI026         V <sub>CC</sub> WHB         WLB         WR         X1         X2         FUNCTIONAL DESCRIPTION         Memory Organization         I/O Space         BUS OPERATION         BUS INTERFACE UNIT         Nonmultiplexed Address Bus	$\begin{array}{c} . \ 31 \\ . \ 31 \\ . \ 31 \\ . \ 31 \\ . \ 31 \\ . \ 31 \\ . \ 31 \\ . \ 31 \\ . \ 31 \\ . \ 31 \\ . \ 32 \\ . \ 32 \\ . \ 32 \\ . \ 32 \\ . \ 32 \\ . \ 33 \\ . \ 33 \\ . \ 33 \\ . \ 34 \\ . \ 36 \\ . \ 36 \end{array}$
TMROUT0/PI010 TMROUT1/PI01 TXD0/PI022 TXD1/PI027 UCS/ONCE1 UZI/PI026 V <sub>CC</sub> WHB WLB WLB WR X1 X2 FUNCTIONAL DESCRIPTION Memory Organization I/O Space BUS OPERATION BUS INTERFACE UNIT Nonmultiplexed Address Bus DRAM Address Multiplexing	$\begin{array}{c} . \ 31 \\ . \ 31 \\ . \ 31 \\ . \ 31 \\ . \ 31 \\ . \ 31 \\ . \ 31 \\ . \ 31 \\ . \ 31 \\ . \ 31 \\ . \ 31 \\ . \ 32 \\ . \ 32 \\ . \ 32 \\ . \ 32 \\ . \ 33 \\ . \ 33 \\ . \ 33 \\ . \ 34 \\ . \ 36 \\ . \ 36 \\ . \ 36 \end{array}$
TMROUT0/PI010 TMROUT1/PI01 TXD0/PI022 TXD1/PI027 UCS/ONCE1 UZI/PI026 V <sub>CC</sub> WHB WLB WLB WR X1 X2 FUNCTIONAL DESCRIPTION Memory Organization I/O Space BUS OPERATION BUS INTERFACE UNIT Nonmultiplexed Address Bus DRAM Address Multiplexing Programmable Bus Sizing	$\begin{array}{c} . \ 31 \\ . \ 31 \\ . \ 31 \\ . \ 31 \\ . \ 31 \\ . \ 31 \\ . \ 31 \\ . \ 31 \\ . \ 31 \\ . \ 31 \\ . \ 31 \\ . \ 31 \\ . \ 31 \\ . \ 32 \\ . \ 32 \\ . \ 32 \\ . \ 32 \\ . \ 32 \\ . \ 32 \\ . \ 33 \\ . \ 33 \\ . \ 33 \\ . \ 34 \\ . \ 36 \\ . \ 36 \\ . \ 37 \end{array}$
TMROUT0/PI010 TMROUT1/PI01 TXD0/PI022 TXD1/PI027 UCS/ONCE1 UZI/PI026 V <sub>CC</sub> WHB WLB WR X1 X2 FUNCTIONAL DESCRIPTION Memory Organization I/O Space BUS OPERATION BUS INTERFACE UNIT Nonmultiplexed Address Bus DRAM Address Multiplexing Programmable Bus Sizing Byte-Write Enables	$\begin{array}{c} . \ 31 \\ . \ 31 \\ . \ 31 \\ . \ 31 \\ . \ 31 \\ . \ 31 \\ . \ 31 \\ . \ 31 \\ . \ 31 \\ . \ 31 \\ . \ 31 \\ . \ 32 \\ . \ 32 \\ . \ 32 \\ . \ 32 \\ . \ 32 \\ . \ 32 \\ . \ 33 \\ . \ 33 \\ . \ 33 \\ . \ 33 \\ . \ 36 \\ . \ 36 \\ . \ 36 \\ . \ 37 \\ . \ 37 \end{array}$
TMROUT0/PI010 TMROUT1/PI01 TXD0/PI022 TXD1/PI027 UCS/ONCE1 UZI/PI026 V <sub>CC</sub> WHB WLB WLB WR X1 X2 FUNCTIONAL DESCRIPTION Memory Organization I/O Space BUS OPERATION BUS INTERFACE UNIT Nonmultiplexed Address Bus DRAM Address Multiplexing Programmable Bus Sizing Byte-Write Enables Data Strobe Bus Interface Option	$\begin{array}{c} . \ 31 \\ . \ 31 \\ . \ 31 \\ . \ 31 \\ . \ 31 \\ . \ 31 \\ . \ 31 \\ . \ 31 \\ . \ 31 \\ . \ 31 \\ . \ 31 \\ . \ 32 \\ . \ 32 \\ . \ 32 \\ . \ 32 \\ . \ 32 \\ . \ 32 \\ . \ 32 \\ . \ 33 \\ . \ 33 \\ . \ 33 \\ . \ 33 \\ . \ 34 \\ . \ 36 \\ . \ 36 \\ . \ 37 \\ . \ 37 \\ . \ 37 \end{array}$
TMROUT0/PI010 TMROUT1/PI01 TXD0/PI022 TXD1/PI027 UCS/ONCE1 UZI/PI026 V <sub>CC</sub> WHB WLB WR X1 X2 FUNCTIONAL DESCRIPTION Memory Organization I/O Space BUS OPERATION BUS INTERFACE UNIT Nonmultiplexed Address Bus DRAM Address Multiplexing Programmable Bus Sizing Byte-Write Enables Data Strobe Bus Interface Option DRAM INTERFACE	.31 .31 .31 .31 .31 .31 .31 .32 .32 .32 .32 .33 .33 .33 .33 .33 .33 .33 .33 .33 .33 .34 .36 .37
TMROUT0/PI010 TMROUT1/PI01 TXD0/PI022 TXD1/PI027 UCS/ONCE1 UZI/PI026 V <sub>CC</sub> WHB WLB WLB WR X1 X2 FUNCTIONAL DESCRIPTION Memory Organization I/O Space BUS OPERATION BUS INTERFACE UNIT Nonmultiplexed Address Bus DRAM Address Multiplexing Programmable Bus Sizing Byte-Write Enables Data Strobe Bus Interface Option	$\begin{array}{c} .31\\ .31\\ .31\\ .31\\ .31\\ .31\\ .31\\ .31\\$

CLOCK AND POWER MANAGEMENT	40
Phase-Locked Loop	40
Crystal-Driven Clock Source	40
External Source Clock	41
System Clocks	41
Power-Save Operation	41
Initialization and Processor Reset	
Reset Configuration Register	
CHIP-SELECT UNIT	
Chip-Select Timing	
Ready and Wait-State Programming	
Chip-Select Overlap	
Upper Memory Chip Select	
Low Memory Chip Select	
Midrange Memory Chip Selects	
Peripheral Chip Selects	
REFRESH CONTROL UNIT	
INTERRUPT CONTROL UNIT	
TIMER CONTROL UNIT	
Watchdog Timer	45
PULSE WIDTH DEMODULATION	45
DIRECT MEMORY ACCESS	46
PULSE WIDTH DEMODULATION DIRECT MEMORY ACCESS DMA Operation	46
DMA Channel Control Registers DMA Priority	47
DMA Priority	47
ASYNCHRONOUS SERIAL PORTS	47
ASYNCHRONOUS SERIAL PORTS DMA Transfers through the Serial Port PROGRAMMABLE I/O (PIO) PINS	48
PROGRAMMABLE I/O (PIO) PINS	48
ABSOLUTE MAXIMUM RATINGS	49
OPERATING RANGES	
DC CHARACTERISTICS OVER COMMERCIAL AND INDUSTRIAL OPERATING RANGES .	
CAPACITANCE	
POWER SUPPLY CURRENT	
THERMAL CHARACTERISTICS	
TQFP Package	
Typical Ambient Temperatures	
COMMERCIAL AND INDUSTRIAL SWITCHING CHARACTERISTICS AND WAVEFORMS	
Key to Switching Waveforms	
Alphabetical Key to Switching Parameter Symbols	
Numerical Key to Switching Parameter Symbols	
SWITCHING CHARACTERISTICS OVER COMMERCIAL AND INDUSTRIAL	01
	<b>C</b> 4
OPERATING RANGES	
Read Cycle (20 MHz and 25 MHz)	
SWITCHING CHARACTERISTICS OVER COMMERCIAL OPERATING RANGES	
Read Cycle (33 MHz and 40 MHz)	
READ CYCLE WAVEFORMS	66
SWITCHING CHARACTERISTICS OVER COMMERCIAL AND INDUSTRIAL	_
OPERATING RANGES	
Write Cycle (20 MHz and 25 MHz)	67
SWITCHING CHARACTERISTICS OVER COMMERCIAL OPERATING RANGES	
Write Cycle (33 MHz and 40 MHz)	
WRITE CYCLE WAVEFORMS	69

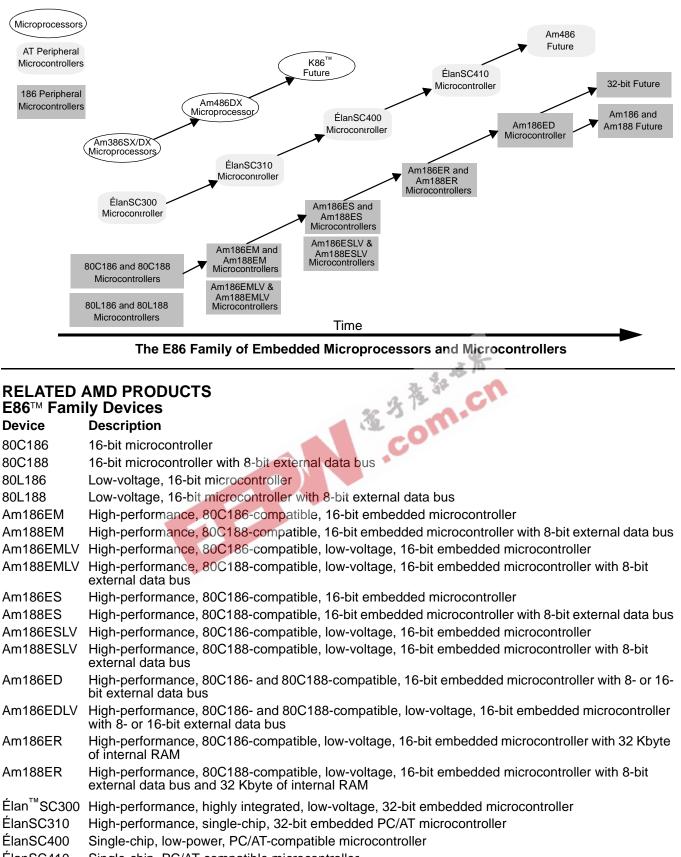
SWITCHING CHARACTERISTICS OVER COMMERCIAL AND INDUSTRIAL	
OPERATING RANGES	. 70
DRAM	. 70
DRAM Read Cycle Timing with No-Wait States	. 71
DRAM Read Cycle Timing with Wait State(s)	
DRAM Write Cycle Timing with No-Wait States	
DRAM Write Cycle Timing With Wait State(s)	
DRAM CAS-before-RAS Cycle Timing	
SWITCHING CHARACTERISTICS OVER COMMERCIAL AND INDUSTRIAL	
OPERATING RANGES	74
Interrupt Acknowledge Cycle (20 MHz and 25 MHz)	
SWITCHING CHARACTERISTICS OVER COMMERCIAL OPERATING RANGES	
Interrupt Acknowledge Cycle (33 MHz and 40 MHz)	
INTERRUPT ACKNOWLEDGE CYCLE WAVEFORMS	
SWITCHING CHARACTERISTICS OVER COMMERCIAL AND INDUSTRIAL	. 70
OPERATING RANGES	77
Software Halt Cycle (20 MHz and 25 MHz)	
SWITCHING CHARACTERISTICS OVER COMMERCIAL OPERATING RANGES	. / /
Software Halt Cycle (33 MHz and 40 MHz)	
SOFTWARE HALT CYCLE WAVEFORMS	
SWITCHING CHARACTERISTICS OVER COMMERCIAL AND INDUSTRIAL	. 70
	70
OPERATING RANGES Clock (20 MHz and 25 MHz)	. 79
	. 79
SWITCHING CHARACTERISTICS OVER COMMERCIAL OPERATING RANGES	. 80
Clock (33 MHz and 40 MHz)	. 80
	. 81
Clock Waveforms—Active Mode	. 81
Clock Waveforms—Power-Save Mode	. 81
SWITCHING CHARACTERISTICS OVER COMMERCIAL AND INDUSTRIAL	~~
Ready and Peripheral (20 MHz and 25 MHz)	
SWITCHING CHARACTERISTICS OVER COMMERCIAL OPERATING RANGES	
Ready and Peripheral (33 MHz and 40 MHz)	. 82
SYNCHRONOUS, ASYNCHRONOUS, AND PERIPHERAL WAVEFORMS	
Synchronous Ready Waveforms	
Asynchronous Ready Waveforms	
Peripheral Waveforms	. 83
SWITCHING CHARACTERISTICS OVER COMMERCIAL AND INDUSTRIAL	
OPERATING RANGES	
Reset and Bus Hold (20 MHz and 25 MHz)	
SWITCHING CHARACTERISTICS OVER COMMERCIAL OPERATING RANGES	
Reset and Bus Hold (33 MHz and 40 MHz)	
RESET AND BUS HOLD WAVEFORMS	
Reset Waveforms	
Signals Related to Reset Waveforms	
Bus Hold Waveforms—Entering	. 86
Bus Hold Waveforms—Leaving	. 86
TQFP PHYSICAL DIMENSIONS	. 87
PQFP PHYSICAL DIMENSIONS	. 88

## LIST OF FIGURES

Figure 1	Am186ED Microcontroller Example System Design	11
Figure 2	80C186 Microcontroller Example System Design	12
Figure 3	Two-Component Address	33
Figure 4	16-Bit Mode—Normal Read and Write Operation	34
Figure 5	16-Bit Mode—Read and Write with Address Bus Disable In Effect	35
Figure 6	8-Bit Mode—Normal Read and Write Operation	35
Figure 7	8-Bit Mode—Read and Write with Address Bus Disable in Effect	36
Figure 8	Am186ED/EDLV Microcontrollers Oscillator Configurations	40
Figure 9	Clock Organization	
Figure 10	DMA Unit Block Diagram	47
Figure 11	Typical I <sub>cc</sub> Versus Frequency for Am186EDLV Microcontroller	50
Figure 12	Typical I <sub>cc</sub> Versus Frequency for Am186ED Microcontroller	50
Figure 13	Thermal Resistance(°C/Watt)	51
Figure 14	Thermal Characteristics Equations	51
Figure 15	Typical Ambient Temperatures for PQFP with a 2-Layer Board	53
Figure 16	Typical Ambient Temperatures for TQFP with a 2-Layer Board	54
Figure 17	Typical Ambient Temperatures for PQFP with a 4-Layer to 6-Layer Board	55
Figure 18	Typical Ambient Temperatures for TQFP with a 4-Layer to 6-Layer Board	56

## LIST OF TABLES

LIST OF T		
Table 1	Data Byte Encoding	22
Table 2	Numeric PIO Pin Designations	29
Table 3	Alphabetic PIO Pin Designations	29
Table 4	Bus Cycle Encoding	30
Table 5	Segment Register Selection Rules	33
Table 6	DRAM Pin Interface	
Table 7	Programming the Bus Width of Am186ED/EDLV Microcontrollers	
Table 8	Peripheral Control Block Register Map	39
Table 9	Am186ED/EDLV Microcontrollers Maximum DMA Transfer Rates	46
Table 10	Typical Power Consumption Calculation for the Am186EDLV Microcontroller	50
Table 11	Thermal Characteristics (°C/Watt)	51
Table 12	Typical Power Consumption Calculation	52
Table 13	Junction Temperature Calculation	52
Table 14	Typical Ambient Temperatures (°C) for PQFP with a 2-Layer Board	53
Table 15	Typical Ambient Temperatures (°C) for TQFP with a 2-Layer Board	54
Table 16	Typical Ambient Temperatures (°C) for PQFP with a 4-Layer to 6-Layer Board	55
Table 17	Typical Ambient Temperatures (°C) for TQFP with a 4-Layer to 6-Layer Board	56



- ElanSC410 Single-chip, PC/AT-compatible microcontroller
- Am386®DX High-performance, 32-bit embedded microprocessor with 32-bit external data bus
- Am386®SX High-performance, 32-bit embedded microprocessor with 16-bit external data bus
- Am486®DX High-performance, 32-bit embedded microprocessor with 32-bit external data bus

### **Related Documents**

The following documents provide additional information regarding the Am186ED/EDLV microcontrollers:

- Am186ED/EDLV Microcontrollers User's Manual, order # 21335
- Am186 and Am188 Family Instruction Set Manual, order # 21267
- FusionE86<sup>SM</sup> Catalog, order # 19255
- E86 Family Support Tools Brief, order # 20071
- FusionE86 Development Tools Reference CD, order # 21058

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## KEY FEATURES AND BENEFITS

34

The Am186ED/EDLV microcontrollers extend the AMD family of microcontrollers based on the industry-standard x86 architecture. The Am186ED/EDLV microcontrollers are a higher-performance, highly integrated version of the 80C186/188 microprocessors, offering an attractive migration path. In addition, the Am186ED/ EDLV microcontrollers offer application-specific features that can enhance the system functionality of the Am186ES/ESLV and Am188ES/ESLV microcontrollers. Upgrading to the Am186ED/EDLV microcontrollers is an attractive solution for several reasons:

- Programmable DRAM controller—Enables system designers to take advantage of low-cost DRAM and fully utilize the performance and flexibility of the x86 architecture. The DRAM controller supports zero wait-state performance with 50-ns DRAM at 40 MHz, or, if required, can be programmed with wait states. The Am186ED/EDLV microcontrollers provide a CAS-before-RAS refresh unit.
- Minimized total system cost—New and enhanced peripherals and on-chip system interface logic on the Am186ED/EDLV microcontrollers reduce the cost of existing 80C186/188 designs.
- X86 software compatibility—80C186/188-compatible and upward-compatible with the other members of the AMD E86 family.

- Enhanced performance—The Am186ED/EDLV microcontrollers increase the performance of 80C186/188 systems, and the nonmultiplexed address bus offers unbuffered access to memory.
- Enhanced functionality—The enhanced on-chip peripherals of the Am186ED/EDLV microcontrollers include two asynchronous serial ports, 32 PIOs, a watchdog timer, additional interrupt pins, a pulse width demodulation option, DMA directly to and from the serial ports, 8-bit and 16-bit programmable bus sizing, a 16-bit reset configuration register, and enhanced chip-select functionality.

### **Application Considerations**

The integration enhancements of the Am186ED/EDLV microcontrollers provide a high-performance, low-system-cost solution for 16-bit embedded microcontroller designs. The nonmultiplexed address bus eliminates the need for system-support logic to interface memory devices, while the multiplexed address/data bus maintains the value of previously engineered, customer-specific peripherals and circuits within the upgraded design.

Figure 1 illustrates an example system design that uses the integrated peripheral set to achieve high performance with reduced system cost.

### **Memory Interface**

The Am186ED/EDLV microcontrollers integrate a versatile memory controller which supports direct memory accesses to DRAM, SRAM, Flash, EPROM, and ROM. No external glue logic is required and all required control signals are provided. The peripheral chip selects have been enhanced to allow them to overlap the DRAM. This allows a small 1.5K portion of the DRAM memory space to be used for peripherals without bus contention.

The improved memory timing specifications of the Am186ED/EDLV microcontrollers allow for zero-waitstate operation at 40 MHz using 50-ns DRAM, 70-ns SRAM, or 70-ns Flash memory. For 60-ns DRAM one wait state is required at 40 MHz and zero wait states at 33 MHz and below. For 70-ns DRAM two wait states are required at 40 MHz, one wait state at 33 MHz, and zero wait states at 25 MHz and below. This reduces overall system cost by enabling the use of commonly available memory speeds and taking advantage of DRAM's lower cost per bit over SRAM.

Figure 1 also shows an implementation of an RS-232 console or modem communications port. The RS-232 to CMOS voltage-level converter is required for the electrical interface with the external device.

### **Clock Generation**

The integrated clock generation circuitry of the Am186ED/EDLV microcontrollers enables the use of a 1x crystal frequency. The Am186ED design in Figure 1 achieves 40-MHz CPU operation, while using a 40-MHz crystal.

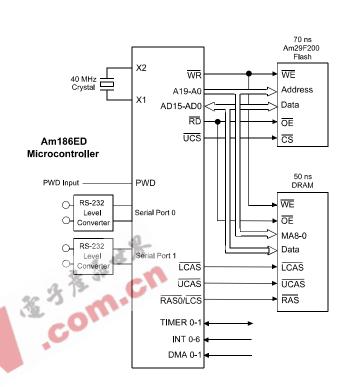


Figure 1. Am186ED Microcontroller Example System Design

### Direct Memory Interface Example

Figure 1 illustrates the direct memory interface of the Am186ED microcontroller. The processor's A19–A0 bus connects to the memory address inputs, the AD bus connects to the data inputs and outputs, and the chip selects connect to the memory chip-select inputs. The odd A1–A17 address pins connect to the DRAM multiplexed address bus.

The  $\overline{\text{RD}}$  output connects to the DRAM Output Enable  $(\overline{\text{OE}})$  pin for read operations. Write operations use the  $\overline{\text{WR}}$  output connected to the DRAM Write Enable ( $\overline{\text{WE}}$ ) pin. The  $\overline{\text{UCAS}}$  and  $\overline{\text{LCAS}}$  pins provide byte selection.

## COMPARING THE Am186ES/ESLV TO THE Am186ED/EDLV MICROCONTROLLERS

Compared to the Am186ES/ESLV microcontrollers, the Am186ED/EDLV microcontrollers have the following additional features:

- Integrated DRAM controller
- Enhanced refresh control unit
- Option to overlap DRAM with peripheral chip select (PCS)
- Additional serial port mode for DMA support of 9-bit protocols
- Option to boot from 8- or 16-bit memory
- Improved external bus master support
- PSRAM controller removed

Figure 1 shows an example system using a 40-MHz Am186ED microcontroller. Figure 2 shows a comparable system implementation with an 80C186. Because of its superior integration, the Am186ED/ EDLV system does not require the support devices that are required on the 80C186 example system. In addition, the Am186ED/EDLV microcontrollers provide significantly better performance with its 40-MHz clock rate.

### Integrated DRAM Controller

The integrated DRAM controller directly interfaces DRAM to support no-wait state DRAM interface up to 40 MHz. Wait states can be inserted to support slower DRAM. All signals required by the DRAM are generated on the Am186ED/EDLV microcontrollers and no external logic is required. The DRAM multiplexed address pins are connected to the odd address pins starting with A1 on the Am186ED/EDLV microcontrollers to MA0 on the DRAM. The correct row and column addresses are generated on these pins during a DRAM access. The UCAS and LCAS are used to select which byte of the DRAM is accessed during a read or write. The RAS0 controls the lower bank of DRAM which starts at 00000h in the address map and is bounded by the lower memory size selected in the LMCS register. RAS1 controls the upper bank of DRAM which ends at FFFFh and is bounded by the upper memory size in the UMCS register. When RAS1 is enabled, UCS is automatically disabled. Neither, either, or both DRAM banks can be activated.

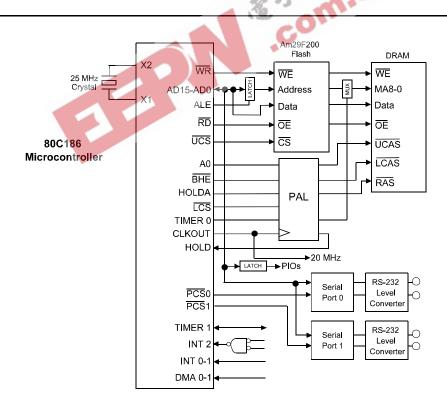


Figure 2. 80C186 Microcontroller Example System Design

### **Enhanced Refresh Control Unit**

The refresh control unit (RCU) is enhanced with two additional bits in the refresh counter to allow for longer refresh periods. The address generated during a refresh has been fixed to FFFFh. When either bank of DRAM is enabled and the RCU is enabled, a CAS-before-RAS refresh will be generated based on the time period coded into the refresh counter.

### Option to Overlap DRAM with PCS

The peripheral chip selects (PCS0–PCS6) can overlap DRAM blocks with different wait states without external or internal bus contention. The RAS0 or RAS1 will assert along with the appropriate PCS. The UCAS and LCAS will not assert, preventing the DRAM from writing erroneously or driving the data bus during a read. The PCS must have the same or higher number of wait states than the DRAM. The PCS bus width will be determined by the LSIZ or USIZ bus widths as programmed in the AUXCON register.

### Additional Serial Port Mode for DMA Support of 9-bit Protocols

A mode 7 was added to the serial port which enhances the direct memory access (DMA) support for 9-bit protocols. Using mode 2, the serial port can be programmed to interrupt only if the 9th bit is set, ignoring all 9th bit cleared byte receptions. Mode 3 receives all bytes, whether the 9th bit is set or cleared. Mode 7 also receives all bytes whether the 9th bit is set or cleared, but now an interrupt is generated when the 9th bit is set. This allows the DMA to service all receptions, but also allows the CPU to intervene when the trailer (9th bit set) is received. In all modes using DMA, the interrupts other than transmitter ready and character received interrupts can still be generated. This allows the DMA to handle the standard sending and receiving characters while the CPU can intervene when a non-standard event (e.g., framing error) occurs.

## Option to Boot from 8- or 16-bit Memory

The Am186ED/EDLV microcontrollers can boot from 8or 16-bit-wide non-volatile memory, based on the state of the  $\overline{S}2/BTSEL$  pin. If  $\overline{S}2/BTSEL$  is pulled High or left floating, an internal pullup sets the boot mode option to 16-bit. If  $\overline{S}2/BTSEL$  is pulled resistively Low during reset, the boot mode option is for 8-bit. The status of the  $\overline{S}2/BTSEL$  pin is latched on the rising edge of reset.

If the 8-bit boot option is selected, the width of the memory region associated with  $\overline{\text{UCS}}$  can be changed in the AUXCON register. This allows for cheaper 8-bit-wide memory to be used for booting the microcontroller, while speed-critical code and data can be executed from 16-bit-wide lower memory. Eight-bit or 16-bit-wide peripherals can be used in the memory area between  $\overline{\text{LCS}}$  and  $\overline{\text{UCS}}$  or in the I/O space. The

entire memory map can be set to 16-bit or 8-bit or mixed between 8-bit and 16-bit based on the USIZ, LSIZ, MSIZ, and IOSIZ bits in the AUXCON register.

### Improved External Bus Master Support

When the bus is arbitrated away from the Am186ED/ EDLV microcontrollers using the HOLD pin, the chip selects are driven High (negated) and then held High with an internal ~10-kohm pullup. This allows external bus masters to assert the chip selects by externally pulling them Low, without having to combine the chip selects from the Am186ED/EDLV microcontrollers and the external bus master in logic external to the Am186ED/EDLV microcontrollers. This internal pullup is activated for any bus arbitration, even if the pin is being used as a PIO input.

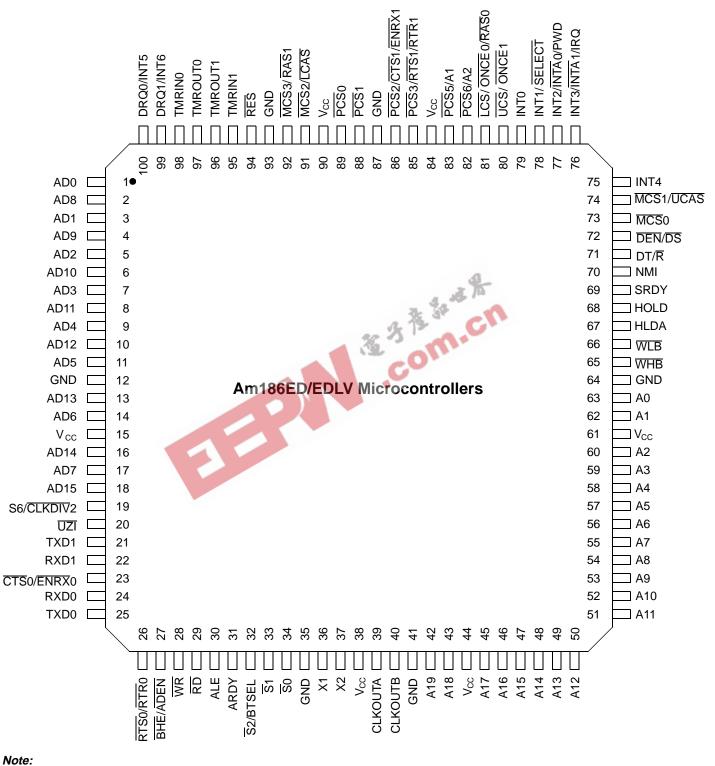
### **PSRAM Controller Removed**

The PSRAM mode found on the Am186ES/ESLV microcontrollers has been removed and replaced with a DRAM controller. This includes removal of the variant PSRAM LCS timing and refresh strobe on MCS3.

## **TQFP CONNECTION DIAGRAMS AND PINOUTS**

**Am186ED/EDLV Microcontrollers** 

Top Side View—100-Pin Thin Quad Flat Pack (TQFP)



Pin 1 is marked for orientation.

## TQFP PIN DESIGNATIONS—Am186ED/EDLV Microcontrollers Sorted by Pin Number

Pin No.	Name	Pin No.	Name	Pin No.	Name	Pin No.	Name
1	AD0	26	RTS0/RTR0/ PIO20	51	A11	76	INT3/INTA1/IRQ
2	AD8	27	BHE/ADEN	52	A10	77	INT2/INTA0/PWD/ PIO31
3	AD1	28	WR	53	A9	78	INT1/SELECT
4	AD9	29	RD	54	A8	79	INT0
5	AD2	30	ALE	55	A7	80	UCS/ONCE1
6	AD10	31	ARDY	56	A6	81	LCS/ONCE0/ RAS0
7	AD3	32	S2/BTSEL	57	A5	82	PCS6/A2/PIO2
8	AD11	33	<u></u> 51	58	A4	83	PCS5/A1/PIO3
9	AD4	34	<b>S</b> 0	59	A3	84	V <sub>CC</sub>
10	AD12	35	GND	60	A2	85	PCS3/RTS1/ RTR1/ PIO19
11	AD5	36	X1	61	Vcc	86	PCS2/CTS1/ ENRX1/PIO18
12	GND	37	X2	62	A1	87	GND
13	AD13	38	V <sub>cc</sub>	63	A0	88	PCS1/PIO17
14	AD6	39	CLKOUTA	64	GND	89	PCS0/PIO16
15	V <sub>CC</sub>	40	CLKOUTB	65	WHB	90	V <sub>CC</sub>
16	AD14	41	GND	66	WLB	91	MCS2/LCAS/ PIO24
17	AD7	42	A19/PIO9	67	HLDA	92	MCS3/RAS1/ PIO25
18	AD15	43	A18/PIO8	68	HOLD	93	GND
19	S6/CLKDIV2/PIO29	44	V <sub>CC</sub>	69	SRDY/PIO6	94	RES
20	UZI/PIO26	45	A17/PIO7	70	NMI	95	TMRIN1/PIO0
21	TXD1/PIO27	46	A16	71	DT/R/PIO4	96	TMROUT1/PIO1
22	RXD1/PIO28	47	A15	72	DEN/DS/PIO5	97	TMROUT0/PIO10
23	CTS0/ENRX0/PIO21	48	A14	73	MCS0/PIO14	98	TMRIN0/PIO11
24	RXD0/PIO23	49	A13	74	MCS1/UCAS/ PIO15	99	DRQ1/INT6/PIO13
25	TXD0/PIO22	50	A12	75	INT4/PIO30	100	DRQ0/INT5/PIO12

## TQFP PIN DESIGNATIONS—Am186ED/EDLV Microcontrollers

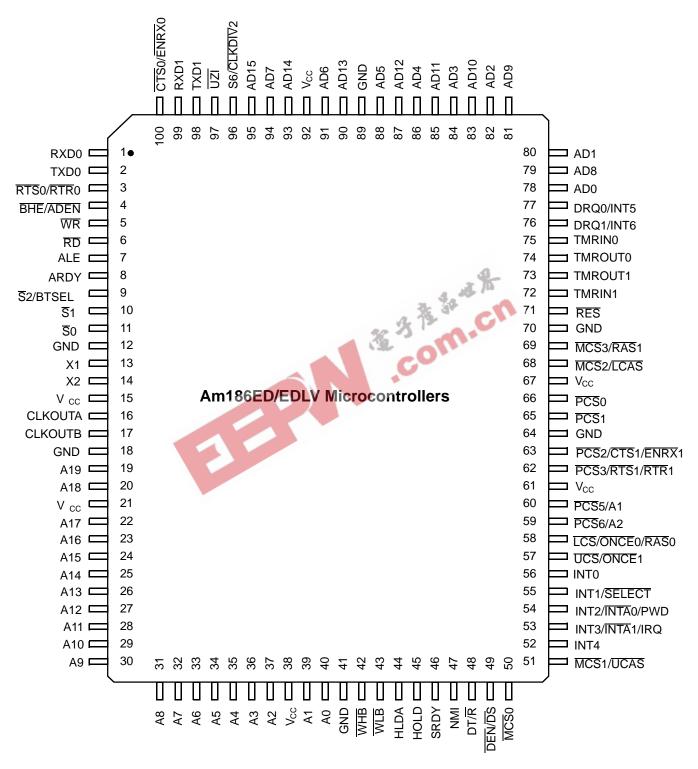
## Sorted by Pin Name

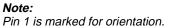
A1       62       AD6       14       GND       93       \$0       34         A2       60       AD7       17       HLDA       67       \$1       33         A3       59       AD8       2       HOLD       68       \$2/BTSEL       32         A4       58       AD9       4       INTO       79       \$6/CLKDIV2/ PIO29       19         A5       57       AD10       6       INT1/SELECT       78       \$R9Y/PIO6       69         A6       56       AD11       8       INT2/INTA/PVD/ PIO31       77       TMRIN1/PIO0       95         A8       54       AD12       10       INT3/INTA/I/RQ       76       TMRIN1/PIO0       95         A8       54       AD13       13       INT4/PIO30       75       TMROUT0/ PIO10       97         A9       53       AD14       16       LCS/ONCE0/RAS0       81       TMROUT1/PIO1       96         A10       52       AD15       18       MCS0/PIO14       73       TXD0/PIO22       25         A11       51       ALE       30       MCS1/UCAS/ PIO15       74       TXD1       21         A12       50       ARDY	Pin Name	No.	Pin Name	No.	Pin Name	No.	Pin Name	No.
A2         60         AD7         17         HLDA         67         S1         33           A3         59         AD8         2         HOLD         68         S2/BTSEL         32           A4         58         AD9         4         INTO         79         S6/CLKDIV2/ PIO29         19           A5         57         AD10         6         INT1/SELECT         78         SRDY/PIO6         69           A6         56         AD11         8         INT2/INTA/OPWD/ PIO31         77         TMRIN/PIO1         98           A7         55         AD12         10         INT3/INTA/I/RQ         76         TMRIN1/PIO0         95           A8         54         AD13         13         INT4/PIO30         75         TMROUT0/ PIO10         97           A9         53         AD14         16         LCS/ONCE0/RAS0         81         TMROUT1/PIO1         96           A10         52         AD15         18         MCS0/PIO14         73         TXD0/PIO22         25           A11         51         ALE         30         MCS1/UCAS/ PIO15         74         TXD1         21           A12         S0         ARDY	A0	63	AD5	11	GND	87	RXD1	22
A3         59         AD8         2         HOLD         68         S2/BTSEL         32           A4         58         AD9         4         INT0         79         S6/CERDIV2/ PIO29         19           A5         57         AD10         6         INT1/SELECT         78         SRDY/PIO6         69           A6         56         AD11         8         INT2/INTA/OPWD/ PIO31         77         TMRINO/PIO11         98           A7         55         AD12         10         INT3/INTA/I/RQ         76         TMRIN1/PIO0         95           A8         54         AD13         13         INT4/PIO30         75         TMROUT0/ PIO10         97           A9         53         AD14         16         LCS/ONCEO/RAS0         81         TMROUT1/PIO1         96           A10         52         AD15         18         MCS0/PIO14         73         TXD0/PIO22         25           A11         51         ALE         30         MCS1/UCAS/ PIO15         74         TXD1         21           A12         50         ARDY         31         MCS2/LCAS/ PIO24         91         UCS/ONCE1         80           A13         49	A1	62	AD6	14	GND	93	<u></u> 50	34
A4         58         AD9         4         INTO         79         S6/CLKDIV2/ PIO29         19           A5         57         AD10         6         INT1/SELECT         78         SRDY/PIO6         69           A6         56         AD11         8         INT2/INTA0/PWD/ PIO31         77         TMRIN0/PIO11         98           A7         55         AD12         10         INT3/INTA1/IRQ         76         TMRIN1/PIO0         95           A8         54         AD13         13         INT4/PIO30         75         TMROUT0/ PIO10         97           A9         53         AD14         16         LCS/ONCE0/RAS0         81         TMROUT1/PIO1         96           A10         52         AD15         18         MCS0/PIO14         73         TXD0/PIO22         25           A11         51         ALE         30         MCS1/UCAS/ PIO15         74         TXD1         21           A12         50         ARDY         31         MCS2/LCAS/PIO24         91         UCS/ONCE1         80           A13         49         BHE/ADEN         27         MCS3/RAS1/PIO25         92         UZI/PIO26         20           A14	A2	60	AD7	17	HLDA	67	<u></u> S1	33
A4         S8         AD9         4         INT0         79         PIO29         19           A5         57         AD10         6         INT1/SELECT         78         SRDY/PIO6         69           A6         56         AD11         8         INT2/INTA0/PWD/ PIO31         77         TMRIN0/PIO11         98           A7         55         AD12         10         INT3/INTA1/IRQ         76         TMRIN1/PIO0         95           A8         54         AD13         13         INT4/PIO30         75         TMROUT0/ PIO10         97           A9         53         AD14         16         LCS/ONCE0/RAS0         81         TMROUT1/PIO1         96           A10         52         AD15         18         MCS0/PIO14         73         TXD0/PIO22         25           A11         51         ALE         30         MCS1/UCAS/ PIO15         74         TXD1         21           A12         50         ARDY         31         MCS2/LCAS/PIO24         91         UCS/ONCE1         80           A13         49         BHE/ADEN         27         MCS3/RAS1/PIO25         92         UZI/PIO26         20           A14         48 </td <td>A3</td> <td>59</td> <td>AD8</td> <td>2</td> <td>HOLD</td> <td>68</td> <td>S2/BTSEL</td> <td>32</td>	A3	59	AD8	2	HOLD	68	S2/BTSEL	32
A6         56         AD11         8         INT2/INTA0/PWD/ PIO31         77         TMRIN0/PIO11         98           A7         55         AD12         10         INT3/INTA1/IRQ         76         TMRIN1/PIO0         95           A8         54         AD13         13         INT4/PIO30         75         TMROUT0/ PIO10         97           A9         53         AD14         16         LCS/ONCE0/RAS0         81         TMROUT1/PIO1         96           A10         52         AD15         18         MCS0/PIO14         73         TXD0/PIO22         25           A11         51         ALE         30         MCS1/UCAS/ PIO15         74         TXD1         21           A12         50         ARDY         31         MCS2/LCAS/PIO24         91         UCS/ONCE1         80           A13         49         BHE/ADEN         27         MCS3/RAS1/PIO25         92         UZI/PIO26         20           A14         48         CLKOUTA         39         NMI         70         Vcc         15           A15         47         CLKOUTB         40         PCS0/PIO16         89         Vcc         44           A17/PIO7 <t< td=""><td>A4</td><td>58</td><td>AD9</td><td>4</td><td>INTO</td><td>79</td><td></td><td>19</td></t<>	A4	58	AD9	4	INTO	79		19
A6         56         AD11         8         PIO31         77         IMRINUPIO11         98           A7         55         AD12         10         INT3/INTA1/IRQ         76         TMRINUPIO11         98           A8         54         AD13         13         INT4/PIO30         75         TMROUT0/ PIO10         97           A9         53         AD14         16         ICS/ONCE0/RAS0         81         TMROUT1/PIO1         96           A10         52         AD15         18         MCS0/PIO14         73         TXD0/PIO22         25           A11         51         ALE         30         MCS1/UCAS/ PIO15         74         TXD1         21           A12         50         ARDY         31         MCS2/ICAS/PIO24         91         UCS/ONCE1         80           A13         49         BHE/ADEN         27         MCS3/RAS1/PIO25         92         UZI/PIO26         20           A14         48         CLKOUTA         39         NMI         70         Vcc         15           A15         47         CLKOUTB         40         PCS1/PIO17         88         Vcc         44           A17/PIO7         45	A5	57	AD10	6	INT1/SELECT	78	SRDY/PIO6	69
A8         54         AD13         13         INT4/PIO30         75         TMROUT0/ PIO10         97           A9         53         AD14         16         LCS/ONCE0/RAS0         81         TMROUT1/PIO1         96           A10         52         AD15         18         MCS0/PIO14         73         TXD0/PIO22         25           A11         51         ALE         30         MCS1/UCAS/ PIO15         74         TXD1         21           A12         50         ARDY         31         MCS2/LCAS/PIO24         91         UCS/ONCE1         80           A13         49         BHE/ADEN         27         MCS3/RAS1/PIO25         92         UZI/PIO26         20           A14         48         CLKOUTA         39         NMI         70         V <sub>CC</sub> 15           A15         47         CLKOUTB         40         PCS0/PIO16         89         V <sub>CC</sub> 38           A16         46         CTS0/ENRX0/ PIO21         23         PCS1/PIO17         88         V <sub>CC</sub> 61           A18/PIO8         43         DRQ0/INT5/PIO12         100         PCS3/RTS1/RTR1/ ENX1/PIO18         86         V <sub>CC</sub> 84 <td< td=""><td>A6</td><td>56</td><td>AD11</td><td>8</td><td></td><td>77</td><td>TMRIN0/PIO11</td><td>98</td></td<>	A6	56	AD11	8		77	TMRIN0/PIO11	98
A8         54         AD13         13         INT4/PIO30         75         PIO10         97           A9         53         AD14         16         LCS/ONCE0/RAS0         81         TMROUT1/PIO1         96           A10         52         AD15         18         MCS0/PIO14         73         TXD0/PIO22         25           A11         51         ALE         30         MCS1/UCAS/ PIO15         74         TXD1         21           A12         50         ARDY         31         MCS2/LCAS/PIO24         91         UCS/ONCE1         80           A13         49         BHE/ADEN         27         MCS3/RAS1/PIO25         92         UZI/PIO26         20           A14         48         CLKOUTA         39         NMI         70         V <sub>CC</sub> 15           A15         47         CLKOUTB         40         PCS0/PIO16         89         V <sub>CC</sub> 38           A16         46         CTS0/ENRX0/ PIO21         23         PCS1/PIO17         88         V <sub>CC</sub> 44           A17/PIO7         45         DEN/DS/PIO5         72         PCS2/CTS1/ ENRX1/PIO18         86         V <sub>CC</sub> 84           A19/PIO9	A7	55	AD12	10	INT3/INTA1/IRQ	76	TMRIN1/PIO0	95
A10       52       AD15       18       MCS0/PIO14       73       TXD0/PIO22       25         A11       51       ALE       30       MCS1/UCAS/ PIO15       74       TXD1       21         A12       50       ARDY       31       MCS2/LCAS/PIO24       91       UCS/ONCE1       80         A13       49       BHE/ADEN       27       MCS3/RAS1/PIO25       92       UZI/PIO26       20         A14       48       CLKOUTA       39       NMI       70       V <sub>CC</sub> 15         A15       47       CLKOUTB       40       PCS0/PIO16       89       V <sub>CC</sub> 38         A16       46       CTS0/ENRX0/ PIO21       23       PCS1/PIO17       88       V <sub>CC</sub> 44         A17/PIO7       45       DEN/DS/PIO5       72       PCS2/CTS1/ ENRX1/PIO18       86       V <sub>CC</sub> 61         A18/PIO8       43       DRQ0/INT5/PIO12       100       PCS3/RTS1/RTR1/ PIO19       85       V <sub>CC</sub> 84         A19/PIO9       42       DRQ1/INT6/PIO13       99       PCS5/A1/PIO3       83       V <sub>CC</sub> 90         AD0       1       DT/R/PIO4       71       PCS6/A2/PIO2       82       WHB <td>A8</td> <td>54</td> <td>AD13</td> <td>13</td> <td>INT4/PIO30</td> <td>75</td> <td></td> <td>97</td>	A8	54	AD13	13	INT4/PIO30	75		97
A11       51       ALE       30       MCS1/UCAS/ PIO15       74       TXD1       21         A12       50       ARDY       31       MCS2/ICAS/PIO24       91       UCS/ONCE1       80         A13       49       BHE/ADEN       27       MCS3/RAS1/PIO25       92       UZI/PIO26       20         A14       48       CLKOUTA       39       NMI       70       V <sub>CC</sub> 15         A15       47       CLKOUTB       40       PCS0/PIO16       89       V <sub>CC</sub> 38         A16       46       CTS0/ENRX0/ PIO21       23       PCS1/PIO17       88       V <sub>CC</sub> 61         A17/PIO7       45       DEN/DS/PIO5       72       PCS2/CTS1/ ENRX1/PIO18       86       V <sub>CC</sub> 61         A18/PIO8       43       DRQ0/INT5/PIO12       100       PCS3/RTS1/RTR1/ PIO19       85       V <sub>CC</sub> 84         A19/PIO9       42       DRQ1/INT6/PIO13       99       PCS5/A1/PIO3       83       V <sub>CC</sub> 90         AD0       1       DT/R/PIO4       71       PCS6/A2/PIO2       82       WHB       65         AD1       3       GND       12       RD       29       WLB       66 <td>A9</td> <td>53</td> <td>AD14</td> <td>16</td> <td>LCS/ONCE0/RAS0</td> <td>81</td> <td>TMROUT1/PIO1</td> <td>96</td>	A9	53	AD14	16	LCS/ONCE0/RAS0	81	TMROUT1/PIO1	96
A11       51       ALE       30       PIO15       74       TXD1       21         A12       50       ARDY       31       MCS2/LCAS/PIO24       91       UCS/ONCE1       80         A13       49       BHE/ADEN       27       MCS3/RAS1/PIO25       92       UZI/PIO26       20         A14       48       CLKOUTA       39       NMI       70       V <sub>CC</sub> 15         A15       47       CLKOUTB       40       PCS0/PIO16       89       V <sub>CC</sub> 38         A16       46       CTS0/ENRX0/ PIO21       23       PCS1/PIO17       88       V <sub>CC</sub> 61         A17/PIO7       45       DEN/DS/PIO5       72       PCS2/CTS1/ ENRX1/PIO18       86       V <sub>CC</sub> 61         A18/PIO8       43       DRQ0/INT5/PIO12       100       PCS3/RTS1/RTR1/ PIO19       85       V <sub>CC</sub> 84         A19/PIO9       42       DRQ1/INT6/PIO13       99       PCS5/A1/PIO3       83       V <sub>CC</sub> 90         AD0       1       DT/R/PIO4       71       PCS6/A2/PIO2       82       WHB       65         AD1       3       GND       12       RD       29       WLB       66 <td>A10</td> <td>52</td> <td>AD15</td> <td>18</td> <td>MCS0/PIO14</td> <td>73</td> <td>TXD0/PIO22</td> <td>25</td>	A10	52	AD15	18	MCS0/PIO14	73	TXD0/PIO22	25
A13       49       BHE/ADEN       27       MCS3/RAS1/PIO25       92       UZI/PIO26       20         A14       48       CLKOUTA       39       NMI       70       V <sub>CC</sub> 15         A15       47       CLKOUTB       40       PCS0/PIO16       89       V <sub>CC</sub> 38         A16       46       CTS0/ENRX0/ PIO21       23       PCS1/PIO17       88       V <sub>CC</sub> 44         A17/PIO7       45       DEN/DS/PIO5       72       PCS2/CTS1/ ENRX1/PIO18       86       V <sub>CC</sub> 61         A18/PIO8       43       DRQ0/INT5/PIO12       100       PCS3/RTS1/RTR1/ PIO19       85       V <sub>CC</sub> 90         AD0       1       DT/R/PIO4       71       PCS6/A2/PIO2       82       WHB       65         AD1       3       GND       12       RD       29       WLB       66         AD2       5       GND       35       RES       94       WR       28         AD3       7       GND       41       RTS0/RTR0/PIO20       26       X1       36	A11	51	ALE	30		74	TXD1	21
A14       48       CLKOUTA       39       NMI       70       V <sub>CC</sub> 15         A15       47       CLKOUTB       40       PCS0/PIO16       89       V <sub>CC</sub> 38         A16       46       CTS0/ENRX0/ PIO21       23       PCS1/PIO17       88       V <sub>CC</sub> 44         A17/PIO7       45       DEN/DS/PIO5       72       PCS2/CTS1/ ENRX1/PIO18       86       V <sub>CC</sub> 61         A18/PIO8       43       DRQ0/INT5/PIO12       100       PCS3/RTS1/RTR1/ PIO19       85       V <sub>CC</sub> 84         A19/PIO9       42       DRQ1/INT6/PIO13       99       PCS5/A1/PIO3       83       V <sub>CC</sub> 90         AD0       1       DT/R/PIO4       71       PCS6/A2/PIO2       82       WHB       65         AD1       3       GND       12       RD       29       WLB       66         AD2       5       GND       35       RES       94       WR       28         AD3       7       GND       41       RTS0/RTR0/PIO20       26       X1       36	A12	50	ARDY	31	MCS2/LCAS/PIO24	91	UCS/ONCE1	80
A15       47       CLKOUTB       40       PCS0/PIO16       89       V <sub>CC</sub> 38         A16       46       CTS0/ENRX0/ PIO21       23       PCS1/PIO17       88       V <sub>CC</sub> 44         A17/PIO7       45       DEN/DS/PIO5       72       PCS2/CTS1/ ENRX1/PIO18       86       V <sub>CC</sub> 61         A18/PIO8       43       DRQ0/INT5/PIO12       100       PCS3/RTS1/RTR1/ PIO19       85       V <sub>CC</sub> 84         A19/PIO9       42       DRQ1/INT6/PIO13       99       PCS5/A1/PIO3       83       V <sub>CC</sub> 90         AD0       1       DT/R/PIO4       71       PCS6/A2/PIO2       82       WHB       65         AD1       3       GND       12       RD       29       WLB       66         AD3       7       GND       41       RTS0/RTR0/PIO20       26       X1       36	A13	49	BHE/ADEN	27	MCS3/RAS1/PIO25	92	UZI/PIO26	20
A16       46       CTS0/ENRX0/ PIO21       23       PCS1/PIO17       88       V <sub>CC</sub> 44         A17/PIO7       45       DEN/DS/PIO5       72       PCS2/CTS1/ ENRX1/PIO18       86       V <sub>CC</sub> 61         A18/PIO8       43       DRQ0/INT5/PIO12       100       PCS3/RTS1/RTR1/ PIO19       85       V <sub>CC</sub> 84         A19/PIO9       42       DRQ1/INT6/PIO13       99       PCS5/A1/PIO3       83       V <sub>CC</sub> 90         AD0       1       DT/R/PIO4       71       PCS6/A2/PIO2       82       WHB       65         AD1       3       GND       12       RD       29       WLB       66         AD2       5       GND       35       RES       94       WR       28         AD3       7       GND       41       RTS0/RTR0/PIO20       26       X1       36	A14	48	CLKOUTA	39	NMI	70	V <sub>CC</sub>	15
A16       46       PIO21       23       PCS1/PIO17       88       V <sub>CC</sub> 44         A17/PIO7       45       DEN/DS/PIO5       72       PCS2/CTS1/ ENRX1/PIO18       86       V <sub>CC</sub> 61         A18/PIO8       43       DRQ0/INT5/PIO12       100       PCS3/RTS1/RTR1/ PIO19       85       V <sub>CC</sub> 84         A19/PIO9       42       DRQ1/INT6/PIO13       99       PCS5/A1/PIO3       83       V <sub>CC</sub> 90         AD0       1       DT/R/PIO4       71       PCS6/A2/PIO2       82       WHB       65         AD1       3       GND       12       RD       29       WLB       66         AD2       5       GND       35       RES       94       WR       28         AD3       7       GND       41       RTS0/RTR0/PIO20       26       X1       36	A15	47	CLKOUTB	40	PCS0/PIO16	89	V <sub>CC</sub>	38
A17/PIO7       45       DEN/DS/PIOS       72       ENRX1/PIO18       86       V <sub>CC</sub> 61         A18/PIO8       43       DRQ0/INT5/PIO12       100       PCS3/RTS1/RTR1/ PIO19       85       V <sub>CC</sub> 84         A19/PIO9       42       DRQ1/INT6/PIO13       99       PCS5/A1/PIO3       83       V <sub>CC</sub> 90         AD0       1       DT/R/PIO4       71       PCS6/A2/PIO2       82       WHB       65         AD1       3       GND       12       RD       29       WLB       66         AD2       5       GND       35       RES       94       WR       28         AD3       7       GND       41       RTS0/RTR0/PIO20       26       X1       36	A16	46		23	PCS1/PIO17	88	V <sub>CC</sub>	44
A13/PIO8       43       DRQU/INTS/PIO12       100       PIO19       85       V <sub>CC</sub> 84         A19/PIO9       42       DRQ1/INT6/PIO13       99       PCS5/A1/PIO3       83       V <sub>CC</sub> 90         AD0       1       DT/R/PIO4       71       PCS6/A2/PIO2       82       WHB       65         AD1       3       GND       12       RD       29       WLB       66         AD2       5       GND       35       RES       94       WR       28         AD3       7       GND       41       RTS0/RTR0/PIO20       26       X1       36	A17/PIO7	45	DEN/DS/PIO5	72		86	V <sub>CC</sub>	61
AD0         1         DT/R/PIO4         71         PCS6/A2/PIO2         82         WHB         65           AD1         3         GND         12         RD         29         WLB         66           AD2         5         GND         35         RES         94         WR         28           AD3         7         GND         41         RTS0/RTR0/PIO20         26         X1         36	A18/PIO8	43	DRQ0/INT5/PIO12	100		85	V <sub>CC</sub>	84
AD1       3       GND       12       RD       29       WLB       66         AD2       5       GND       35       RES       94       WR       28         AD3       7       GND       41       RTS0/RTR0/PIO20       26       X1       36	A19/PIO9	42	DRQ1/INT6/PIO13	99	PCS5/A1/PIO3	83	V <sub>CC</sub>	90
AD2         5         GND         35         RES         94         WR         28           AD3         7         GND         41         RTS0/RTR0/PIO20         26         X1         36	AD0	1	DT/R/PIO4	71	PCS6/A2/PIO2	82	WHB	65
AD3 7 GND 41 RTS0/RTR0/PIO20 26 X1 36	AD1	3	GND	12	RD	29	WLB	66
	AD2	5	GND	35	RES	94	WR	28
AD4 9 GND 64 RXD0/PIO23 24 X2 37	AD3	7	GND	41	RTS0/RTR0/PIO20	26	X1	36
	AD4	9	GND	64	RXD0/PIO23	24	X2	37

## PQFP CONNECTION DIAGRAMS AND PINOUTS

**Am186ED/EDLV Microcontrollers** 

## Top Side View—100-Pin Plastic Quad Flat Pack (PQFP)





## PQFP PIN DESIGNATIONS—Am186ED/EDLV Microcontrollers

## Sorted by Pin Number

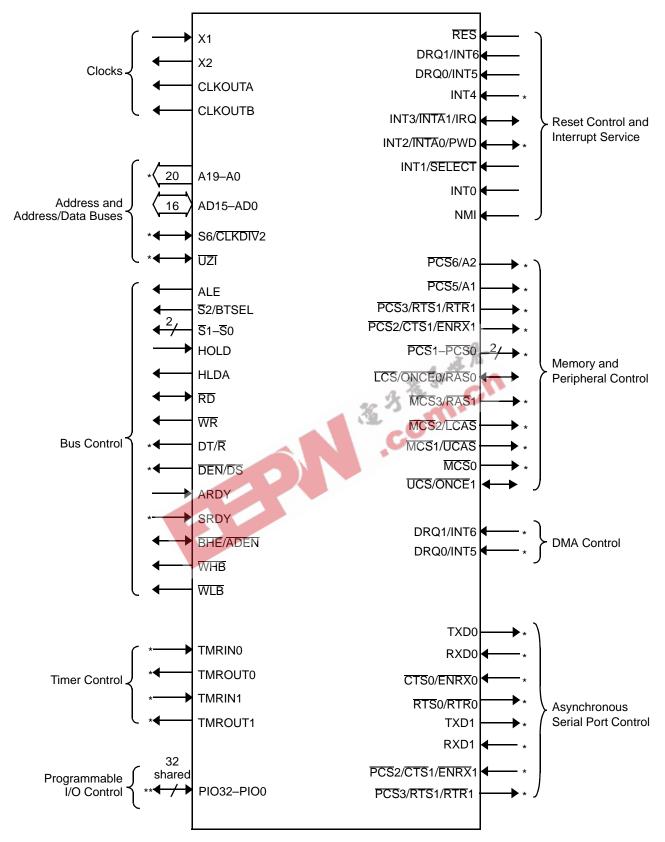
Pin No.	Name	Pin No.	Name	Pin No.	Name	Pin No.	Name
1	RXD0/PIO23	26	A13	51	MCS1/UCAS/PIO15	76	DRQ1/INT6/PIO13
2	TXD0/PIO22	27	A12	52	INT4/PIO30	77	DRQ0/INT5/PIO12
3	RTS0/RTR0/ PIO20	28	A11	53	INT3/INTA1/IRQ	78	AD0
4	BHE/ADEN	29	A10	54	INT2/INTA0/PWD/ PIO31	79	AD8
5	WR	30	A9	55	INT1/SELECT	80	AD1
6	RD	31	A8	56	INT0	81	AD9
7	ALE	32	A7	57	UCS/ONCE1	82	AD2
8	ARDY	33	A6	58	LCS/ONCE0/RAS0	83	AD10
9	S2/BTSEL	34	A5	59	PCS6/A2/PIO2	84	AD3
10	<del>S</del> 1	35	A4	60	PCS5/A1/PIO3	85	AD11
11	<u></u> 50	36	A3	61	V <sub>CC</sub>	86	AD4
12	GND	37	A2	62	PCS3/RTS1/RTR1/ PIO19	87	AD12
13	X1	38	V <sub>CC</sub>	63	PCS2/CTS1/ ENRX1/PIO18	88	AD5
14	X2	39	A1	64	GND	89	GND
15	V <sub>CC</sub>	40	A0	65	PCS1/PIO17	90	AD13
16	CLKOUTA	41	GND	66	PCS0/PIO16	91	AD6
17	CLKOUTB	42	WHB	67	V <sub>CC</sub>	92	V <sub>CC</sub>
18	GND	43	WLB	68	MCS2/LCAS/PIO24	93	AD14
19	A19/PIO9	44	HLDA	69	MCS3/RAS1/PIO25	94	AD7
20	A18/PIO8	45	HOLD	70	GND	95	AD15
21	V <sub>CC</sub>	46	SRDY/PIO6	71	RES	96	S6/CLKDIV2/PIO29
22	A17/PIO7	47	NMI	72	TMRIN1/PIO0	97	UZI/PIO26
23	A16	48	DT/R/PIO4	73	TMROUT1/PIO1	98	TXD1/PIO27
24	A15	49	DEN/DS/PIO5	74	TMROUT0/PIO10	99	RXD1/PIO28
25	A14	50	MCS0/PIO14	75	TMRIN0/PIO11	100	CTS0/ENRX0/PIO21

## PQFP PIN DESIGNATIONS—Am186ED/EDLV Microcontrollers

## Sorted by Pin Name

Pin Name	No.	Pin Name	No.	Pin Name	No.	Pin Name	No.
A0	40	AD5	88	GND	70	RXD1/PIO28	99
A1	39	AD6	91	GND	89	<u></u> \$0	11
A2	37	AD7	94	HLDA	44	<u></u>	10
A3	36	AD8	79	HOLD	45	S2/BTSEL	9
A4	35	AD9	81	INTO	56	S6/CLKDIV2/ PIO29	96
A5	34	AD10	83	INT1/SELECT	55	SRDY/PIO6	46
A6	33	AD11	85	INT2/INTA0/ PWD/PIO31	54	TMRIN0/PIO11	75
A7	32	AD12	87	INT3/INTA1/IRQ	53	TMRIN1/PIO0	72
A8	31	AD13	90	INT4/PIO30	52	TMROUT0/ PIO10	74
A9	30	AD14	93	LCS/ONCE0/RAS0	58	TMROUT1/PIO1	73
A10	29	AD15	95	MCS0/PIO14	50	TXD0/PIO22	2
A11	28	ALE	7	MCS1/UCAS/PIO15	51	TXD1/PIO27	98
A12	27	ARDY	8	MCS2/LCAS/PIO24	68	UCS/ONCE1	57
A13	26	BHE/ADEN	4	MCS3/RAS1/PIO25	69	UZI/PIO26	97
A14	25	CLKOUTA	16	NMI	47	V <sub>CC</sub>	15
A15	24	CLKOUTB	17	PCS0/PIO16	66	V <sub>CC</sub>	21
A16	23	CTS0/ENRX0/ PIO21	100	PCS1/PIO17	65	V <sub>CC</sub>	38
A17/PIO7	22	DEN/DS/PIO5	49	PCS2/CTS1/ENRX1/ PIO18	63	V <sub>CC</sub>	61
A18/PIO8	20	DRQ0/INT5/PIO12	77	PCS3/RTS1/RTR1/ PIO19	62	V <sub>CC</sub>	67
A19/PIO9	19	DRQ1/INT6/PIO13	76	PCS5/A1/PIO3	60	V <sub>CC</sub>	92
AD0	78	DT/R/PIO4	48	PCS6/A2/PIO2	59	WHB	42
AD1	80	GND	12	RD	6	WLB	43
AD2	82	GND	18	RES	71	WR	5
AD3	84	GND	41	RTS0/RTR0/PIO20	3	X1	13
AD4	86	GND	64	RXD0/PIO23	1	X2	14

## LOGIC SYMBOL—Am186ED/EDLV MICROCONTROLLERS



Notes:

\* These signals are the normal function of a pin that can be used as a PIO. See Pin Descriptions beginning on page 21 and Table 2 on page 29 for information on shared function.

\*\* All PIO signals are shared with other physical pins.

### **PIN DESCRIPTIONS**

### Pins That Are Used by Emulators

The following pins are used by emulators: A19–A0, AD7–AD0, ALE,  $\overline{BHE}/\overline{ADEN}$ , CLKOUTA,  $\overline{RD}$ ,  $\overline{S2}-\overline{S0}$ , S6/CLKDIV2, and  $\overline{UZI}$ .

Many emulators require S6/CLKDIV2 and UZI to be configured in their normal functionality as S6 and UZI, not as PIOs. If BHE/ADEN is held Low during the rising edge of RES, S6 and UZI are configured in their normal functionality.

### **Pin Terminology**

The following terms are used to describe the pins:

Input—An input-only pin.

**Output**—An output-only pin.

**Input/Output**—A pin that can be either input or output (I/O).

**Synchronous**—Synchronous inputs must meet setup and hold times in relation to CLKOUTA. Synchronous outputs are synchronous to CLKOUTA.

**Asynchronous**—Inputs or outputs that are asynchronous to CLKOUTA.

### A19–A0 (A19/PIO9, A18/PIO8, A17/PIO7)

### Address Bus (output, three-state, synchronous)

These pins supply nonmultiplexed memory or I/O addresses to the system one half of a CLKOUTA period earlier than the multiplexed address and data bus (AD15–AD0). During a bus hold or reset condition, the address bus is in a high-impedance state.

While the Am186ED/EDLV microcontrollers are directly connected to DRAM, A19–A0 will serve as the nonmultiplexed address bus for SRAM, FLASH, PROM, EPROM, and peripherals. The odd address pins (A17, A15, A13, A11, A9, A7, A5, A3, and A1) will have both the row and column address during a DRAM space access. The odd address signals connect directly to the row and column multiplexed address bus of the DRAM. The even address pins (A18, A16, A14, A12, A10, A8, A6, A4, A2, and A0) and A19 will have the initial address asserted during the full DRAM access. These signals will not transition during a DRAM access.

### AD15-AD8

## Address and Data Bus (input/output, three-state, synchronous, level-sensitive)

**AD15–AD8**—These time-multiplexed pins supply memory or I/O addresses and data to the system. This bus can supply an address to the system during the first period of a bus cycle  $(t_1)$ . It supplies data to the system during the remaining periods of that cycle ( $t_2$ ,  $t_3$ , and  $t_4$ ).

The address phase of these pins can be disabled. See the  $\overline{\text{ADEN}}$  description with the  $\overline{\text{BHE}}/\overline{\text{ADEN}}$  pin. When  $\overline{\text{WHB}}$  is deasserted, these pins are three-stated during  $t_2$ ,  $t_3$ , and  $t_4$ .

During a bus hold or reset condition, the address and data bus is in a high-impedance state.

During a power-on reset, the address and data bus pins (AD15–AD0) can also be used to load system configuration information into the internal reset configuration register.

When accesses are made to 8-bit-wide memory regions, AD15–AD8 drive their corresponding address signals throughout the access. If the disable address phase and 8-bit mode are selected (see the  $\overline{\text{ADEN}}$  description with the  $\overline{\text{BHE}}/\overline{\text{ADEN}}$  pin), then AD15–AD8 are three-stated during t<sub>1</sub> and driven with their corresponding address signal from t<sub>2</sub> to t<sub>4</sub>.

## AD7-AD0

Address and Data Bus (input/output, three-state, synchronous, level-sensitive)

These time-multiplexed pins supply partial memory or I/O addresses, as well as data, to the system. This bus supplies the low-order 8 bits of an address to the system during the first period of a bus cycle ( $t_1$ ), and it supplies data to the system during the remaining periods of that cycle ( $t_2$ ,  $t_3$ , and  $t_4$ ). In 8-bit mode, AD7– AD0 supplies the data for both high and low bytes.

The address phase of these pins can be disabled. See the  $\overline{\text{ADEN}}$  pin description with the  $\overline{\text{BHE}}/\overline{\text{ADEN}}$  pin. When  $\overline{\text{WLB}}$  is deasserted, these pins are three-stated during  $t_2$ ,  $t_3$ , and  $t_4$ .

During a bus hold or reset condition, the address and data bus is in a high-impedance state.

During a power-on reset, the address and data bus pins (AD15–AD0) can also be used to load system configuration information into the internal reset configuration register.

### ALE

### Address Latch Enable (output, synchronous)

This pin indicates to the system that an address appears on the address and data bus (AD15–AD0). The address is guaranteed to be valid on the trailing edge of ALE. This pin is three-stated during ONCE mode.

ALE is three-stated and held resistively Low during a bus hold condition. In addition, ALE has a weak internal pulldown resistor that is active during reset, so that an external device does not get a spurious ALE during reset.

## ARDY

## Asynchronous Ready (input, asynchronous, level-sensitive)

This pin is a true asynchronous ready that indicates to the microcontroller that the addressed memory space or I/O device will complete a data transfer. The ARDY pin is asynchronous to CLKOUTA and is active High. To guarantee the number of wait states inserted, ARDY or SRDY must be synchronized to CLKOUTA. If the falling edge of ARDY is not synchronized to CLKOUTA as specified, an additional clock period can be added.

To always assert the ready condition to the microcontroller, tie ARDY High. If the system does not use ARDY, tie the pin Low to yield control to SRDY.

### **BHE/ADEN**

#### Bus High Enable (three-state, output, synchronous) Address Enable (input, internal pullup)

**BHE**—During a memory access, this pin and the leastsignificant address bit (AD0 or A0) indicate to the system which bytes of the data bus (upper, lower, or both) participate in a bus cycle. The BHE/ADEN and AD0 pins are encoded as shown in Table 1.

### Table 1. Data Byte Encoding

BHE	AD0	Type of Bus Cycle	
0	0	Word Transfer	
0	1	High Byte Transfer (Bits 15–8)	
1	0	Low Byte Transfer (Bits 7–0)	
1	1	Reserved	

BHE is asserted during  $t_1$  and remains asserted through  $t_3$  and  $t_W$ . BHE does not need to be latched. BHE floats during bus hold and reset.

WLB and WHB implement the functionality of BHE and AD0 for High and Low byte-write enables. UCAS and LCAS implement High and Low-byte selection for DRAM devices.

BHE/ADEN also signals DRAM refresh cycles when using the multiplexed address and data (AD) bus. A refresh cycle is indicated when both BHE/ADEN and AD0 are High. During refresh cycles, the A bus is indeterminate and the AD bus is driven to FFFFh during the address phase of the AD bus cycle. For this reason, the A0 signal cannot be used in place of the AD0 signal to determine refresh cycles.

**ADEN**—If **BHE**/ADEN is held High or left floating during power-on reset, the address portion of the AD bus (AD15–AD0) is enabled or disabled during  $\overline{\text{LCS}}$  and  $\overline{\text{UCS}}$  bus cycles based on the DA bit in the LMCS and UMCS registers. If the DA bit is set, the AD bus will

not drive the address during  $t_1$ . There is a weak internal pullup resistor on  $\overline{BHE}/\overline{ADEN}$  so no external pullup is required. Disabling the address phase reduces power consumption.

If  $\overline{\text{BHE}/\text{ADEN}}$  is held Low on power-on reset, the AD bus drives both addresses and data, regardless of the DA bit setting. The pin is sampled on the rising edge of RES. (S6 and UZI also assume their normal functionality in this instance. See Table 2 on page 29.) The internal pullup on  $\overline{\text{ADEN}}$  is ~9 kohm.

**Note:** For 8-bit accesses, AD15–AD8 are driven with addresses during the  $t_2$ – $t_4$  bus cycle, regardless of the setting of the DA bit in the UMCS and LMCS registers.

### CLKOUTA

### Clock Output A (output, synchronous)

This pin supplies the internal clock to the system. Depending on the value of the system configuration register (SYSCON), CLKOUTA operates at either the PLL frequency (X1), the power-save frequency, or is held Low. CLKOUTA remains active during reset and bus hold conditions.

All AC timing specs that use a clock relate to CLKOUTA.

## CLKOUTB

### Clock Output B (output, synchronous)

This pin supplies an additional clock with a delayed output compared to CLKOUTA. Depending upon the value of the system configuration register (SYSCON), CLKOUTB operates at either the PLL frequency (X1), the power-save frequency, or is held Low. CLKOUTB remains active during reset and bus hold conditions.

CLKOUTB is not used for AC timing specs.

### CTS0/ENRX0/PIO21

#### Clear-to-Send 0 (input, asynchronous) Enable-Receiver-Request 0 (input, asynchronous)

**CTS0**—This pin provides the Clear-to-Send signal for asynchronous serial port 0 when the ENRX0 bit in the AUXCON register is 0 and hardware flow control is enabled for the port (FC bit in the serial port 0 control register is set). The CTS0 signal gates the transmission of data from the associated serial port transmit register. When CTS0 is asserted, the transmitter begins transmission of a frame of data, if any is available. If CTS0 is deasserted, the transmitter holds the data in the serial port transmit register. The value of CTS0 is checked only at the beginning of the transmission of the frame.

**ENRX0**—This pin provides the Enable Receiver Request for asynchronous serial port 0 when the ENRX0 bit in the AUXCON register is 1 and hardware flow control is enabled for the port (FC bit in the serial port 0 control register is set). The ENRX0 signal enables the receiver for the associated serial port.

## DEN/DS/PIO5

### Data Enable (output, three-state, synchronous) Data Strobe (output, three-state, synchronous)

**DEN**—This pin supplies an output enable to an external data-bus transceiver. DEN is asserted during memory, I/O, and interrupt acknowledge cycles. DEN is deasserted when DT/R changes state. DEN floats during a bus hold or reset condition.

 $\overline{\text{DS}}$ —The data strobe provides a signal where the write cycle timing is identical to the read cycle timing. When used with other control signals,  $\overline{\text{DS}}$  provides an interface for 68K-type peripherals without the need for additional system interface logic.

When  $\overline{\text{DS}}$  is asserted, addresses are valid. When  $\overline{\text{DS}}$  is asserted on writes, data is valid. When  $\overline{\text{DS}}$  is asserted on reads, data can be asserted on the AD bus.

Note: This pin resets to DEN.

### DRQ0/INT5/PIO12

#### DMA Request 0 (input, synchronous, level-sensitive) Maskable Interrupt Request 5 (input, asynchronous, edge-triggered)

**DRQ0**—This pin indicates to the microcontroller that an external device is ready for DMA channel 0 to perform a transfer. DRQ0 is level-triggered and internally synchronized. DRQ0 is not latched and must remain active until serviced.

**INT5**—If DMA 0 is not enabled or DMA 0 is not being used with external synchronization, INT5 can be used as an additional external interrupt request. INT5 shares the DMA 0 interrupt type (0Ah) and register control bits.

INT5 is edge-triggered only and must be held until the interrupt is acknowledged.

### DRQ1/INT6/PIO13

#### DMA Request 1 (input, synchronous, level-sensitive) Maskable Interrupt Request 6 (input, asynchronous, edge-triggered)

**DRQ1**—This pin indicates to the microcontroller that an external device is ready for DMA channel 1 to perform a transfer. DRQ1 is level-triggered and internally synchronized. DRQ1 is not latched and must remain active until serviced.

**INT6**—If DMA 1 is not enabled or DMA 1 is not being used with external synchronization, INT6 can be used as an additional external interrupt request. INT6 shares the DMA 1 interrupt type (0Bh) and register control bits.

INT6 is edge-triggered only and must be held until the interrupt is acknowledged.

### DT/R/PIO4

# Data Transmit or Receive (output, three-state, synchronous)

This pin indicates in which direction data should flow through an external data-bus transceiver. When  $DT/\overline{R}$  is asserted High, the microcontroller transmits data. When this pin is deasserted Low, the microcontroller receives data.  $DT/\overline{R}$  floats during a bus hold or reset condition.

### GND

### Ground

Ground pins connect the microcontroller to the system ground.

### HLDA

### Bus Hold Acknowledge (output, synchronous)

This pin is asserted High to indicate to an external bus master that the microcontroller has released control of the local bus. When an external bus master requests control of the local bus (by asserting HOLD), the microcontroller completes the bus cycle in progress. It then relinquishes control of the bus to the external bus master by asserting HLDA and floating DEN, RD, WR, S2–S0, AD15–AD0, S6, A19–A0, BHE, WHB, WLB, and DT/R. The following chip selects are three-stated (then will be held High with an ~10-kohm resistor): UCS, ICS, MCS3–MCS0, PCS6–PCS5, PCS3–PCS0, RAS0, RAS1, UCAS, and ICAS. ALE is also three-stated (then will be held Low with an ~10-kohm resistor).

When the external bus master has finished using the local bus, it indicates this to the microcontroller by deasserting HOLD. The microcontroller responds by deasserting HLDA.

If the microcontroller requires access to the bus (for example, to refresh), it will deassert HLDA before the external bus master deasserts HOLD. The external bus master must be able to deassert HOLD and allow the microcontroller access to the bus. See the timing diagrams for bus hold on page 86.

## HOLD

# Bus Hold Request (input, synchronous, level-sensitive)

This pin indicates to the microcontroller that an external bus master needs control of the local bus.

The Am186ED/EDLV microcontrollers' HOLD latency time, that is, the time between HOLD request and HOLD acknowledge, is a function of the activity occurring in the processor when the HOLD request is received. A HOLD request is second only to DRAM refresh requests in priority of activity requests received by the processor.

For more information, see the HLDA pin description on page 23.

### INT0

# Maskable Interrupt Request 0 (input, asynchronous)

This pin indicates to the microcontroller that an interrupt request has occurred. If the INTO pin is not masked, the microcontroller transfers program execution to the location specified by the INTO vector in the microcontroller interrupt vector table.

Interrupt requests are synchronized internally and can be edge-triggered or level-triggered. To guarantee interrupt recognition, the requesting device must continue asserting INTO until the request is acknowledged.

## INT1/SELECT

#### Maskable Interrupt Request 1 (input, asynchronous) Slave Select (input, asynchronous)

**INT1**—This pin indicates to the microcontroller that an interrupt request has occurred. If INT1 is not masked, the microcontroller transfers program execution to the location specified by the INT1 vector in the microcontroller interrupt vector table.

Interrupt requests are synchronized internally and can be edge-triggered or level-triggered. To guarantee interrupt recognition, the requesting device must continue asserting INT1 until the request is acknowledged.

**SELECT**—When the microcontroller interrupt control unit is operating as a slave to an external interrupt controller, this pin indicates to the microcontroller that an interrupt type appears on the address and data bus. The INTO pin must indicate to the microcontroller that an interrupt has occurred before the <u>SELECT</u> pin indicates to the microcontroller that the interrupt type appears on the bus.

## INT2/INTA0/PWD/PIO31

#### Maskable Interrupt Request 2 (input, asynchronous) Interrupt Acknowledge 0 (output, synchronous) Pulse Width Demodulator (input, Schmitt trigger)

**INT2**—This pin indicates to the microcontroller that an interrupt request has occurred. If the INT2 pin is not masked, the microcontroller transfers program execution to the location specified by the INT2 vector in the microcontroller interrupt vector table.

Interrupt requests are synchronized internally and can be edge-triggered or level-triggered. To guarantee

interrupt recognition, the requesting device must continue asserting INT2 until the request is acknowledged. INT2 becomes INTA0 when INT0 is configured in cascade mode.

**INTAO**—When the microcontroller interrupt control unit is operating in cascade mode, this pin indicates to the system that the microcontroller needs an interrupt type to process the interrupt request on INTO. The peripheral issuing the interrupt request must provide the microcontroller with the corresponding interrupt type.

**PWD**—If pulse width demodulation is enabled, PWD processes a signal through the Schmitt trigger. PWD is used internally to drive TIMERIN0 and INT2, and PWD is inverted internally to drive TIMERIN1 and INT4. If INT2 and INT4 are enabled and timer 0 and timer 1 are properly configured, the pulse width of the alternating PWD signal can be calculated by comparing the values in timer 0 and timer 1.

In PWD mode, the signals TIMERIN0/PIO11, TIMERIN1/PIO0, and INT4/PIO30 can be used as PIOs. If they are not used as PIOs, they are ignored internally. The level of INT2/INTA0/PWD/PIO31 is reflected in the PIO data register for PIO31 as if it was a PIO.

## INT3/INTA1/IRQ

Maskable Interrupt Request 3 (input, asynchronous) Interrupt Acknowledge 1 (output, synchronous) Slave Interrupt Request (output, synchronous)

**INT3**—This pin indicates to the microcontroller that an interrupt request has occurred. If the INT3 pin is not masked, the microcontroller then transfers program execution to the location specified by the INT3 vector in the microcontroller interrupt vector table.

Interrupt requests are synchronized internally, and can be edge-triggered or level-triggered. To guarantee interrupt recognition, the requesting device must continue asserting INT3 until the request is acknowledged. INT3 becomes INTA1 when INT1 is configured in cascade mode.

**INTA1**—When the microcontroller interrupt control unit is operating in cascade mode, this pin indicates to the system that the microcontroller needs an interrupt type to process the interrupt request on INT1. The peripheral issuing the interrupt request must provide the microcontroller with the corresponding interrupt type.

**IRQ**—When the microcontroller interrupt control unit is operating as a slave to an external master interrupt controller, this pin lets the microcontroller issue an interrupt request to the external master interrupt controller.

### INT4/PIO30

## Maskable Interrupt Request 4 (input, asynchronous)

This pin indicates to the microcontroller that an interrupt request has occurred. If the INT4 pin is not masked, the microcontroller then transfers program execution to the location specified by the INT4 vector in the microcontroller interrupt vector table.

Interrupt requests are synchronized internally, and can be edge-triggered or level-triggered. To guarantee interrupt recognition, the requesting device must continue asserting INT4 until the request is acknowledged.

When pulse width demodulation mode is enabled, the INT4 signal is used internally to indicate a High-to-Low transition on the PWD signal. When pulse width demodulation mode is enabled, INT4/PIO30 can be used as a PIO.

### LCS/ONCE0/RAS0

Lower Memory Chip Select (output, synchronous, internal pullup) ONCE Mode Request 0 (input) Row Address Strobe 0

**LCS**—This pin indicates to the system that a memory access is in progress to the lower memory block. The base address and size of the lower memory block are programmable up to 512 Kbytes. LCS is configured for 8-bit or 16-bit bus size by the auxiliary configuration register.

LCS is three-stated and held resistively High during a bus hold condition. In addition, LCS has an ~9-kohm internal pullup resistor that is active during reset.

**ONCE0**—During reset, this pin and ONCE1 indicate to the microcontroller the mode in which it should operate. ONCE0 and ONCE1 are sampled on the rising edge of RES. If both pins are asserted Low, the microcontroller enters ONCE mode; otherwise, it operates normally.

In ONCE mode, all pins assume a high-impedance state and remain in that state until a subsequent reset occurs. To guarantee that the microcontroller does not inadvertently enter ONCE mode, ONCE0 has a weak internal pullup resistor that is active only during reset.

**RAS0**—This pin is the row address strobe for the lower DRAM block. The selection of RAS0 or  $\overline{LCS}$  functionality, along with their configurations, are set using the LMCS register.

RAS0 is three-stated and held resistively High during a bus hold condition. In addition, RAS0 has a weak internal pullup resistor that is active during reset.

### MCS0/PIO14

# Midrange Memory Chip Select 0 (output, synchronous, internal pullup)

This pin indicates to the system that a memory access is in progress to the corresponding region of the midrange memory block. The base address and size of the midrange memory block are programmable. MCS0 can be programmed as the chip select for the entire middle chip select address range. This mode is recommended when using DRAM since the MCS1, MCS2, and MCS3 chip selects function as RAS and CAS signals for the DRAM interface and are not available as chip selects.

 $\overline{\text{MCS0}}$  is configured for 8-bit or 16-bit bus size by the auxiliary configuration register.  $\overline{\text{MCS0}}$  is three-stated and held resistively High during a bus hold condition. In addition,  $\overline{\text{MCS0}}$  has a weak internal pullup resistor that is active during reset.

### MCS1/UCAS/PIO15

#### Midrange Memory Chip Select (output, synchronous, internal pullup) Upper Column Address Strobe

This pin indicates to the system that a memory access is in progress to the corresponding region of the midrange memory block. The base address and size of the midrange memory block are programmable. MCS1 is configured for 8-bit or 16-bit bus size via the auxiliary configuration register.

 $\overline{\text{MCS}}$ 1 is three-stated and held resistively High during a bus hold condition. In addition,  $\overline{\text{MCS}}$ 1 has a weak internal pullup resistor that is active during reset.

If  $\overline{\text{MCSO}}$  is programmed to be active for the entire middle chip-select range, then this signal is available as a PIO or a DRAM control. If this signal is not programmed as a PIO or DRAM control and if  $\overline{\text{MCSO}}$  is programmed for the entire middle chip-select range, this signal operates normally.

**UCAS**—When either bank of DRAM is activated, the UCAS functionality is enabled. The UCAS activates when the DRAM access is for the AD15–AD8 byte. UCAS also activates at the start of a DRAM refresh access.

UCAS is three-stated and held resistively High during a bus hold condition. In addition, UCAS has a weak internal pullup resistor that is active during reset.

## MCS2/LCAS/PIO24

### Midrange Memory Chip Select (output, synchronous, internal pullup) Lower Column Address Strobe

This pin indicates to the system that a memory access is in progress to the corresponding region of the midrange memory block. The base address and size of the midrange memory block are programmable. MCS2 is configured for 8-bit or 16-bit bus size via the auxiliary configuration register.

MCS2 is three-stated and held resistively High during a bus hold condition. In addition, it has a weak internal pullup resistor that is active during reset.

If  $\overline{\text{MCS0}}$  is programmed to be active for the entire middle chip-select range, then this signal is available as a PIO or a DRAM control. If this pin is not programmed as a PIO or DRAM control and if  $\overline{\text{MCS0}}$  is programmed for the whole middle chip-select range, this signal operates normally.

**LCAS**—When either bank of DRAM is activated, the LCAS functionality is enabled. The LCAS activates when the DRAM access is for the AD7–AD0 byte. LCAS also activates at the start of a DRAM refresh access.

LCAS is three-stated and held resistively High during a bus hold condition. In addition, LCAS has a weak internal pullup resistor that is active during reset.

## MCS3/RAS1/PIO25

### Midrange Memory Chip Select 3 (output, synchronous, internal pullup) Row Address Strobe 1 (output, synchronous)

**MCS3**—This pin indicates to the system that a memory access is in progress to the fourth region of the midrange memory block. The base address and size of the mid-range memory block are programmable. MCS3 is configured for 8-bit or 16-bit bus size by the auxiliary configuration register.

MCS3 is three-stated and held resistively High during a bus hold condition. In addition, this pin has a weak internal pullup resistor that is active during reset.

If  $\overline{\text{MCS0}}$  is programmed for the entire middle chipselect range, then this signal is available as a PIO or a DRAM control. If  $\overline{\text{MCS3}}$  is not programmed as a PIO or DRAM control and if  $\overline{\text{MCS0}}$  is programmed for the entire middle chip-select range, this signal operates normally.

**RAS1**—This pin is the row address strobe for the upper DRAM block. The selection of RAS1 or UCS functionality, along with their configurations, are set using the UMCS register. When RAS1 is activated, the code activating RAS1 must not reside in the UCS memory block. When RAS1 is activated, UCS is automatically deactivated and remains negated.

 $\overline{RAS1}$  is three-stated and held resistively High during a bus hold condition. In addition,  $\overline{RAS1}$  has a weak internal pullup resistor that is active during reset.

### NMI

# Nonmaskable Interrupt (input, synchronous, edge-sensitive)

This pin indicates to the microcontroller that an interrupt request has occurred. The NMI signal is the highest priority hardware interrupt and, unlike the INT6–INT0 pins, cannot be masked. The microcontroller always transfers program execution to the location specified by the nonmaskable interrupt vector in the microcontroller interrupt vector table when NMI is asserted.

Although NMI is the highest priority interrupt source, it does not participate in the priority resolution process of the maskable interrupts. There is no bit associated with NMI in the interrupt in-service or interrupt request registers. This means that a new NMI request can interrupt an executing NMI interrupt service routine. As with all hardware interrupts, the IF (interrupt flag) is cleared when the processor takes the interrupt, disabling the maskable interrupt sources. However, if maskable interrupts are re-enabled by software in the NMI interrupt service routine, via the STI instruction for example, the fact that an NMI is currently in service does not have any effect on the priority resolution of maskable interrupt requests. For this reason, it is strongly advised that the interrupt service routine for NMI should not enable the maskable interrupts.

An NMI transition from Low to High is latched and synchronized internally, and it initiates the interrupt at the next instruction boundary. To guarantee that the interrupt is recognized, the NMI pin must be asserted for at least one CLKOUTA period.

## PCS1/PIO17, PCS0/PIO16

### Peripheral Chip Selects (output, synchronous)

These pins indicate to the system that a memory access is in progress to the corresponding region of the peripheral memory block (either I/O or memory address space). The base address of the peripheral memory block is programmable.

The  $\overline{\text{PCS}}$  chip selects can overlap either block of DRAM. The  $\overline{\text{PCS}}$  chip selects must have the same or greater number of wait states as the bank of DRAM they overlap. The  $\overline{\text{PCS}}$  signals take precedence over DRAM accesses when DRAM and memory-mapped peripherals overlap.

PCS1–PCS0 are three-stated and held resistively High during a bus hold condition. In addition, PCS1–PCS0 each have a weak internal pullup resistor that is active during reset.

Unlike the UCS and LCS chip selects, the PCS outputs assert with the multiplexed AD address bus. Note also that each peripheral chip select asserts over a 256byte address range, which is twice the address range covered by peripheral chip selects in the 80C186 and 80C188 microcontrollers.  $\overline{PCS0}$ – $\overline{PCS1}$  also have extended wait state options.

### PCS2/CTS1/ENRX1/PIO18

#### Peripheral Chip Select 2 (output, synchronous) Clear-to-Send 1 (input, asynchronous) Enable-Receiver-Request 1 (input, asynchronous)

**PCS2**—This pin provides the Peripheral Chip Select 2 signal to the system when hardware flow control is not enabled for asynchronous serial port 1. The PCS2 signal indicates to the system that a memory access is in progress to the corresponding region of the peripheral memory block (either I/O or memory address space). The base address of the peripheral memory block is programmable.

The  $\overline{PCS}$  chip selects can overlap either block of DRAM. The  $\overline{PCS}$  chip selects must have the same or greater number of wait states as the bank of DRAM they overlap. The  $\overline{PCS}$  signals take precedence over DRAM accesses when DRAM and memory-mapped peripherals overlap.

PCS2 is three-stated and held resistively High during a bus hold condition. In addition, PCS2 has a weak internal pullup resistor that is active during reset.

Unlike the UCS and LCS chip selects, the PCS outputs assert with the multiplexed AD address bus. Note also that each peripheral chip select asserts over a 256byte address range, which is twice the address range covered by peripheral chip selects in the 80C186 and 80C188 microcontrollers. PCS2 also has extended wait state options.

**CTS1**—This pin provides the Clear-to-Send signal for asynchronous serial port 1 when the ENRX1 bit in the AUXCON register is 0 and hardware flow control is enabled for the port (FC bit in the serial port 1 control register is set). The CTS1 signal gates the transmission of data from the associated serial port transmit register. When CTS1 is asserted, the transmitter begins transmission of a frame of data, if any is available. If CTS1 is deasserted, the transmitter holds the data in the serial port transmit register. The value of CTS1 is checked only at the beginning of the transmission of the frame.

**ENRX1**—This pin provides the Enable Receiver Request for asynchronous serial port 1 when the ENRX1 bit in the AUXCON register is 1 and hardware flow control is enabled for the port (FC bit in the serial port 1 control register is set). The ENRX1 signal enables the receiver for the associated serial port.

### PCS3/RTS1/RTR1/PIO19

#### Peripheral Chip Select 3 (output, synchronous) Ready-to-Send 1 (output, asynchronous) Ready-to-Receive 1 (output, asynchronous)

**PCS3**—This pin provides the Peripheral Chip Select 3 signal to the system when hardware flow control is not enabled for asynchronous serial port 1. The PCS3 signal indicates to the system that a memory access is in progress to the corresponding region of the peripheral memory block (either I/O or memory address space). The base address of the peripheral memory block is programmable.

The  $\overline{PCS}$  chip selects can overlap either block of DRAM. The  $\overline{PCS}$  chip selects must have the same or greater number of wait states as the bank of DRAM they overlap. The  $\overline{PCS}$  signals take precedence over DRAM accesses when DRAM and memory-mapped peripherals overlap.

PCS3 is three-stated and held resistively High during a bus hold condition. In addition, PCS3 has a weak internal pullup resistor that is active during reset.

Unlike the UCS and LCS chip selects, the PCS outputs assert with the multiplexed AD address bus. Note also that each peripheral chip select asserts over a 256byte address range, which is twice the address range covered by peripheral chip selects in the 80C186 and 80C188 microcontrollers. PCS3 also has extended wait state options.

**RTS1**—This pin provides the Ready-to-Send signal for asynchronous serial port 1 when the **RTS1** bit in the AUXCON register is 1 and hardware flow control is enabled for the port (FC bit in the serial port 1 control register is set). The **RTS1** signal is asserted when the associated serial port transmit register contains data which has not been transmitted.

**RTR1**—This pin provides the Ready-to-Receive signal for asynchronous serial port 1 when the **RTS1** bit in the AUXCON register is 0 and hardware flow control is enabled for the port (FC bit in the serial port 1 control register is set). The **RTR1** signal is asserted when the associated serial port receive register does not contain valid, unread data.

### PCS5/A1/PIO3

### Peripheral Chip Select 5 (output, synchronous) Latched Address Bit 1 (output, synchronous)

**PCS5**—This pin indicates to the system that a memory access is in progress to the sixth region of the peripheral memory block (either I/O or memory address space). The base address of the peripheral memory block is programmable.

The  $\overline{PCS}$  chip selects can overlap either block of DRAM. The  $\overline{PCS}$  chip selects must have the same or greater number of wait states as the bank of DRAM

they overlap. The PCS signals take precedence over DRAM accesses when DRAM and memory-mapped peripherals overlap.

PCS5 is three-stated and held resistively High during a bus hold condition. In addition, PCS5 has a weak internal pullup resistor that is active during reset.

Unlike the UCS and LCS chip selects, the PCS outputs assert with the multiplexed AD address bus. Note also that each peripheral chip select asserts over a 256byte address range, which is twice the address range covered by peripheral chip selects in the 80C186 and 80C188 microcontrollers. PCS5 also has extended wait state options.

**A1**—When the EX bit in the  $\overline{\text{MCS}}$  and  $\overline{\text{PCS}}$  auxiliary register is 0, this pin supplies an internally latched address bit 1 to the system. During a bus hold condition, A1 retains its previously latched value.

## PCS6/A2/PIO2

### Peripheral Chip Select 6 (output, synchronous) Latched Address Bit 2 (output, synchronous)

**PCS6**—This pin indicates to the system that a memory access is in progress to the seventh region of the peripheral memory block (either I/O or memory address space). The base address of the peripheral memory block is programmable.

The PCS chip selects can overlap either block of DRAM. The PCS chip selects must have the same or greater number of wait states as the bank of DRAM they overlap. The PCS signals take precedence over DRAM accesses when DRAM and memory-mapped peripherals overlap.

PCS6 is three-stated and held resistively High during a bus hold condition. In addition, PCS6 has a weak internal pullup resistor that is active during reset.

Unlike the UCS and LCS chip selects, the PCS outputs assert with the multiplexed AD address bus. Note also that each peripheral chip select asserts over a 256byte address range, which is twice the address range covered by peripheral chip selects in the 80C186 and 80C188 microcontrollers. PCS6 also has extended wait state options.

**A2**—When the EX bit in the  $\overline{\text{MCS}}$  and  $\overline{\text{PCS}}$  auxiliary register is 0, this pin supplies an internally latched address bit 2 to the system. During a bus hold condition, A2 retains its previously latched value.

## PIO31-PIO0 (Shared)

# Programmable I/O Pins (input/output, asynchronous, open-drain)

The Am186ED/EDLV microcontrollers provide 32 individually programmable I/O pins. Each PIO can be programmed with the following attributes: PIO function (enabled/disabled), direction (input/output), and weak

pullup or pulldown. The pins that are multiplexed with PIO31–PIO0 are listed in Table 2 and Table 3.

After power-on reset, the PIO pins default to various configurations. The column titled *Power-On Reset Status* in Table 2 and Table 3 lists the defaults for the PIOs. Most of the PIO pins are configured as PIO inputs with pullup after power-on reset. The system initialization code must reconfigure any PIO pins as required.

The A19–A17 address pins default to normal operation on power-on reset, allowing the processor to correctly begin fetching instructions at the boot address FFFF0h. The DT/R, DEN, and SRDY pins also default to normal operation on power-on reset. PIO15 and PIO24 should be set to normal operation before enabling either bank of DRAM. PIO25 should be set to normal operation before enabling the upper bank of DRAM.

## RD

### Read Strobe (output, synchronous, three-state)

 $\overline{RD}$ —This pin indicates to the system that the microcontroller is performing a memory or I/O read cycle.  $\overline{RD}$  is guaranteed to not be asserted before the address and data bus is floated during the address-to-data transition.  $\overline{RD}$  floats during a bus hold condition.

## RES

### Reset (input, asynchronous, level-sensitive)

This pin requires the microcontroller to perform a reset. When  $\overline{RES}$  is asserted, the microcontroller immediately terminates its present activity, clears its internal logic, and transfers CPU control to the reset address, FFFF0h.

RES must be held Low for at least 1 ms.

 $\overline{\text{RES}}$  can be asserted asynchronously to CLKOUTA because  $\overline{\text{RES}}$  is synchronized internally. For proper initialization,  $V_{CC}$  must be within specifications, and CLKOUTA must be stable for more than four CLKOUTA periods during which  $\overline{\text{RES}}$  is asserted.

The microcontroller begins fetching instructions approximately 6.5 CLKOUTA periods after  $\overline{\text{RES}}$  is deasserted. This input is provided with a Schmitt trigger to facilitate power-on  $\overline{\text{RES}}$  generation via an RC network.

PIO No	Associated Pin	Power-On Reset Status
0	TMRIN1	Input with pullup
1	TMROUT1	Input with pulldown
2	PCS6/A2	Input with pullup
3	PCS5/A1	Input with pullup
4	DT/R	Normal operation <sup>(3)</sup>
5	DEN/DS	Normal operation <sup>(3)</sup>
6	SRDY	Normal operation <sup>(4)</sup>
7 <sup>(1)</sup>	A17	Normal operation <sup>(3)</sup>
8 <sup>(1)</sup>	A18	Normal operation <sup>(3)</sup>
9 <sup>(1)</sup>	A19	Normal operation <sup>(3)</sup>
10	TMROUT0	Input with pulldown
11	TMRIN0	Input with pullup
12	DRQ0/INT5	Input with pullup
13	DRQ1/INT6	Input with pullup
14	MCS0	Input with pullup
15	MCS1/UCAS	Input with pullup
16	PCS0	Input with pullup
17	PCS1	Input with pullup
18	PCS2/CTS1/ENRX1	Input with pullup
19	PCS3/RTS1/RTR1	Input with pullup
20	RTS0/RTR0	Input with pullup
21	CTS0/ENRX0	Input with pullup
22	TXD0	Input with pullup
23	RXD0	Input with pullup
24	MCS2/LCAS	Input with pullup
25	MCS3/RAS1	Input with pullup
26 <sup>(1,2)</sup>	UZI	Input with pullup
27	TXD1	Input with pullup
28	RXD1	Input with pullup
29 <sup>(1,2)</sup>	S6/CLKDIV2	Input with pullup
30	INT4	Input with pullup
31	INT2/INTA0/PWD	Input with pullup

### Table 2. Numeric PIO Pin Designations

### Table 3. Alphabetic PIO Pin Designations

Associated Pin	PIO No	Power-On Reset Status
A17 <sup>(1)</sup>	7	Normal operation <sup>(3)</sup>
A18 <sup>(1)</sup>	8	Normal operation <sup>(3)</sup>
A19 <sup>(1)</sup>	9	Normal operation <sup>(3)</sup>
CTS0/ENRX0	21	Input with pullup
DEN/DS	5	Normal operation <sup>(3)</sup>
DRQ0/INT5	12	Input with pullup
DRQ1/INT6	13	Input with pullup
DT/R	4	Normal operation <sup>(3)</sup>
INT2/INTA0/PWD	31	Input with pullup
INT4	30	Input with pullup
MCS0	14	Input with pullup
MCS1/UCAS	15	Input with pullup
MCS2/LCAS	24	Input with pullup
MCS3/RAS1	25	Input with pullup
PCS0	16	Input with pullup
PCS1	17	Input with pullup
PCS2/CTS1/ENRX1	18	Input with pullup
PCS3/RTS1/RTR1	19	Input with pullup
PCS5/A1	3	Input with pullup
PCS6/A2	2	Input with pullup
RTS0/RTR0	20	Input with pullup
RXD0	23	Input with pullup
RXD1	28	Input with pullup
S6/CLKDIV2 <sup>(1,2)</sup>	29	Input with pullup
SRDY	6	Normal operation <sup>(4)</sup>
TMRIN0	11	Input with pullup
TMRIN1	0	Input with pullup
TMROUT0	10	Input with pulldown
TMROUT1	1	Input with pulldown
TXD0	22	Input with pullup
TXD1	27	Input with pullup
<u>UZI<sup>(1,2)</sup></u>	26	Input with pullup

### Notes:

The following notes apply to both tables.

- These pins are used by many emulators. (Emulators also use S2–S0, RES, NMI, CLKOUTA, BHE, ALE, AD15– AD0, and A16–A0.)
- 2. These pins revert to normal operation if BHE/ADEN is held Low during power-on reset.
- 3. When used as a PIO, input with pullup option available.
- 4. When used as a PIO, input with pulldown option available.

## RTS0/RTR0/PIO20

### Ready-to-Send 0 (output, asynchronous) Ready-to-Receive 0 (output, asynchronous)

**RTS0**—This pin provides the Ready-to-Send signal for asynchronous serial port 0 when the RTS0 bit in the AUXCON register is 1 and hardware flow control is enabled for the port (FC bit in the serial port 0 control register is set). The RTS0 signal is asserted when the associated serial port transmit register contains data that has not been transmitted.

**RTR0**—This pin provides the Ready-to-Receive signal for asynchronous serial port 0 when the **RTS0** bit in the AUXCON register is 0 and hardware flow control is enabled for the port (FC bit in the serial port 0 control register is set). The **RTR0** signal is asserted when the associated serial port receive register does not contain valid, unread data.

## RXD0/PIO23

### Receive Data 0 (input, asynchronous)

This pin supplies asynchronous serial receive data from the system to asynchronous serial port 0.

### RXD1/PIO28

### Receive Data 1 (input, asynchronous)

This pin supplies asynchronous serial receive data from the system to asynchronous serial port 1.

### S2/BTSEL

## Bus Cycle Status (output, three-state, synchronous) Boot Mode Select

 $\overline{S2}$ —This pin indicates to the system the type of bus cycle in progress.  $\overline{S2}$  can be used as a logical memory or I/O indicator.  $\overline{S2}$ — $\overline{S0}$  float during bus hold and hold acknowledge conditions. The  $\overline{S2}$ — $\overline{S0}$  pins are encoded as shown in Table 4.

**BTSEL**—The Am186ED/EDLV microcontrollers can boot from 8- or 16-bit wide nonvolatile memory, based on the state of the BTSEL pin. If BTSEL is pulled High or left floating, an internal pullup sets the boot mode option to 16-bit. If BTSEL is pulled resistively Low during reset, the 8-bit boot mode option is selected. The status of the BTSEL pin is latched on the rising edge of reset. If 8-bit mode is selected, the width of the memory region associated with UCS can be changed in the AUXCON register.

This signal should never be tied to  $V_{CC}$  or  $V_{SS}$  directly since this pin is driven during normal operation. This signal should be tied Low with an external resistor if the 8-bit boot mode is to be used. The internal pullup resistor on BTSEL is ~9 kohm.

### 

# Bus Cycle Status (output, three-state, synchronous)

These pins indicate to the system the type of bus cycle in progress.  $\overline{S1}$  can be used as a data transmit or receive indicator.  $\overline{S1}$ – $\overline{S0}$  float during bus hold and hold acknowledge conditions. The  $\overline{S2}$ – $\overline{S0}$  pins are encoded as shown in Table 4.

Table 4.	Bus	Cycle	Encoding
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S2/BTSEL	<u></u> <u> </u> <u> </u> S 1	<u></u> 50	Bus Cycle
0	0	0	Interrupt acknowledge
0	0	1	Read data from I/O
0	1	0	Write data to I/O
0	1	1	Halt
1	0	0	Instruction fetch
1	0	1	Read data from memory
1	1	0	Write data to memory
1	1_4	1	None (passive)

## S6/CLKDIV2/PIO29

### Bus Cycle Status Bit 6 (output, synchronous) Clock Divide by 2 (input, internal pullup)

**S6**—During the second and remaining periods of a cycle ( $t_2$ ,  $t_3$ , and  $t_4$ ), this pin is asserted High to indicate a DMA-initiated bus cycle. During a bus hold or reset condition, S6 floats.

**CLKDIV2**—If S6/CLKDIV2/PIO29 is held Low during power-on reset, the chip enters clock divided by 2 mode where the processor clock is derived by dividing the external clock input by 2. If this mode is selected, the PLL is disabled. The pin is sampled on the rising edge of RES.

If S6 is to be used as PIO29 in input mode, the device driving PIO29 must not drive the pin Low during poweron reset. S6/CLKDIV2/PIO29 defaults to a PIO input with pullup, so the pin does not need to be driven High externally.

### SRDY/PIO6

# Synchronous Ready (input, synchronous, level-sensitive)

This pin indicates to the microcontroller that the addressed memory space or I/O device will complete a data transfer. The SRDY pin accepts an active High input synchronized to CLKOUTA.

Using SRDY instead of ARDY allows a relaxed system timing because of the elimination of the one-half clock period required to internally synchronize ARDY. To always assert the ready condition to the microcontroller, tie SRDY High. If the system does not use SRDY, tie the pin Low to yield control to ARDY.

### TMRIN0/PIO11

### Timer Input 0 (input, synchronous, edge-sensitive)

This pin supplies a clock or control signal to the internal microcontroller timer 0. After internally synchronizing a Low-to-High transition on TMRIN0, the microcontroller increments the timer. TMRIN0 must be tied High if not being used. When PIO11 is enabled, TMRIN0 is pulled High internally.

TMRINO is driven internally by INT2/INTA0/PWD when pulse width demodulation mode is enabled. The TMRIN0/PIO11 pin can be used as a PIO when pulse width demodulation mode is enabled.

### TMRIN1/PIO0

### Timer Input 1 (input, synchronous, edge-sensitive)

This pin supplies a clock or control signal to the internal microcontroller timer 1. After internally synchronizing a Low-to-High transition on TMRIN1, the microcontroller increments the timer. TMRIN1 must be tied High if not being used. When PIO0 is enabled, TMRIN1 is pulled High internally.

TMRIN1 is driven internally by INT2/INTA0/PWD when pulse width demodulation mode is enabled. The TMRIN1/PIO0 pin can be used as a PIO when pulse width demodulation mode is enabled.

## TMROUT0/PIO10

### Timer Output 0 (output, synchronous)

This pin supplies the system with either a single pulse or a continuous waveform with a programmable duty cycle. TMROUT0 is floated during a bus hold or reset.

## TMROUT1/PIO1

### Timer Output 1 (output, synchronous)

This pin supplies the system with either a single pulse or a continuous waveform with a programmable duty cycle. TMROUT1 floats during a bus hold or reset.

### TXD0/PIO22

### Transmit Data 0 (output, asynchronous)

This pin supplies asynchronous serial transmit data to the system from serial port 0.

## TXD1/PIO27

### Transmit Data 1 (output, asynchronous)

This pin supplies asynchronous serial transmit data to the system from serial port 1.

### UCS/ONCE1

### Upper Memory Chip Select (output, synchronous) ONCE Mode Request 1 (input, internal pullup)

**UCS**—This pin indicates to the system that a memory access is in progress to the upper memory block. The base address and size of the upper memory block are programmable up to 512 Kbytes.

UCS is three-stated and held resistively High during a bus hold condition. In addition, UCS has an ~9-kohm internal pullup resistor that is active during reset.

After reset, UCS is active for the 64 Kbyte memory range from F0000h to FFFFh, including the reset address of FFFF0h.

When  $\overline{RAS1}$  is activated, the code activating  $\overline{RAS1}$  must not reside in the  $\overline{UCS}$  memory block. When  $\overline{RAS1}$  is activated,  $\overline{UCS}$  is automatically deactivated and remains negated. This allows code to boot from  $\overline{UCS}$ , copy its code to another memory device, then activate a DRAM bank in place of the  $\overline{UCS}$  memory block.

**ONCE1**—During reset, this pin and LCS/ONCE0 indicate to the microcontroller the mode in which it should operate. ONCE0 and ONCE1 are sampled on the rising edge of RES. If both pins are asserted Low, the microcontroller enters ONCE mode. Otherwise, it operates normally. In ONCE mode, all pins assume a high-impedance state and remain in that state until a subsequent reset occurs. To guarantee that the microcontroller does not inadvertently enter ONCE mode, ONCE1 has a weak internal pullup resistor that is active only during a reset.

## UZI/PIO26

### Upper Zero Indicate (output, synchronous)

This pin lets the designer determine if an access to the interrupt vector table is in progress by ORing it with bits 15-10 of the address and data bus (AD15-AD10). UZI is the logical AND of the inverted A19-A16 bits. It asserts in the first period of a bus cycle and is held throughout the cycle.

### V<sub>CC</sub>

### **Power Supply (input)**

These pins supply power (+5 V) to the microcontroller.

### WHB

### Write High Byte (output, three-state, synchronous)

This pin and  $\overline{\text{WLB}}$  indicate to the system which bytes of the data bus (upper, lower, or both) participate in a write cycle. In 80C186 microcontroller designs, information is provided by BHE, AD0, and  $\overline{\text{WR}}$ . However, by using  $\overline{\text{WHB}}$  and  $\overline{\text{WLB}}$ , the standard system interface logic and external address latch that were required are eliminated.

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 $\overline{\text{WHB}}$  is asserted with AD15–AD8.  $\overline{\text{WHB}}$  is the logical OR of  $\overline{\text{BHE}}$  and  $\overline{\text{WR}}$ . This pin floats during reset.

## WLB

### Write Low Byte (output, three-state, synchronous)

**WLB**—This pin and  $\overline{\text{WHB}}$  indicate to the system which bytes of the data bus (upper, lower, or both) participate in a write cycle. In 80C186 microcontroller designs, this information is provided by  $\overline{\text{BHE}}$ , AD0, and  $\overline{\text{WR}}$ . However, by using  $\overline{\text{WHB}}$  and  $\overline{\text{WLB}}$ , the standard system interface logic and external address latch that were required are eliminated.

WLB is asserted with AD7–AD0. WLB is the logical OR of AD0 and WR. This pin floats during reset.

## WR

### Write Strobe (output, synchronous)

**WR**—This pin indicates to the system that the data on the bus is to be written to a memory or I/O device. WR floats during a bus hold or reset condition. WR should be used for DRAM write enable.

## X1

### **Crystal Input (input)**

This pin and the X2 pin provide connections for a fundamental mode or third-overtone, parallel-resonant crystal used by the internal oscillator circuit. To provide the microcontroller with an external clock source, connect the source to the X1 pin and leave the X2 pin unconnected.

## X2

### **Crystal Output (output)**

This pin and the X1 pin provide connections for a fundamental mode or third-overtone, parallel-resonant crystal used by the internal oscillator circuit. To provide the microcontroller with an external clock source, leave the X2 pin unconnected and connect the source to the X1 pin.

### FUNCTIONAL DESCRIPTION

The Am186ED/EDLV microcontrollers are based on the architecture of the 80C186 and 80C188 microcontrollers. The Am186ED/EDLV microcontrollers function in the enhanced mode of earlier generations of 80C186 and 80C188 microcontrollers. Enhanced mode includes system features such as power-save control.

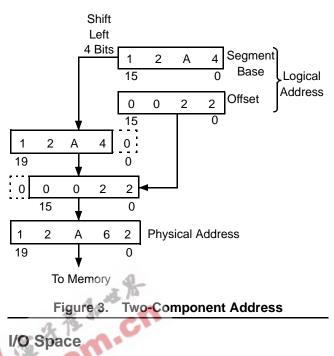
Each of the 8086, 8088, 80186, and 80188 microcontrollers contains the same basic set of registers, instructions, and addressing modes. The Am186ED/ EDLV microcontrollers are backward-compatible with the 80C186 and 80C188 microcontrollers.

A full description of all the Am186ED/EDLV microcontroller registers and instructions is included in the *Am186ED/EDLV Microcontrollers User's Manual*, order# 21335A.

### **Memory Organization**

Memory is organized in sets of segments. Each segment is a linear contiguous sequence of 64K (216) 8-bit bytes. Memory is addressed using a two-component address that consists of a 16-bit segment value and a 16-bit offset. The 16-bit segment values are contained in one of four internal segment registers (CS, DS, SS, or ES). The physical address is calculated by shifting the segment value left by 4 bits and adding the 16-bit offset value to yield a 20-bit physical address (see Figure 3). This allows for a 1-Mbyte physical address size.

All instructions that address operands in memory must specify the segment value and the 16-bit offset value. For speed and compact instruction encoding, the segment register used for physical address generation is implied by the addressing mode used (see Table 5).



The I/O space consists of 64K 8-bit or 32K 16-bit ports. Separate instructions (IN, INS and OUT, OUTS) address the I/O space with either an 8-bit port address specified in the instruction, or a 16-bit port address in the DX register. Eight-bit port addresses are zero-extended such that A15–A8 are Low. I/O port addresses 00F8h through 00FFh are reserved.

Memory Reference Needed	Segment Register Used	Implicit Segment Selection Rule
Instructions	Code (CS)	Instructions (including immediate data)
Local Data	Data (DS)	All data references
Stack	Stack (SS)	All stack pushes and pops; any memory references that use BP Register
External Data (Global)	Extra (ES)	All string instruction references that use the DI Register as an index

### Table 5. Segment Register Selection Rules

## **BUS OPERATION**

The industry-standard 80C186 and 80C188 microcontrollers use a multiplexed address and data (AD) bus. The address is present on the AD bus only during the t<sub>1</sub> clock phase. The Am186ED/EDLV microcontrollers continue to provide the multiplexed AD bus and, in addition, provides a nonmultiplexed address (A) bus. The A bus provides an address to the system for the complete bus cycle  $(t_1-t_4)$ .

For systems where power consumption is a concern, it is possible to disable the address from being driven on the AD bus during the normal address portion of the bus cycle for accesses to RAS0, RAS1, UCS, and/or LCS address spaces. In this mode, the affected bus is placed in a high-impedance state during the address portion of the bus cycle. This feature is enabled through the DA bits in the UMCS and LMCS registers. When address disable is in effect, the number of signals that assert on the bus during all normal bus cycles to the associated address space is reduced, decreasing power consumption and reducing processor switching noise. In 8-bit mode, the address is driven on AD15–AD8 during the data portion of the bus cycle regardless of the setting of the DA bits.

If the ADEN pin is pulled Low during processor reset, the value of the DA bits in the UMCS and LMCS registers is ignored and the address is driven on the AD bus for all accesses, thus preserving the industry-standard 80C186 and 80C188 microcontrollers' multiplexed address bus and providing support for existing emulation tools.

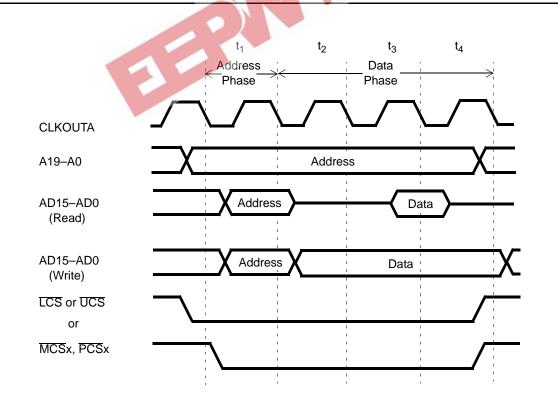
The following diagrams show the bus cycles of the Am186ED/EDLV microcontrollers when the address bus disable feature is in effect:

Figure 4 shows the affected signals during a normal read or write operation for 16-bit mode. The address and data are multiplexed onto the AD bus.

Figure 5 shows a 16-bit mode bus cycle when address bus disable is in effect. This results in the AD bus operating in a nonmultiplexed address/data mode. The A bus has the address during a read or write operation.

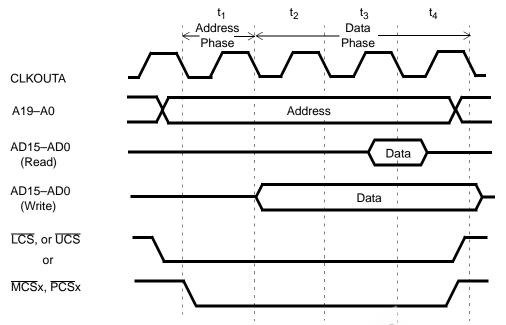
Figure 6 shows the affected signals during a normal read or write operation for 8-bit mode. The multiplexed address/data mode is compatible with the 80C186 and 80C188 microcontrollers and might be used to take advantage of existing logic or peripherals.

Figure 7 shows an 8-bit mode bus cycle when address bus disable is in effect. The address and data are not multiplexed. The AD7–AD0 signals have only data on the bus, while the AD bus has the address during a read or write operation.



**Note:** For a detailed description of DRAM control signals, see DRAM switching characteristics beginning on page 70.

Figure 4. 16-Bit Mode—Normal Read and Write Operation



**Note:** For a detailed description of DRAM control signals, see DRAM switching characteristics beginning on page 70.



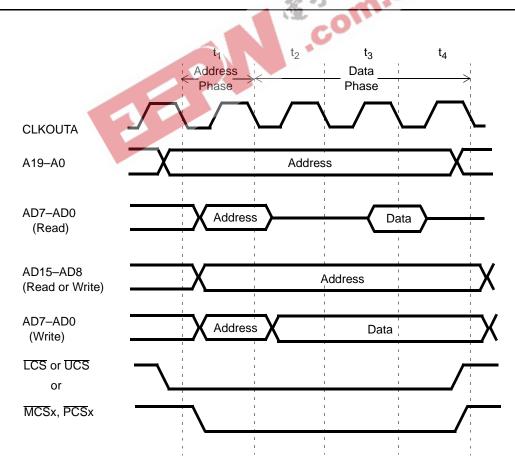
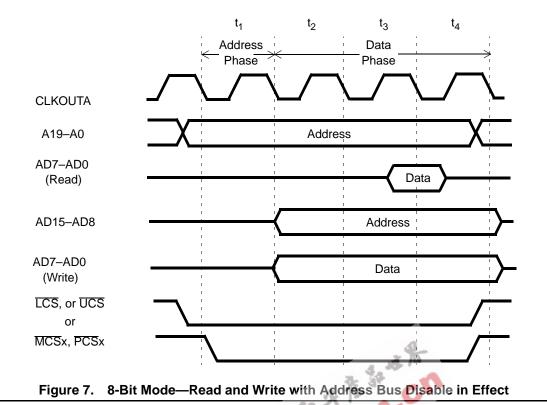


Figure 6. 8-Bit Mode—Normal Read and Write Operation



### **BUS INTERFACE UNIT**

The bus interface unit controls all accesses to external peripherals and memory devices. External accesses include those to memory devices, as well as those to memory-mapped and I/O-mapped peripherals and the peripheral control block. The Am186ED/EDLV microcontrollers provide an enhanced bus interface unit with the following features:

- A nonmultiplexed address bus
- DRAM address multiplexing
- A static bus-sizing option for 8-bit and 16-bit memory and I/O
- Separate byte write enables and CAS for High and Low bytes
- Data strobe bus interface option

The standard 80C186/188 microcontroller multiplexed address and data bus requires system interface logic and an external address latch. On the Am186ED/EDLV microcontrollers, new byte write enables, DRAM control logic, and a new nonmultiplexed address bus can reduce design costs by eliminating this external logic.

The standard 80C186/188 microcontroller required external DRAM controller logic and DRAM address multiplex circuitry for interfacing to DRAM. On the Am186ED/EDLV microcontrollers, the integrated DRAM controller and internal address multiplexing can reduce design costs by eliminating this external logic. Further, system costs can be reduced for systems using more than 64K of RAM by replacing SRAM with less expensive DRAM.

## **Nonmultiplexed Address Bus**

The nonmultiplexed address bus (A19–A0) is valid one-half CLKOUTA cycle in advance of the address on the AD bus. When used in conjunction with the modified  $\overline{UCS}$  and  $\overline{LCS}$  outputs and the byte-write enable signals, the A19–A0 bus provides a seamless interface to SRAM, and Flash EPROM memory systems.

## **DRAM Address Multiplexing**

The A19–A0 address bus also provides the addresses for the DRAM. When RAS0 or RAS1 asserts for a read or write, all the address signals are valid. This allows the DRAM to latch the odd addresses into the row address. Before the UCAS and/or LCAS asserts, the odd addresses A17–A1 change to reflect the even addresses. This allows the DRAM to latch in the even addresses into the column address. During a refresh cycle, the entire A19–A0 address bus is stable but undefined. The internal address and that reflected on the AD bus is all 1s. The DRAM pin interface is shown in Table 6.

#### Table 6. DRAM Pin Interface

AM186ED/EDLV Microcontroller Pins	DRAM Pin
A1	MA0
A3	MA1
A5	MA2
A7	MA3
A9	MA4
A11	MA5
A13	MA6
A15	MA7
A17	MA8
RAS0	RAS (Bank 0)
RAS1	RAS (Bank 1)
UCAS	UCAS (AD15–AD8 Byte)
LCAS	LCAS (AD7–AD0 Byte)
RD	OE
WR	WE

# **Programmable Bus Sizing**

The Am186ED/EDLV microcontrollers allow programmability for data bus widths through fields in the Auxiliary Configuration Register (AUXCON), as shown in Table 7. The USIZ bit in AUXCON is only configurable if the boot mode is 8-bit at reset.

The width of the data access should not be modified while the processor is fetching instructions from the associated address space.

#### Table 7. Programming the Bus Width of Am186ED/EDLV Microcontrollers

Space	AUXCON Field	Value	Bus Width	Comments
UCS	USIZ	0	16 bits	Dependent on boot option <sup>1</sup>
		1	8 bits	
LCS	LSIZ	0	16 bits	Default
		1	8 bits	
I/O	IOSIZ	0	16 bits	Default
		1	8 bits	
Other	MSIZ	0	16 bits	Default
		1	8 bits	

#### Note:

1. UCS width on reset is determined by the S2/BTSEL pin. If UCS boots as a 16-bit space, it is not re-con-figurable to 8-bit.

### Byte-Write Enables

The Am186ED/EDLV microcontrollers provide the  $\overline{WHB}$  (Write High Byte) and  $\overline{WLB}$  (Write Low Byte) signals, which act as byte-write enables.

 $\overline{\text{WHB}}$  is the logical OR of  $\overline{\text{BHE}}$  and  $\overline{\text{WR}}$ .  $\overline{\text{WHB}}$  is Low when  $\overline{\text{BHE}}$  and  $\overline{\text{WR}}$  are both Low.  $\overline{\text{WLB}}$  is the logical OR of A0 and  $\overline{\text{WR}}$ .  $\overline{\text{WLB}}$  is Low when A0 and  $\overline{\text{WR}}$  are both Low.

The byte-write enables are driven in conjunction with the nonmultiplexed address bus as required for the write timing requirements of common SRAMs.

# **Data Strobe Bus Interface Option**

The Am186ED/EDLV microcontrollers provide an asynchronous bus interface that allows the use of 68K-type peripherals. This implementation combines a  $\overline{\text{DS}}$  data strobe signal (multiplexed with  $\overline{\text{DEN}}$ ) with an asynchronous ARDY ready input. When  $\overline{\text{DS}}$  is asserted, the data and address signals are valid.

A chip select signal, ARDY,  $\overline{DS}$ , and other control signals ( $\overline{RD}/\overline{WR}$ ) can control the interface of 68K-type external peripherals to the AD bus.

# DRAM INTERFACE

The Am186ED/EDLV microcontrollers support up to two banks of DRAM. The use of DRAM can significantly reduce the memory costs for applications using more than 64K of RAM. No performance is lost except for the slight overhead of periodically refreshing the DRAM. The lower bank of DRAM uses the LCS space. The upper bank of DRAM uses the UCS space. Either, neither, or both banks can be activated. When either bank is activated, the UCAS and LCAS are enabled, and the DRAM address multiplexing is enabled on the A19–A0 bus. When DRAM is activated, the corresponding memory bus size should be set to 16-bit. The use of 8-bit-wide DRAM is not supported. All refreshes to DRAM are 7 clocks long. The refreshes must be separately enabled in the RCU.

The improved memory timing specifications of the Am186ED/EDLV microcontrollers allow for zero-waitstate operation using 50-ns DRAM at a 40-MHz clock speed. 60-ns DRAM requires one wait state at 40 MHz and zero wait states at 33 MHz and below. 70-ns DRAM requires two wait states at 40 MHz, one wait state at 33 MHz, and zero wait states at 25 MHz and below. This reduces overall system cost by enabling the use of commonly available memory speeds and taking advantage of DRAM's lower cost per bit over SRAM.

# PERIPHERAL CONTROL BLOCK

The integrated peripherals of the Am186ED/EDLV microcontrollers are controlled by 16-bit read/write registers. The peripheral registers are contained within an internal 256-byte peripheral control block (PCB). The registers are physically located in the peripheral devices they control, but they are addressed as a single 256-byte block. Table 8 shows a map of these registers.

### Reading and Writing the PCB

Code written for the Am186ED/EDLV microcontrollers should perform all writes to the PCB registers as byte writes. These writes transfer 16 bits of data to the PCB register even if an 8-bit register is named in the instruction. For example, out dx, al results in the value of ax being written to the port address in dx. Reads to the PCB should be done as word reads. Code written in this manner runs correctly on the Am186ED/EDLV microcontrollers with the PCB overlayed on either 8- or 16-bit address spaces.

Unaligned reads and writes to the PCB result in unpredictable behavior.

透力意味着。 For a complete description of all the registers in the PCB, see the Am186ED/EDLV Microcontrollers User's Manual. order# 21335A.

#### Table 8. Peripheral Control Block Register Map

Register Name	Offset
Processor Control Registers:	
Peripheral control block relocation register	FEh
Reset configuration register	F6h
Processor release level register <sup>1</sup>	F4h
Auxiliary configuration register <sup>1</sup>	F2h
System configuration register <sup>1</sup>	F0h
Watchdog timer control register	E6h
Enable RCU register <sup>1</sup>	E4h
Clock prescaler register <sup>1</sup>	E2h
(See note 2.)	
DMA Registers:	
DMA 1 control register	DAh
DMA 1 transfer count register	D8h
DMA 1 destination address high register	D6h
DMA 1 destination address low register	D4h
DMA 1 source address high register	D2h
DMA 1 source address low register	D0h
DMA 0 control register	CAh
DMA 0 transfer count register	C8h
DMA 0 destination address high register	C6h
DMA 0 destination address low register	C4h
DMA 0 source address high register	C2h
DMA 0 source address low register	C0h
Chip-Select Registers:	
PCS and MCS auxiliary register	A8h
Midrange memory chip-select register	A6h
Peripheral chip-select register	A4h
Low memory chip-select register <sup>1</sup>	A2h
Upper memory chip-select register <sup>1</sup>	A0h
Serial Port 0 Registers:	
Serial Port 0 Registers: Serial port 0 baud rate divisor register	88h
	88h 86h
Serial port 0 baud rate divisor register	
Serial port 0 baud rate divisor register Serial port 0 receive register	86h
Serial port 0 baud rate divisor register Serial port 0 receive register Serial port 0 transmit register	86h 84h
Serial port 0 baud rate divisor register Serial port 0 receive register Serial port 0 transmit register Serial port 0 status register	86h 84h 82h
Serial port 0 baud rate divisor register Serial port 0 receive register Serial port 0 transmit register Serial port 0 status register Serial port 0 control register	86h 84h 82h
Serial port 0 baud rate divisor register Serial port 0 receive register Serial port 0 transmit register Serial port 0 status register Serial port 0 control register PIO Registers:	86h 84h 82h 80h
Serial port 0 baud rate divisor register Serial port 0 receive register Serial port 0 transmit register Serial port 0 status register Serial port 0 control register <b>PIO Registers:</b> PIO data 1 register	86h 84h 82h 80h 7Ah
Serial port 0 baud rate divisor register Serial port 0 receive register Serial port 0 transmit register Serial port 0 status register Serial port 0 control register <b>PIO Registers:</b> PIO data 1 register PIO direction 1 register	86h 84h 82h 80h 7Ah 78h
Serial port 0 baud rate divisor register Serial port 0 receive register Serial port 0 transmit register Serial port 0 status register Serial port 0 control register PIO Registers: PIO data 1 register PIO direction 1 register PIO mode 1 register	86h 84h 82h 80h 7Ah 78h 76h
Serial port 0 baud rate divisor register Serial port 0 receive register Serial port 0 transmit register Serial port 0 status register Serial port 0 control register PIO Registers: PIO data 1 register PIO direction 1 register PIO mode 1 register PIO data 0 register	86h 84h 82h 80h 7Ah 78h 76h 74h
Serial port 0 baud rate divisor register Serial port 0 receive register Serial port 0 transmit register Serial port 0 status register Serial port 0 control register <b>PIO Registers:</b> PIO data 1 register PIO direction 1 register PIO mode 1 register PIO data 0 register PIO direction 0 register	86h 84h 82h 80h 7Ah 78h 76h 74h 72h

Register Name	Offset
Timer 2 max count compare A register	62h
Timer 2 count register	60h
Timer 1 mode/control register	5Eh
Timer 1 max count compare B register	5Ch
Timer 1 max count compare A register	5Ah
Timer 1 count register	58h
Timer 0 mode/control register	56h
Timer 0 max count compare B register	54h
Timer 0 max count compare A register	52h
Timer 0 count register	50h
Interrupt Registers:	
Serial port 0 interrupt control register	44h
Serial port 1 interrupt control register	42h
INT4 interrupt control register	40h
INT3 control register	3Eh
INT2 control register	3Ch
INT1 control register	3Ah
INT0 control register	38h
DMA1/INT6 interrupt control register	36h
DMA0/INT5 interrupt control register	34h
Timer interrupt control register	32h
Interrupt status register	30h
Interrupt request register	2Eh
Interrupt in-service register	2Ch
Interrupt priority mask register	2Ah
Interrupt mask register	28h
Interrupt poll status register	26h
Interrupt poll register	24h
End-of-interrupt register	22h
Interrupt vector register	20h
Serial Port 1 Registers:	
Serial port 1 baud rate divisor register	18h
Serial port 1 receive register	16h
Serial port 1 transmit register	14h
Serial port 1 status register	12h
Serial port 1 control register	10h

All unused addresses are reserved and should not be accessed.

#### Notes:

- 1. The register has been modified from the Am186ES/ Am188ES microcontrollers.
- 2. The previous Memory Partition Register (MDRAM) has been removed and its functionality replaced with the CAS-before-RAS refresh mode.

# CLOCK AND POWER MANAGEMENT

The clock and power management unit of the Am186ED/EDLV microcontrollers includes a phaselocked loop (PLL) and a second programmable system clock output (CLKOUTB).

# Phase-Locked Loop

In a traditional 80C186/188 microcontroller design, the crystal frequency is twice that of the desired internal clock. Because of the PLL on the Am186ED/EDLV microcontrollers, the internal clock generated by the Am186ED/EDLV microcontrollers (CLKOUTA) is the same frequency as the crystal. The PLL takes the crystal inputs (X1 and X2) and generates a 45–55% (worst case) duty cycle intermediate system clock of the same frequency. This removes the need for an external 2x oscillator, reducing system cost. The PLL is reset during power-on reset by an on-chip power-on reset (POR) circuit.

# **Crystal-Driven Clock Source**

The internal oscillator circuit of the Am186ED/EDLV microcontrollers is designed to function with a parallel resonant fundamental or third overtone crystal. Because of the PLL, the crystal frequency should be equal to the processor frequency. Do not replace a crystal with an LC or RC equivalent.

The X1 and X2 signals are connected to an internal inverting amplifier (oscillator) that provides, along with the external feedback loading, the necessary phase shift (Figure 8). In such a positive feedback circuit, the inverting amplifier has an output signal (X2) 180 degrees out of phase of the input signal (X1).

The external feedback network provides an additional 180-degree phase shift. In an ideal system, the input to X1 will have 360 or zero degrees of phase shift. The external feedback network is designed to be as close to ideal as possible. If the feedback network is not providing necessary phase shift, negative feedback dampens the output of the amplifier and negatively affects the operation of the clock generator. Values for the loading on X1 and X2 must be chosen to provide the necessary phase shift and crystal operation.

#### Selecting a Crystal

When selecting a crystal, the load capacitance should always be specified ( $C_L$ ). This value can cause variance in the oscillation frequency from the desired specified value (resonance). The load capacitance and the loading of the feedback network have the following relationship:

$$C_L = - \frac{(C_1 \cdot C_2)}{(C_1 + C_2)} + C_S$$

where  $C_S$  is the stray capacitance of the circuit. Placing the crystal and  $C_L$  in series across the inverting amplifier and tuning these values ( $C_1$ ,  $C_2$ ) allows the crystal to oscillate at resonance. This relationship is true for both fundamental and third-overtone operation. Finally, there is a relationship between  $C_1$  and  $C_2$ . To enhance the oscillation of the inverting amplifier, these values need to be offset with the larger load on the output (X2). Equal values of these loads tend to balance the poles of the inverting amplifier.

The characteristics of the inverting amplifier set limits on the following parameters for crystals:

ESR	(Equivalent Series Resistance)	60 Ω max
Drive	e Level	1 mW max

The recommended range of values for  $C_1$  and  $C_2$  are as follows:

C <sub>1</sub> 1	5 pF ± 20%
C <sub>2</sub>	2 pF ± 20%

The specific values for  $C_1$  and  $C_2$  must be determined by the designer and are dependent on the characteristics of the chosen crystal and board design.

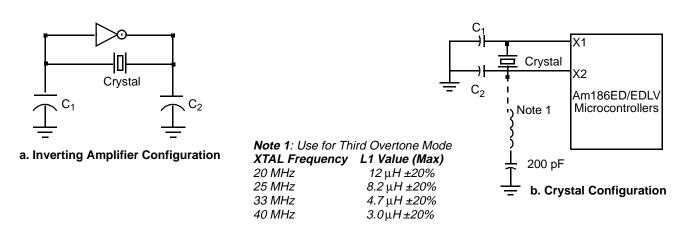


Figure 8. Am186ED/EDLV Microcontrollers Oscillator Configurations

# **External Source Clock**

Alternately, the internal oscillator can be driven from an external clock source. This source should be connected to the input of the inverting amplifier (X1), with the output (X2) not connected.

# **System Clocks**

The base system clock of AMD's original 80C186 and 80C188 microcontrollers is renamed CLKOUTA and the additional output is called CLKOUTB. CLKOUTA and CLKOUTB operate at either the processor frequency or the PLL frequency. The output drivers for both clocks are individually programmable for disable. Figure 9 shows the organization of the clocks.

The second clock output (CLKOUTB) allows one clock to run at the PLL frequency and the other clock to run at the power-save frequency. Individual drive enable bits allow selective enabling of just one or both of these clock outputs.

### **Power-Save Operation**

The power-save mode of the Am186ED/EDLV microcontrollers reduces power consumption and heat dissipation, thereby extending battery life in portable systems. In power-save mode, operation of the CPU and internal peripherals continues at a slower clock frequency. When an interrupt occurs, the microcontroller automatically returns to its normal operating frequency on the internal clock's next rising edge of  $t_3$ .

**Note:** Power-save operation requires that clock-dependent devices be reprogrammed for clock frequency changes. Software drivers must be aware of clock frequency. The power-save divisor should not be set to operate the processor core below 100 kHz.

# Initialization and Processor Reset

Processor initialization or startup is accomplished by driving the RES input pin Low. RES must be held Low for 1 ms during power-up to ensure proper device initialization. RES forces the Am186ED/EDLV microcontrollers to terminate all execution and local bus activity. No instruction or bus activity occurs as long as RES is active. After RES becomes inactive and an internal processing interval elapses, the microcontroller begins execution with the instruction at physical location FFFF0h, with UCS asserted with three wait states. RES also sets some registers to predefined values and resets the watchdog timer.

# **Reset Configuration Register**

When the RES input is asserted Low, the contents of the address/data bus (AD15–AD0) are written into the reset configuration register. The system can place configuration information on the address/data bus using weak external pullup or pulldown resistors, or using an external driver that is enabled during reset. The processor does not drive the address/data bus during reset.

For example, the reset configuration register could be used to provide the software with the position of a configuration switch in the system. Using weak external pullup and pulldown resistors on the address and data bus, the system can provide the microcontroller with a value corresponding to the position of the jumper during a reset.

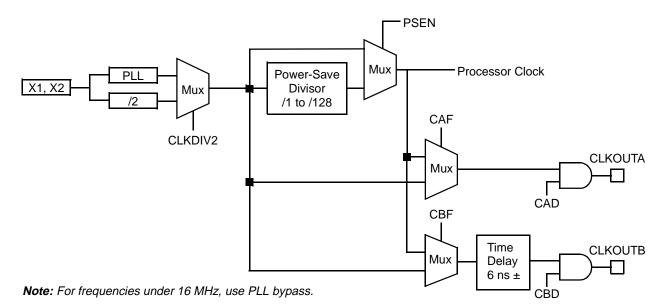


Figure 9. Clock Organization

# 

# CHIP-SELECT UNIT

The Am186ED/EDLV microcontrollers contain logic that provides programmable chip-select generation for both memories and peripherals. The logic can be programmed to provide ready and wait-state generation and latched address bits A1 and A2. The chip-select lines are active for all memory and I/O cycles in their programmed areas, whether they are generated by the CPU or by the integrated DMA unit.

The Am186ED/EDLV microcontrollers provide six chipselect outputs for use with memory devices and six more for use with peripherals in either memory space or I/O space. The six memory chip selects can be used to address three memory ranges. Each peripheral chip select addresses a 256-byte block that is offset from a programmable base address. A write to a chip select register will enable the corresponding chip select logic even if the actual pin has another function (e.g., PIO).

# **Chip-Select Timing**

The timing for the UCS and LCS outputs is modified from the original 80C186 microcontroller. These outputs now assert in conjunction with the nonmultiplexed address bus for normal memory timing. To allow these outputs to be available earlier in the bus cycle, the number of programmable memory size selections has been reduced.

# Ready and Wait-State Programming

The Am186ED/EDLV microcontrollers can be programmed to sense a ready signal for each of the peripheral or memory chip-select lines. The ready signal can be either the ARDY or SRDY signal. Each chipselect control register (UMCS, LMCS, MMCS, PACS, and MPCS) contains a single-bit field that determines whether the external ready signal is required or ignored.

The number of wait states to be inserted for each access to a peripheral or memory region is programmable. The chip-select control registers for UCS, ICS, MCS3–MCS0, PCS6, and PCS5 contain a two-bit field that determines the number of wait states from zero to three to be inserted. PCS3–PCS0 use three bits to provide additional values of 5, 7, 9, and 15 wait states.

When external ready is required, internally programmed wait states will always complete before external ready can terminate or extend a bus cycle. For example, if the internal wait states are set to insert two wait states, the processor samples the external ready pin during the first wait cycle. If external ready is asserted at that time, the access completes after six cycles (four cycles plus two wait states). If external ready is not asserted during the first wait cycle, the access is extended until ready is asserted, and one more wait state occurs followed by  $t_4$ . The ARDY signal on the Am186ED/EDLV microcontrollers is a true asynchronous ready signal. The ARDY pin accepts a rising edge that is asynchronous to CLK-OUTA and is active High. If the falling edge of ARDY is not synchronized to CLKOUTA as specified, an additional clock period may be added.

# **Chip-Select Overlap**

Although programming the various chip selects on the Am186ED/EDLV microcontrollers so that multiple chip select signals are asserted for the same physical address is not recommended, it may be unavoidable in some systems. In such systems, the chip selects whose assertions overlap must have the same configuration for ready (external ready required or not required) and the number of wait states to be inserted into the cycle by the processor. The one exception to this is PCS overlapping DRAM.

The peripheral control block (PCB) is accessed using internal signals. These internal signals function as chip selects configured with zero wait states and no external ready. Therefore, the PCB can be programmed to addresses that overlap external chip-select signals only if those external chip selects are programmed to zero wait states with no external ready required.

When overlapping an additional chip select with either the LCS or UCS chip selects, it must be noted that setting the Disable Address (DA) bit in the LMCS or UMCS register disables the address from being driven on the AD bus for all accesses for which the associated chip select is asserted, including any accesses for which multiple chip selects assert.

The MCS and PCS chip-select pins can be configured as either chip selects (normal function) or as PIO inputs or outputs. It should be noted, however, that the ready and wait state generation logic for these chip selects is in effect regardless of their configurations as chip selects or PIOs. This means that if these chip selects are enabled (by a write to the MMCS and MPCS for the MCS chip selects, or by a write to the PACS and MPCS registers for the PCS chip selects), the ready and wait state programming for these signals must agree with the programming for any other chip selects with which their assertion would overlap if they were configured as chip selects.

Although the PCS4 signal is not available on an external pin, the ready and wait state logic for this signal still exists internal to the part. For this reason, the PCS4 address space must follow the rules for overlapping chip selects. The ready and wait-state logic for PCS6– PCS5 is disabled when these signals are configured as address bits A2–A1.

Failure to configure overlapping chip selects with the same ready and wait state requirements may cause

the processor to hang with the appearance of waiting for a ready signal. This behavior may occur even in a system in which ready is always asserted (ARDY or SRDY tied High).

Configuring  $\overline{PCS}$  in I/O space with  $\overline{LCS}$  or any other chip select configured for memory address 0 is not considered overlapping of the chip selects. Overlapping chip selects refers to configurations where more than one chip select asserts for the same physical address.

The  $\overline{\text{PCS}}$  can overlap DRAM blocks with different wait states and without external or internal bus contention. The  $\overline{\text{RAS}}$  will assert along with the appropriate  $\overline{\text{PCS}}$ . The UCAS and LCAS will not assert, preventing the DRAM from writing erroneously or driving the data bus during a read. The  $\overline{\text{PCS}}$  must have the same or higher number of wait states than the DRAM. The  $\overline{\text{PCS}}$  bus width will be determined by the LSIZ or USIZ bus widths. This will make a 1785-byte block of the DRAM inaccessible. In its place, the peripherals associated with the  $\overline{\text{PCS}}$  can be accessed. This is especially useful when the entire memory space is used with two banks of DRAM or a bank of DRAM and a 512K Flash.

# **Upper Memory Chip Select**

The Am186ED/EDLV microcontrollers provide a UCS chip select for the top of memory. On reset the Am186ED/EDLV microcontrollers begin fetching and executing instructions at memory location FFFF0h. Therefore, upper memory is usually used as instruction memory. To facilitate this usage, UCS defaults to active on reset, with a default memory range of 64 Kbytes from F0000h to FFFFFh, with external ready required and three wait states automatically inserted. The UCS memory range always ends at FFFFFh. The UCS lower boundary is programmable.

The bus width associated with  $\overline{\text{UCS}}$  is determined on reset by the S2/BTSEL. If S2/BTSEL is pulled High or left floating, an internal pullup sets the boot mode option to 16-bit. If S2/BTSEL is pulled resistively Low during reset, the boot mode option is for 8-bit. The status of the  $\overline{S}2/BTSEL$  pin is latched on the rising edge of reset. If 8-bit mode is selected, the width of the memory region associated with UCS can be changed in the AUXCON register. If UCS boots as a 16-bit space, it is not re-configurable to 8-bit. This allows for cheaper 8bit-wide memory to be used for booting the Am186ED/ EDLV microcontrollers, while speed-critical code and data can be executed from 16-bit-wide lower memory. Eight-bit or 16-bit-wide peripherals can be used in the memory area between LCS and UCS or in the I/O space. The entire memory map can be set to 16-bit or 8-bit or mixed between 8-bit and 16-bit based on the USIZ, LSIZ, MSIZ, and IOSIZ bits in the AUXCON register.

# Low Memory Chip Select

The Am186ED/EDLV microcontrollers provide an  $\overline{\text{LCS}}$  chip select for lower memory. The AUXCON register can be used to configure  $\overline{\text{LCS}}$  for 8-bit or 16-bit accesses. Since the interrupt vector table is located at the bottom of memory starting at 00000h, the  $\overline{\text{LCS}}$  pin is usually used to control data memory. The  $\overline{\text{LCS}}$  pin is not active on reset.

The  $\overline{\text{LCS}}$  signal is multiplexed with the  $\overline{\text{RAS}}$ 0 signal when the DRAM mode is enabled in the LMCS register.

# **Midrange Memory Chip Selects**

The Am186ED/EDLV microcontrollers provide four chip selects, MCS3–MCS0, for use in a user-locatable memory block. With some exceptions, the base address of the memory block can be located anywhere within the 1-Mbyte memory address space. The areas associated with the UCS and LCS chip selects are excluded. If they are mapped to memory, the address range of the peripheral chip selects, PCS6, PCS5, and PCS3–PCS0, are also excluded. The MCS address range can overlap the PCS address range if the PCS chip selects are mapped to I/O space.

MCS0 can be configured to be asserted for the entire MCS range. When configured in this mode, the MCS3– MCS1 pins can be used as PIOs or DRAM control signals.

The AUXCON register can be used to configure MCS for 8-bit or 16-bit accesses. The bus width of the MCS range is determined by the width of the non-UCS/non-LCS memory range.

Unlike the  $\overline{\text{UCS}}$  and  $\overline{\text{LCS}}$  chip selects, the  $\overline{\text{MCS}}$  outputs assert with the same timing as the multiplexed AD address bus.

Activating either bank of DRAM will change the MCS1 and MCS2 functionality to UCAS and LCAS. Activating the upper DRAM bank will change the MCS3 functionality to RAS1. It is recommended that when either bank of DRAM is activated, either MCS0 be configured to assert for the entire MCS range or that MCS space be unused. If the lower bank of DRAM is activated, but not the upper bank of DRAM, MCS3 can still be used as a chip select or PIO. The MCS2 and MCS1 portion of the middle chip select address space will not have a chip select signal asserted, but the wait states will still be valid.

### **Peripheral Chip Selects**

The Am186ED/EDLV microcontrollers provide six chip selects, PCS6–PCS5 and PCS3–PCS0, for use within a user-configured memory or I/O block. PCS4 is not available on the Am186ED/EDLV microcontrollers. The base address of the memory block can be located anywhere within the 1-Mbyte memory address space, exclusive of the areas associated with the UCS, LCS, and

MCS chip selects, or they can be configured to access the 64-Kbyte I/O space.

The  $\overline{PCS}$  pins are not active on reset.  $\overline{PCS6}$ – $\overline{PCS5}$  can be programmed for zero to three wait states.  $\overline{PCS3}$ – $\overline{PCS0}$  can be programmed for four additional wait-state values: 5, 7, 9, and 15.

The AUXCON register can be used to configure  $\overline{PCS}$  for 8-bit or 16-bit accesses. The bus width of the  $\overline{PCS}$  range is determined by the width of the non-UCS/non-UCS memory range or by the width of the I/O area.

Unlike the UCS and LCS chip selects, the PCS outputs assert with the multiplexed AD address bus. Each peripheral chip select asserts over a 256-byte address range, which is twice the address range covered by peripheral chip selects in the 80C186/188 microcontrollers.

The PCS allows for overlap in memory space with the DRAM (RAS0, RAS1) space. Overlap of the PCS with LCS, MCS, or UCS in a non-DRAM mode is not recommended. If overlap of the PCS with MCS, LCS, or UCS occurs, the same number of wait states and external ready must be used. If overlap of PCS with DRAM space occurs, the DRAM controller will assert RAS and stop the CAS signal from asserting. This will not modify the contents of the DRAM and the access will continue as a normal PCS access. When overlapping the PCS with DRAM, the number of wait states can be different for PCS space. PCS wait states must be greater than or equal to DRAM wait states. The ready and wait states will be determined by the PCS programming in the MPCS and PACS registers.

PCS space should not contain the address FFFFh, which is the address used for a refresh cycle. The AD15–AD0 bus will drive FFFFh during a refresh cycle for the address portion of cycle.

# **REFRESH CONTROL UNIT**

The refresh control unit (RCU) automatically generates refresh bus cycles when enabled. After a programmable period of time, the RCU generates a CAS-before-RAS refresh bus cycle. The RCU should not be enabled if at least one bank of DRAM is not enabled. All refreshes will be 7 clocks, no matter how the DRAM wait states are programmed. During a refresh cycle, the A19-A0 bus is undefined; the AD15-AD0 bus is driven with all 1s (FFFFh). The PCS and MCS chip selects are decoded by the processor using a 20-bit version of the AD bus. The highest four bits of this internal bus are not available externally; however, internally these bits are set to all 1s during a refresh cycle, resulting in the 20-bit address FFFFh. For this reason, the MCS and PCS chip selects should not contain the address FFFFh while DRAM is enabled.

# INTERRUPT CONTROL UNIT

The Am186ED/EDLV microcontrollers can receive interrupt requests from a variety of sources, both internal and external. The internal interrupt controller arranges these requests by priority and presents them one at a time to the CPU.

There are up to eight external interrupt sources on the Am186ED/EDLV microcontrollers—seven maskable interrupt pins and one nonmaskable interrupt (NMI) pin. In addition, there are eight internal interrupt sources (three timers, two DMA channels, two asynchronous serial ports, and the Watchdog Timer NMI) that are not connected to external pins. INT5 and INT6 are multiplexed with DRQ0 and DRQ1. These two interrupts are available if the associated DMA is not enabled or is being used with internal synchronization.

The Am186ED/EDLV microcontrollers provide up to six interrupt sources not present on the 80C186 and 80C188 microcontrollers. There are up to three additional external interrupt pins—INT4, INT5, and INT6. These pins operate much like the INT3–INT0 interrupt pins on the 80C186 and 80C188 microcontrollers. There are also two internal interrupts from the serial ports and the watchdog timer can generate interrupts.

INT5 and INT6 are multiplexed with the DMA request signals, DRQ0 and DRQ1. If a DMA channel is not enabled, or if it is not using external synchronization, then the associated pin can be used as an external interrupt. INT5 and INT6 can also be used in conjunction with the DMA terminal count interrupts.

The seven maskable interrupt request pins can be used as direct interrupt requests. INT4–INT0 can be either edge-triggered or level-triggered. INT6 and INT5 are edge-triggered only. In addition, INT0 and INT1 can be configured in cascade mode for use with an external 82C59A-compatible interrupt controller. When INT0 is configured in cascade mode, the INT2 pin is automatically configured in its INTA0 function. When INT1 is configured in cascade mode, the INT3 pin is automatically configured in its INTA1 function. An external interrupt controller can be used as the system master by programming the internal interrupt controller to operate in slave mode. INT6–INT4 are not available in slave mode.

Interrupts are automatically disabled when an interrupt is taken. Interrupt-service routines (ISRs) may re-enable interrupts by setting the IF flag. This allows interrupts of greater or equal priority to interrupt the currently executing ISR. Interrupts from the same source are disabled as long as the corresponding bit in the interrupt in-service register is set. INT1 and INT0 provide a special bit to enable special fully nested mode. When configured in special fully nested mode, the interrupt source may generate a new interrupt regardless of the setting of the in-service bit.

## TIMER CONTROL UNIT

There are three 16-bit programmable timers and a watchdog timer on the Am186ED/EDLV microcontrollers.

Timer 0 and timer 1 are connected to four external pins (each one has an input and an output). These two timers can be used to count or time external events, or to generate nonrepetitive or variable-duty-cycle waveforms. When pulse width demodulation is enabled, timer 0 and timer 1 are used to measure the width of the High and Low pulses on the PWD pin. (See the Pulse Width Demodulation section on page 45.)

Timer 2 is not connected to any external pins. It can be used for real-time coding and time-delay applications. It can also be used as a prescaler to timers 0 and 1 or to synchronize DMA transfers.

The programmable timers are controlled by eleven 16bit registers in the peripheral control block. A timer's timer-count register contains the current value of that timer. The timer-count register can be read or written with a value at any time, whether the timer is running or not. The microcontroller increments the value of the timer-count register each time a timer event occurs.

Each timer also has a maximum-count register that defines the maximum value the timer can reach. When the timer reaches the maximum value, it resets to 0 during the same clock cycle. The value in the maximum-count register is never stored in the timer-count register. Also, timers 0 and 1 have a secondary maximum-count register. Using both the primary and secondary maximum-count registers lets the timer alternate between two maximum values.

If the timer is programmed to use only the primary maximum-count register, the timer output pin switches Low for one clock cycle after the maximum value is reached. If the timer is programmed to use both of its maximum-count registers, the output pin indicates which maximum-count register is currently in control, thereby creating a waveform. The duty cycle of the waveform depends on the values in the maximumcount registers.

Each timer is serviced every fourth clock cycle, so a timer can operate at a speed of up to one-quarter of the internal clock frequency. A timer can be clocked externally at this same frequency; however, because of internal synchronization and pipelining of the timer circuitry, the timer output can take up to six clock cycles to respond to the clock or gate input.

#### Watchdog Timer

The Am186ED/EDLV microcontrollers provide a true watchdog timer function. The Watchdog Timer (WDT) can be used to regain control of the system when software fails to respond as expected. The WDT is active

after reset. It can only be modified a single time by a keyed sequence of writes to the watchdog timer control register (WDTCON) following reset. This single write can either disable the timer or modify the timeout period and the action taken upon timeout. A keyed sequence is also required to reset the current WDT count. This behavior ensures that randomly executing code will not prevent a WDT event from occurring.

The WDT supports up to a 1.67-second timeout period in a 40-MHz system. After reset, the WDT is enabled and the timeout period is set to its maximum value.

The WDT can be configured to cause either an NMI interrupt or a system reset upon timeout. If the WDT is configured for NMI, the NMIFLAG in the WDTCON register is set when the NMI is generated. The NMI interrupt service routine (ISR) should examine this flag to determine if the interrupt was generated by the WDT or by an external source. If the NMIFLAG is set, the ISR should clear the flag by writing the correct keyed sequence to the WDTCON register. If the NMIFLAG is set when a second WDT timeout occurs, a WDT system reset is generated rather than a second NMI event.

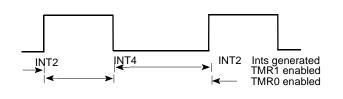
When the processor takes a WDT reset, either due to a single WDT event with the WDT configured to generate resets or due to a WDT event with the NMIFLAG set, the RSTFLAG in the WDTCON register is set. This allows system initialization code to differentiate between a hardware reset and a WDT reset and take appropriate action. The RSTFLAG is cleared when the WDTCON register is read or written. The processor does not resample external pins during a WDT reset. This means that the clocking, the reset configuration register, and any other features that are user-selectable during reset do not change when a WDT system reset occurs. All other activities are identical to those of a normal system reset.

**Note:** The Watchdog Timer (WDT) is active after reset.

### PULSE WIDTH DEMODULATION

For many applications, such as bar-code reading, it is necessary to measure the width of a signal in both its High and Low phases. The Am186ED/EDLV microcontrollers provide a pulse-width demodulation (PWD) option to fulfill this need. The PWD bit in the System Configuration Register (SYSCON) enables the PWD option. Analog-to-digital conversion is not supported.

In PWD mode, TMRIN0, TMRIN1, INT2, and INT4 are configured internal to the microcontroller to support the detection of rising and falling edges on the PWD input pin (INT2/INTA0/PWD) and to enable either timer 0 when the signal is High or timer 1 when the signal is Low. The INT4, TMRIN0, and TMRIN1 pins are not used in PWD mode and so are available for use as PIOs. The following diagram shows the behavior of a system for a typical waveform.



The interrupt service routine (ISR) for the INT2 and INT4 interrupts should examine the current count of the associated timer, timer 1 for INT2, and timer 0 for INT4, in order to determine the pulse width. The ISR should then reset the timer count register in preparation for the next pulse.

Since the timers count at one quarter of the processor clock rate, this determines the maximum resolution that can be obtained. Further, in applications where the pulse width may be short, it may be necessary to poll the INT2 and INT4 request bits in the interrupt request register in order to avoid the overhead involved in taking and returning from an interrupt. Overflow conditions, where the pulse width is greater than the maximum count of the timer, can be detected by monitoring the Maximum Count (MC) bit in the associated timer or by setting the INT bit to enable timer interrupt requests.

# DIRECT MEMORY ACCESS

Direct memory access (DMA) permits transfer of data between memory and peripherals without CPU involvement. The DMA unit shown in Figure 10, provides two high-speed DMA channels. Data transfers can occur between memory and I/O spaces (e.g., memory to I/O) or within the same space (e.g., memory to memory or I/O to I/O). Table 9 shows maximum DMA transfer rates.

The DMA channels can be directly connected to the asynchronous serial ports. DMA and serial port transfer is accomplished by programming the DMA controller to perform transfers between a data source in memory or I/O space and a serial port transmit or receive register. The two DMA channels can support one serial port in full-duplex mode or two serial ports in half-duplex mode.

Either bytes or words can be transferred to or from even or odd addresses. However, word DMA transfers to or from memory configured for 8-bit accesses are not supported. Only two bus cycles (a minimum of eight clocks) are necessary for each data transfer.

Each channel accepts a DMA request from one of four sources: the channel request pin (DRQ1–DRQ0), Timer 2, a serial port, or the system software. The channels can be programmed with different priorities in the event of a simultaneous DMA request or if there is a need to interrupt transfers on the other channel.

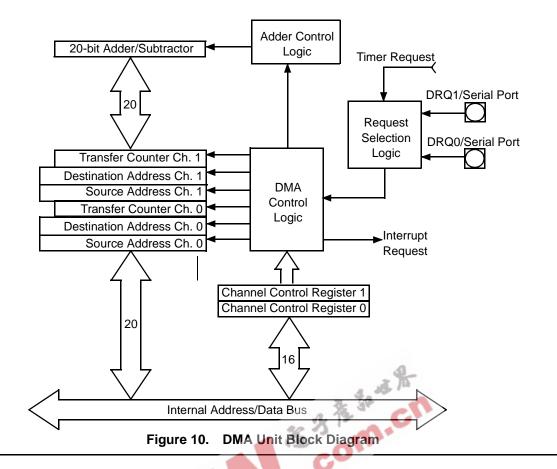
# **DMA Operation**

Each channel has six registers in the peripheral control block that define specific channel operations. The DMA registers consist of a 20-bit source address (two registers), a 20-bit destination address (two registers), a 16bit transfer count register, and a 16-bit control register.

The DMA Transfer Count Register (DTC) specifies the number of DMA transfers to be performed. Up to 64K of byte or word transfers can be performed with automatic termination. The DMA control registers define the channel operation. All registers can be modified during any DMA activity. Any changes made to the DMA registers are reflected immediately in DMA operation.

Type of	Maximum DMA Transfer Rate (Mbytes)				
Synchronization Selected	40 MHz	33 MHz	25 MHz	20 MHz	
Unsynchronized	10	8.25	6.25	5	
Source Synchronized	10	8.25	6.25	5	
Destination Synchronized (CPU needs bus)	6.6	5.5	4.16	3.3	
Destination Synch (CPU does not need bus)	8	6.6	5	4	

#### Table 9. Am186ED/EDLV Microcontrollers Maximum DMA Transfer Rates



# DMA Channel Control Registers

Each DMA control register determines the mode of operation for the particular DMA channel. The DMA control registers specify the following:

- The mode of synchronization
- Whether bytes or words are transferred
- Whether an interrupt is generated after the last transfer
- Whether the DRQ pins are configured as INT pins
- Whether DMA activity ceases after a programmed number of DMA cycles
- The relative priority of the DMA channel with respect to the other DMA channel
- Whether the source address is incremented, decremented, or maintained constant after each transfer
- Whether the source address addresses memory or I/O space
- Whether the destination address is incremented, decremented, or maintained constant after transfers
- Whether the destination address addresses memory or I/O space

# DMA Priority

The DMA channels can be programmed so that one channel is always given priority over the other, or they can be programmed to alternate cycles when both have DMA requests pending. DMA cycles always have priority over internal CPU cycles except between locked memory accesses or word accesses to odd memory locations. However, an external bus hold takes priority over an internal DMA cycle.

Because an interrupt request cannot suspend a DMA operation and the CPU cannot access memory during a DMA cycle, interrupt latency time suffers during sequences of continuous DMA cycles. An NMI request, however, causes all internal DMA activity to halt. This allows the CPU to respond quickly to the NMI request.

# **ASYNCHRONOUS SERIAL PORTS**

The Am186ED/EDLV microcontrollers provide two independent asynchronous serial ports. These ports provide full-duplex, bidirectional data transfer using several industry-standard communications protocols. The serial ports can be used as sources or destinations of DMA transfers.

# 

The asynchronous serial ports support the following features:

- Full-duplex operation
- Direct memory access (DMA) from the serial ports
- 7-bit, 8-bit, or 9-bit data transfers
- Odd, even, or no parity
- One stop bit
- Long or short break character recognition
- Error detection
  - Parity errors
  - Framing errors
  - Overrun errors
  - Break character recognition
- Hardware handshaking with the following selectable control signals:
  - Clear-to-send (CTS)
  - Enable-receiver-request (ENRX)
  - Ready-to-send (RTS)
  - Ready-to-receive (RTR)
- DMA to and from the serial ports
- Separate maskable interrupts for each port
- Multidrop protocol (9-bit) support
- Independent baud rate generators
- Maximum baud rate of 1/16th of the CPU clock
- Double-buffered transmit and receive
- Programmable interrupt generation for transmit, receive, and/or error detection

# DMA Transfers through the Serial Port

The DMA channels can be directly connected to the asynchronous serial ports. DMA and serial port transfer is accomplished by programming the DMA controller to perform transfers between a memory or I/O space and a serial port transmit or receive register. The two DMA channels can support one serial port in full-duplex mode or two serial ports in half-duplex mode. See the DMA Control register descriptions in the *Am186ED/EDLV Microcontrollers User's Manual*, order# 21335A for more information.

# PROGRAMMABLE I/O (PIO) PINS

There are 32 pins on the Am186ED/EDLV microcontrollers that are available as user-programmable I/O signals. Table 2 on page 29 and Table 3 on page 29 list the PIO pins. Each of these pins can be used as a userprogrammable input or output signal if the normal shared function is not needed.

If a pin is enabled to function as a PIO signal, the preassigned signal function is disabled and does not affect the level on the pin. A PIO signal can be configured to operate as an input or output with or without a weak pullup or pulldown, or as an open-drain output.

After power-on reset, the PIO pins default to various configurations. The column titled *Power-On Reset Status* in Table 2 on page 29 and Table 3 on page 29 lists the defaults for the PIOs. The system initialization code must reconfigure the PIOs as required.

The A19–A17 address pins default to normal operation on power-on reset, allowing the processor to correctly begin fetching instructions at the boot address FFFF0h. The DT/R, DEN, and SRDY pins also default to normal operation on power-on reset.

Note that emulators use A19, A18, A17, S6, and  $\overline{UZI}$ . In environments where an emulator is needed, these pins must be configured for normal function—not as PIOs.

If the AD15–AD0 bus override is enabled on power-on reset, then S6/CLKDIV2 and UZI revert to normal operation instead of PIO input with pullup. If BHE/ADEN is held Low during power-on reset, the AD15–AD0 bus override is enabled.

When the  $\overline{PCS}$  or  $\overline{MCS}$  are used as PIO inputs (only) and the bus is arbitrated, an internal pullup of ~10 kohms is activated, even if the pullup option for the PIO is not selected.

# **ABSOLUTE MAXIMUM RATINGS**

#### Storage temperature

Am186ED	–65°C to +125°C
Am186EDLV	–65°C to +125°C

#### Voltage on any pin with respect to ground

Am186ED	–0.5 V to $V_{cc}$ +0.5 V
Am186EDLV	–0.5 V to $V_{cc}$ +0.5 V

**Note:** Stresses above those listed under Absolute Maximum Ratings may cause permanent device failure. Functionality at or above these limits is not implied. Exposure to absolute maximum ratings for extended periods may affect device reliability.

# **OPERATING RANGES**

#### Am186ED Microcontroller

Commercial (T <sub>C</sub> )	0°C to +100°C
Industrial* (T <sub>A</sub> )	40°C to +85°C
Supply voltage (V <sub>CC</sub> )	5 V ± 10%

#### Am186EDLV Microcontroller

Commercial (T <sub>A</sub> )	0°C to +70°C
V <sub>CC</sub> up to 25 MHz	3.3 V ± 0.3 V

Where:  $T_C$  = case temperature  $T_A$  = ambient temperature

\*Industrial versions of Am186ED microcontrollers are available in 20 and 25 MHz operating frequencies only.

# DC CHARACTERISTICS OVER COMMERCIAL AND INDUSTRIAL OPERATING RANGES

			Prelir	ninary	
Symbol	Parameter Description	Test Conditions	Min	Max	Unit
V <sub>IL</sub>	Input Low Voltage (Except X1)		-0.5	0.2V <sub>CC</sub> -0.3	V
V <sub>IL1</sub>	Clock Input Low Voltage (X1)		-0.5	0.8	V
V <sub>IH</sub>	Input High Voltage (Except RES and X1)		2.0	V <sub>CC</sub> +0.5	V
V <sub>IH1</sub>	Input High Voltage (RES)		2.4	V <sub>CC</sub> +0.5	V
V <sub>IH2</sub>	Clock Input High Voltage (X1)	1 × 12	V <sub>CC</sub> -0.8	V <sub>CC</sub> +0.5	V
	Output Low Voltage				
V <sub>OL</sub>	Am186ED	l <sub>OL</sub> = 2.5 mA (S2–S0) l <sub>OL</sub> = 2.0 mA (others)		0.45	V
	Am186EDLV	l <sub>OL</sub> = 1.5 mA (ᢒ2–ᢒ0) l <sub>OL</sub> = 1.0 mA (others)		0.45	V
	Output High Voltage <sup>(a)</sup>				
N	Am186ED	I <sub>OH</sub> = –2.4 mA @ 2.4 V	2.4	V <sub>CC</sub> +0.5	V
V <sub>OH</sub>		I <sub>OH</sub> = -200 μA @ <i>V<sub>CC</sub></i> -0.5	V <sub>CC</sub> –0.5	V <sub>CC</sub>	V
	Am186EDLV	I <sub>OH</sub> = -200 μA @ <i>V<sub>CC</sub></i> -0.5	V <sub>CC</sub> –0.5	V <sub>CC</sub>	V
	Power Supply Current @ 0°C	$V_{CC} = 5.5 V^{(b)}$		5.9	mA/MHz
lcc		$V_{CC} = 3.6 V^{(b)}$		4.0	
ILI	Input Leakage Current @ 0.5 MHz	0.45 V≤V <sub>IN</sub> ≤ <i>V<sub>CC</sub></i>		±10	μA
I <sub>LO</sub>	Output Leakage Current @ 0.5 MHz	$0.45 V \le V_{OUT} \le V_{CC}^{(c)}$		±10	μA
V <sub>CLO</sub>	Clock Output Low	I <sub>CLO</sub> = 4.0 mA		0.45	V
V <sub>CHO</sub>	Clock Output High	I <sub>CHO</sub> = –500 μA	V <sub>CC</sub> –0.5		V

Notes:

a The  $\overline{LCS/ONCE0/RAS0}$  and  $\overline{UCS/ONCE1}$  pins have weak internal pullup resistors. Loading the  $\overline{LCS/ONCE0/RAS0}$  and  $\overline{UCS/ONCE1}$  pins in excess of  $I_{OH} = -200 \ \mu$ A during reset can cause the device to go into ONCE mode.

b Current is measured with the device in RESET with X1 and X2 driven and all other non-power pins open but held High or Low.

c Testing is performed with the pins floating, either during HOLD or by invoking the ONCE mode.

# 

# CAPACITANCE

			Preliminary		
Symbol	Parameter Description	Test Conditions	Min	Max	Unit
C <sub>IN</sub>	Input Capacitance	@ 1 MHz		10	pF
C <sub>IO</sub>	Output or I/O Capacitance	@ 1 MHz		20	pF

Note:

Capacitance limits are guaranteed by characterization.

# **POWER SUPPLY CURRENT**

For the following typical system specification shown in Figure 11,  $I_{CC}$  has been measured at 4.0 mA per MHz of system clock. For the following typical system specification shown in Figure 12,  $I_{CC}$  has been measured at 5.9 mA per MHz of system clock. The typical system is measured while the system is executing code in a typical application with nominal voltage and maximum case temperature. Actual power supply current is dependent on system design and may be greater or less than the typical  $I_{CC}$  figure presented here.

Typical current in Figure 11 is given by:  $I_{CC} = 4.0 \text{ mA} \cdot \text{freq}(\text{MHz})$ 

Typical current in Figure 12 is given by:  $I_{CC} = 5.9 \text{ mA} \cdot \text{freq}(\text{MHz})$ 

Please note that dynamic  $I_{CC}$  measurements are dependent upon chip activity, operating frequency, output buffer logic, and capacitive/resistive loading of the outputs. For these  $I_{CC}$  measurements, the devices were set to the following modes:

- No DC loads on the output buffers
- Output capacitive load set to 35 pF
- AD bus set to data only
- PIOs are disabled
- Timer, serial port, refresh, and DMA are enabled

Table 10 shows the variables that are used to calculate the typical power consumption value for the Am186EDLV microcontroller.

# Table 10. Typical Power Consumption Calculation for the Am186EDLV Microcontroller

MHz ·	Typical Power in Watts		
MHz Typical I <sub>CC</sub> Volts			
20	4.0	3.6	0.288
25	4.0	3.6	0.360
			25 MHz 20 MHz

I<sub>CC</sub> (mA) 60 40 20 0 10 20 30

Clock Frequency (MHz)

Figure 11. Typical I<sub>cc</sub> Versus Frequency for Am186EDLV Microcontroller

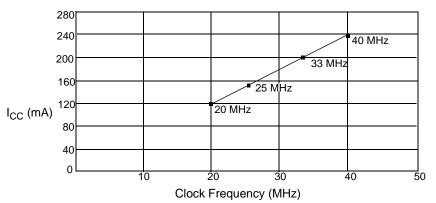


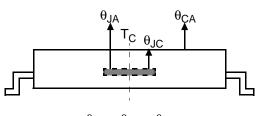
Figure 12. Typical  $I_{cc}$  Versus Frequency for Am186ED Microcontroller

# THERMAL CHARACTERISTICS TQFP Package

The Am186ED microcontroller is specified for operation with case temperature ranges from 0°C to +100°C for a commercial device. Case temperature is measured at the top center of the package as shown in Figure 13. The various temperatures and thermal resistances can be determined using the equations in Figure 14 with information given in Table 11.

The total thermal resistance is  $\theta_{JA}$ ;  $\theta_{JA}$  is the sum of  $\theta_{JC}$ , the internal thermal resistance of the assembly, and  $\theta_{CA}$ , the case to ambient thermal resistance.

The variable P is power in watts. Power supply current  $(I_{CC})$  is in mA per MHz of clock frequency.







$$\theta_{JA} = \theta_{JC} + \theta_{CA}$$

$$P = I_{CC} \cdot \text{freq (MHz)} \cdot V_{CC}$$

$$T_J = T_C + (P \cdot \theta_{JC})$$

$$T_J = T_A + (P \cdot \theta_{JA})$$

$$T_C = T_J - (P \cdot \theta_{JC})$$

$$T_C = T_A + (P \cdot \theta_{CA})$$

$$T_A = T_C - (P \cdot \theta_{CA})$$



	Ainflour			
	Airflow (Linear Feet			
Package/Board	per Minute)	$\theta_{JA}$	θJC	θca
PQFP/2-Layer	0 fpm	45	7	38
	200 fpm	39	7	32
	400 fpm	35	7	28
	600 fpm	33	7	26
TQFP/2-Layer	0 fpm	56	10	46
	200 fpm	46	10	36
	400 fpm	40	10	30
	600 fpm	38	10	28
PQFP/4-Layer	0 fpm	23	5	18
to 6-Layer	200 fpm	21	5	16
	400 fpm	19	5	14
	600 fpm	17	5	12
TQFP/4-Layer	0 fpm	30	6	24
to 6-Layer	200 fpm	28	6	22
	400 fpm	26	6	20
	600 fpm	24	6	18

#### Table 11. Thermal Characteristics (°C/Watt)

# **Typical Ambient Temperatures**

The typical ambient temperature specifications are based on the following assumptions and calculations:

The commercial operating range of the Am186ED microcontroller is a case temperature  $T_C$  of 0 to 100 degrees Centigrade.  $T_C$  is measured at the top center of the package. An increase in the ambient temperature causes a proportional increase in  $T_C$ .

Microcontrollers up to 40 MHz are specified as 5.0 V plus or minus 10%. Therefore, 5.0 V is used for calculating typical power consumption up to 40 MHz.

Typical power supply current ( $I_{CC}$ ) in normal usage is estimated at 5.9 mA per MHz of microcontroller clock rate.

Typical power consumption (watts) = (5.9 mA/MHz) times microcontroller clock rate times V<sub>CC</sub> divided by 1000.

Table 12 shows the variables that are used to calculate the typical power consumption value for each version of the Am186ED microcontroller.

Table 12. Typical Power Consumption Calculation

P = N	Typical Power (P) in Watts		
MHz	Typical I <sub>CC</sub>	Volts	
40	5.9	5.0	1.2
33	5.9	5.0	1.0
25	5.9	5.0	0.7
20	5.9	5.0	0.6

Thermal resistance is a measure of the ability of a package to remove heat from a semiconductor device. A safe operating range for the device can be calculated using the formulas from Figure 14 and the variables in Table 11.

By using the maximum case rating  $T_C$ , the typical power consumption value from Table 12, and  $\theta_{JC}$  from Table 11, the junction temperature  $T_J$  can be calculated by using the following formula from Figure 14.

$$\mathsf{T}_{\mathsf{J}} = \mathsf{T}_{\mathsf{C}} + (\mathsf{P} \cdot \theta_{\mathsf{JC}})$$

Table 13 shows  $T_J$  values for the various versions of the Am186ED microcontroller. The column titled *Speed/Pkg/Board* in Table 13 indicates the clock speed in MHz, the type of package (P for PQFP and T for TQFP), and the type of board (2 for 2-layer and 4-6 for 4-layer to 6-layer).

#### Table 13. Junction Temperature Calculation

Speed/ Pkg/		$T_J = T_{C+} (P \cdot \theta_{JC})$				
Board	T <sub>J</sub> (°C)	т <sub>с</sub>	Р	θJC		
40/P2	108.3	100	1.2	7		
40/T2	111.8	100	1.2	10		
40/P4-6	105.9	100	1.2	5		
40/T4-6	107.1	100	1.2	6		
33/P2	106.8	100	1.0	7		
33/T2	109.7	100	1.0	10		
33/P4-6	104.9	100	1.0	5		
33/T4-6	105.8	100	1.0	6		
25/P2	105.2	100	0.7	7		
25/T2	107.4	100	0.7	10		
25/P4-6	103.7	100	0.7	5		
25/T4-6	104.4	100	0.7	6		
20/P2	104.1	100	0.6	7		
20/T2	105.9	100	0.6	10		
20/P4-6	103.0	100	0.6	5		
20/T4-6	103.5	100	0.6	6		

By using T<sub>J</sub> from Table 13, the typical power consumption value from Table 12, and a  $\theta_{JA}$  value from Table 11, the typical ambient temperature T<sub>A</sub> can be calculated using the following formula from Figure 14:

$$F_A = T_J - (P \cdot \theta_{JA})$$

For example,  $T_A$  for a 40-MHz PQFP design with a 2layer board and 0 fpm airflow is calculated as follows:

$$T_A = 108.3 - (1.2 \cdot 45)$$
  
 $T_A = 55.2$ 

In this calculation, T\_J comes from Table 13, P comes from Table 12, and  $\theta_{JA}$  comes from Table 11. See Table 14.

 $T_A$  for a 33-MHz TQFP design with a 4-layer to 6-layer board and 200 fpm airflow is calculated as follows:

$$T_{A} = 105.8 - (1.0 \cdot 28)$$
  
$$T_{A} = 78.6$$

See Table 17 for the result of this calculation.

Table 14 through Table 17 and Figure 15 through Figure 18 show  $T_A$  based on the preceding assumptions and calculations for a range of  $\theta_{JA}$  values with airflow from 0 linear feet per minute to 600 linear feet per minute.

Table 14 shows typical maximum ambient temperatures in degrees Centigrade for a PQFP package used on a 2layer board. The typical ambient temperatures are based on a 100-degree Centigrade maximum case temperature. Figure 15 graphically illustrates the typical temperatures in Table 14.

Table 14.	Typical Ambient Temperatures (°C) for PQFP with a 2-Layer Board	
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			Linear Feet per	Minute Airflow	
Microcontroller Speed	Typical Power (Watts)	0 fpm	200 fpm	400 fpm	600 fpm
40 MHz	1.2	55.2	62.2	67.0	69.3
33 MHz	1.0	63.0	68.8	72.7	74.7
25 MHz	0.7	72.0	76.4	79.4	80.8
20 MHz	0.6	77.6	81.1	83.5	84.7

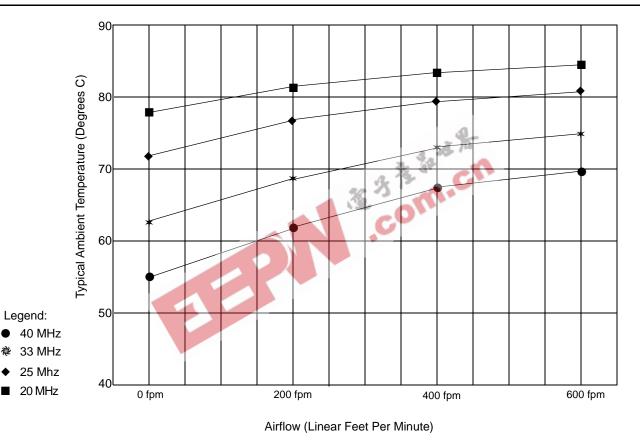


Figure 15. Typical Ambient Temperatures for PQFP with a 2-Layer Board

Table 15 shows typical maximum ambient temperatures in degrees Centigrade for a TQFP package used on a 2layer board. The typical ambient temperatures are based on a 100-degree Centigrade maximum case temperature. Figure 16 graphically illustrates the typical temperatures in Table 15.

Table 15.	Typical Ambient Temperatures (°C) for TQFP with a 2-Layer Board
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		Linear Feet per Minute Airflow				
Microcontroller Speed	Typical Power (Watts)	0 fpm	200 fpm	400 fpm	600 fpm	
40 MHz	1.2	45.7	57.5	64.6	67.0	
33 MHz	1.0	55.2	65.0	70.8	72.7	
25 MHz	0.7	66.1	73.5	77.9	79.4	
20 MHz	0.6	72.9	78.8	82.3	83.5	



Figure 16. Typical Ambient Temperatures for TQFP with a 2-Layer Board

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Table 16 shows typical maximum ambient temperatures in degrees Centigrade for a PQFP package used on a 4layer to 6-layer board. The typical ambient temperatures are based on a 100-degree Centigrade maximum case temperature. Figure 17 graphically illustrates the typical temperatures in Table 16.

Table 16. Typic	al Ambient Temperatur	s (°C) for PQFP wit	th a 4-Layer to 6-Layer Board
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		Linear Feet per Minute Airflow				
Microcontroller Speed	Typical Power (Watts)	0 fpm	200 fpm	400 fpm	600 fpm	
40 MHz	1.2	78.8	81.1	83.5	85.8	
33 MHz	1.0	82.5	84.4	86.4	88.3	
25 MHz	0.7	86.7	88.2	89.7	91.2	
20 MHz	0.6	89.4	90.6	91.7	92.9	

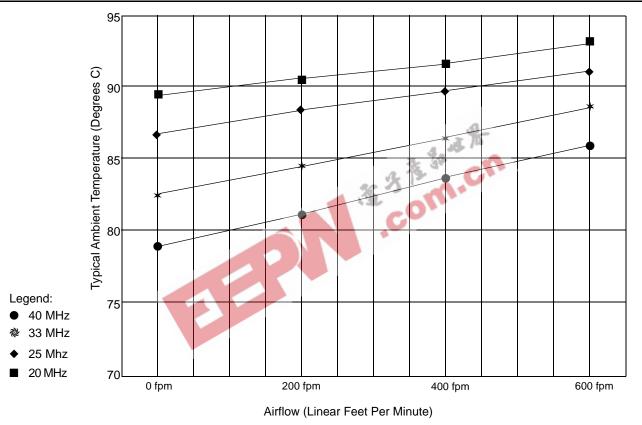


Figure 17. Typical Ambient Temperatures for PQFP with a 4-Layer to 6-Layer Board

Table 17 shows typical maximum ambient temperatures in degrees Centigrade for a TQFP package used on a 4layer to 6-layer board. The typical ambient temperatures are based on a 100-degree Centigrade maximum case temperature. Figure 18 graphically illustrates the typical temperatures in Table 17.

Table 17.	. Typical Ambient Temperatures (°C) for TQFP with a 4-Layer	to 6-Layer Board
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		Linear Feet per Minute Airflow						
Microcontroller Speed	Typical Power (Watts)	0 fpm	200 fpm	400 fpm	600 fpm			
40 MHz	1.2	71.7	74.0	76.4	78.8			
33 MHz	1.0	76.6	78.6	80.5	82.5			
25 MHz	0.7	82.3	83.8	85.3	86.7			
20 MHz	0.6	85.8	87.0	88.2	89.4			

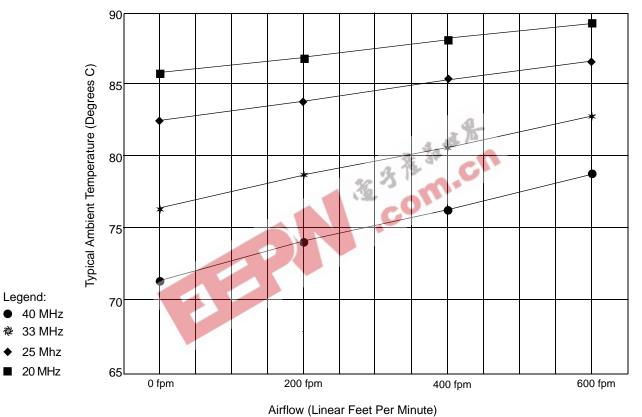


Figure 18. Typical Ambient Temperatures for TQFP with a 4-Layer to 6-Layer Board

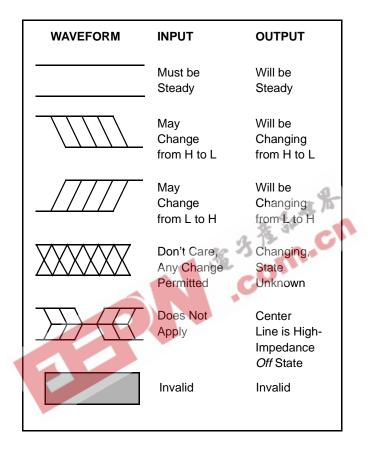
# COMMERCIAL AND INDUSTRIAL SWITCHING CHARACTERISTICS AND WAVEFORMS

In the switching waveforms that follow, several abbreviations are used to indicate the specific periods of a bus cycle. These periods are referred to as time states. A typical bus cycle is composed of four consecutive time states:  $t_1$ ,  $t_2$ ,  $t_3$ , and  $t_4$ . Wait states, which represent multiple  $t_3$  states, are referred to as  $t_w$ 

states. When no bus cycle is pending, an idle  $\left(t_{i}\right)$  state occurs.

In the switching parameter descriptions, the *multiplexed* address is referred to as the AD address bus; the *demultiplexed* address is referred to as the A address bus.

#### Key to Switching Waveforms



# Alphabetical Key to Switching Parameter Symbols

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Parameter Symbol	No.	Description
t <sub>ARYCH</sub>	49	ARDY Resolution Transition Setup Time
t <sub>ARYCHL</sub>	51	ARDY Inactive Holding Time
t <sub>ARYHDSH</sub> <sup>(a)</sup>	95	ARDY High to DS High
t <sub>ARYHDV</sub> <sup>(a)</sup>	89	ARDY Assert to Data Valid
t <sub>ARYLCL</sub>	52	ARDY Setup Time
t <sub>ARYLDSH</sub> <sup>(a)</sup>	96	ARDY Low to DS High
t <sub>AVBL</sub>	87	A Address Valid to WHB, WLB Low
t <sub>AVCH</sub>	14	AD Address Valid to Clock High
t <sub>AVLL</sub>	12	AD Address Valid to ALE Low
t <sub>AVRL</sub>	66	A Address Valid to RD Low
t <sub>AVWL</sub>	65	A Address Valid to WR Low
t <sub>AZRL</sub>	24	AD Address Float to RD Active
t <sub>CH1CH2</sub>	45	CLKOUTA Rise Time
t <sub>CHAV</sub>	68	CLKOUTA High to A Address Valid
t <sub>CHCA</sub>	104	CLKOUTA High to CAS Active
t <sub>CHCAV</sub>	101	CLKOUTA Low to Column Address Valid
tснск	38	X1 High Time
t <sub>CHCL</sub>	44	CLKOUTA High Time
t <sub>CHCSV</sub>	67	CLKOUTA High to ECS/UCS Valid
t <sub>CHCSX</sub>	18	MCS/PCS Inactive Delay
t <sub>CHCTV</sub>	22	Control Active Delay 2
t <sub>CHCV</sub>	64	Command Lines Valid Delay (after Float)
t <sub>CHCZ</sub>	63	Command Lines Float Delay
t <sub>CHDX</sub>	8	Status Hold Time
t <sub>CHLH</sub>	9	ALE Active Delay
t <sub>CHLL</sub>	11	ALE Inactive Delay
t <sub>CHRA</sub>	106	CLKOUTA High to RAS Active
t <sub>CHSV</sub>	3	Status Active Delay
t <sub>CICOA</sub>	69	X1 to CLKOUTA Skew
tсісов	70	X1 to CLKOUTB Skew
t <sub>CHRX</sub>	103	CLKOUTA High to RAS Inactive
t <sub>CKHL</sub>	39	X1 Fall Time
<sup>t</sup> скіл	36	X1 Period
t <sub>CKLH</sub>	40	X1 Rise Time
t <sub>CL2CL1</sub>	46	CLKOUTA Fall Time
t <sub>CLARX</sub>	50	ARDY Active Hold Time
t <sub>CLAV</sub>	5	AD Address Valid Delay and BHE
t <sub>CLAX</sub>	6	Address Hold
t <sub>CLAZ</sub>	15	AD Address Float Delay
t <sub>CLCH</sub>	43	CLKOUTA Low Time
t <sub>CLCK</sub>	37	X1 Low Time
t <sub>CLCL</sub>	42	CLKOUTA Period

# Alphabetical Key to Switching Parameter Symbols (continued)

Parameter Symbol	No.	Description	
t <sub>CLCSV</sub>	16	MCS/PCS Active Delay	
t <sub>CLCX</sub>	105	CLKOUTA Low to CAS Inactive	
t <sub>CLRX</sub>	107	CLKOUTA Low to RAS Inactive	
t <sub>CLDOX</sub>	30	Data Hold Time	
t <sub>CLDV</sub>	7	Data Valid Delay	
t <sub>CLDX</sub>	2	Data in Hold	
t <sub>CLHAV</sub>	62	HLDA Valid Delay	
t <sub>CLRA</sub>	102	CLKOUTA Low to RAS Active	
t <sub>CLRH</sub>	27	RD Inactive Delay	
t <sub>CLRL</sub>	25	RD Active Delay	
t <sub>CLSH</sub>	4	Status Inactive Delay	
t <sub>CLSRY</sub>	48	SRDY Transition Hold Time	
t <sub>CLTMV</sub>	55	Timer Output Delay	
t <sub>COAOB</sub> <sup>(a)</sup>	83	CLKOUTA to CLKOUTB Skew	
t <sub>CSHARYL</sub> <sup>(a)</sup>	88	Chip Select to ARDY Low	
t <sub>CVCTV</sub>	20	Control Active Delay 1	
t <sub>CVCTX</sub>	31	Control Inactive Delay	
t <sub>CVDEX</sub>	21	DEN Inactive Delay	
t <sub>CXCSX</sub>	17	MCS/PCS Hold from Command Inactive	
t <sub>DSHDIR</sub> <sup>(a)</sup>	92	DS High to Data Invalid—Read	
t <sub>DSHDIW</sub>	98	DS High to Data Invalid-Write	
t <sub>DSHDX</sub> <sup>(a)</sup>	93	DS High to Data Bus Turn-off Time	
t <sub>DSHLH</sub>	41	DS Inactive to ALE Inactive	
t <sub>DSLDD</sub> <sup>(a)</sup>	90	DS Low to Data Driven	
t <sub>DSLDV</sub> <sup>(a)</sup>	91	DS Low to Data Valid	
t <sub>DVCL</sub>	1	Data in Setup	
t <sub>DVDSL</sub> <sup>(a)</sup>	97	Data Valid to DS Low	
t <sub>DXDL</sub>	19	DEN Inactive to DT/R Low	
t <sub>HVCL</sub>	58	HOLD Setup	
t <sub>INVCH</sub>	53	Peripheral Setup Time	
t <sub>INVCL</sub>	54	DRQ Setup Time	
t <sub>LHAV</sub>	23	ALE High to Address Valid	
t <sub>LHLL</sub>	10	ALE Width	
t <sub>LLAX</sub>	13	AD Address Hold from ALE Inactive	
t <sub>LOCK</sub>	61	Maximum PLL Lock Time	
t <sub>PLAL</sub>	99	PCS Active to ALE Inactive	
t <sub>RD0W</sub>	110	RAS To Column Address Delay Time with 0 Wait States	
t <sub>RD1W</sub>	111	RAS to Column Address Delay Time with 1 or More Wait States	
t <sub>RESIN</sub>	57	RES Setup Time	
t <sub>RHAV</sub>	29	RD Inactive to AD Address Active	
t <sub>RHDX</sub>	59	RD High to Data Hold on AD Bus	
t <sub>RHDZ</sub> <sup>(a)</sup>	94	RD High to Data Bus Turn-off Time	
t <sub>RHLH</sub>	28	RD Inactive to ALE High	

### Alphabetical Key to Switching Parameter Symbols (continued)

Parameter Symbol	No.	Description
t <sub>RLRH</sub>	26	RD Pulse Width
t <sub>RP0W</sub>	108	RAS Inactive Pulse Width (0 Wait States)
t <sub>RP1W</sub>	109	RAS Inactive Pulse Width (1 Wait State)
t <sub>SRYCL</sub>	47	SRDY Transition Setup Time
t <sub>WHDEX</sub>	35	WR Inactive to DEN Inactive
t <sub>WHDX</sub>	34	Data Hold after WR
t <sub>WHLH</sub>	33	WR Inactive to ALE High
t <sub>WLWH</sub>	32	WR Pulse Width

Note:

a Specs 83 and 88–97 are defined but not used at this time. Additionally, the following parameters are not defined nor used at this time: 56, 60, and 71–78.



# Numerical Key to Switching Parameter Symbols

No.	Parameter Symbol	Description
1	t <sub>DVCL</sub>	Data in Setup
2	t <sub>CLDX</sub>	Data in Hold
3	t <sub>CHSV</sub>	Status Active Delay
4	t <sub>CLSH</sub>	Status Inactive Delay
5	t <sub>CLAV</sub>	AD Address Valid Delay and BHE
6	t <sub>CLAX</sub>	Address Hold
7	t <sub>CLDV</sub>	Data Valid Delay
8	t <sub>CHDX</sub>	Status Hold Time
9	t <sub>CHLH</sub>	ALE Active Delay
10	t <sub>LHLL</sub>	ALE Width
11	t <sub>CHLL</sub>	ALE Inactive Delay
12	t <sub>AVLL</sub>	AD Address Valid to ALE Low
13	t <sub>LLAX</sub>	AD Address Hold from ALE Inactive
14	t <sub>AVCH</sub>	AD Address Valid to Clock High
15	t <sub>CLAZ</sub>	AD Address Float Delay
16	t <sub>CLCSV</sub>	MCS/PCS Active Delay
17	t <sub>CXCSX</sub>	MCS/PCS Hold from Command Inactive
18	t <sub>CHCSX</sub>	MCS/PCS Inactive Delay
19	t <sub>DXDL</sub>	DEN Inactive to DT/R Low
20	t <sub>CVCTV</sub>	Control Active Delay 1
21	t <sub>CVDEX</sub>	DEN Inactive Delay
22	t <sub>CHCTV</sub>	Control Active Delay 2
23	t <sub>LHAV</sub>	ALE High to Address Valid
24	t <sub>AZRL</sub>	AD Address Float to RD Active
25	t <sub>CLRL</sub>	RD Active Delay
26	t <sub>RLRH</sub>	RD Pulse Width
27	t <sub>CLRH</sub>	RD Inactive Delay
28	t <sub>RHLH</sub>	RD Inactive to ALE High
29	t <sub>RHAV</sub>	RD Inactive to AD Address Active
30	t <sub>CLDOX</sub>	Data Hold Time
31	t <sub>CVCTX</sub>	Control Inactive Delay
32	t <sub>WLWH</sub>	WR Pulse Width
33	t <sub>WHLH</sub>	WR Inactive to ALE High
34	t <sub>WHDX</sub>	Data Hold after WR
35	t <sub>WHDEX</sub>	WR Inactive to DEN Inactive
36	t <sub>CKIN</sub>	X1 Period
37	t <sub>CLCK</sub>	X1 Low Time
38	t <sub>снск</sub>	X1 High Time
39	t <sub>CKHL</sub>	X1 Fall Time
40	t <sub>CKLH</sub>	X1 Rise Time
41	t <sub>DSHLH</sub>	DS Inactive to ALE Inactive
42	t <sub>CLCL</sub>	CLKOUTA Period

# Numerical Key to Switching Parameter Symbols (continued)

No.	Parameter Symbol	Description
43	t <sub>CLCH</sub>	CLKOUTA Low Time
44	t <sub>CHCL</sub>	CLKOUTA High Time
45	t <sub>CH1CH2</sub>	CLKOUTA Rise Time
46	t <sub>CL2CL1</sub>	CLKOUTA Fall Time
47	t <sub>SRYCL</sub>	SRDY Transition Setup Time
48	t <sub>CLSRY</sub>	SRDY Transition Hold Time
49	t <sub>ARYCH</sub>	ARDY Resolution Transition Setup Time
50	t <sub>CLARX</sub>	ARDY Active Hold Time
51	t <sub>ARYCHL</sub>	ARDY Inactive Holding Time
52	t <sub>ARYLCL</sub>	ARDY Setup Time
53	t <sub>INVCH</sub>	Peripheral Setup Time
54	t <sub>INVCL</sub>	DRQ Setup Time
55	t <sub>CLTMV</sub>	Timer Output Delay
57	t <sub>RESIN</sub>	RES Setup Time
58	t <sub>HVCL</sub>	HOLD Setup
59	t <sub>RHDX</sub>	RD High to Data Hold on AD Bus
61	t <sub>LOCK</sub>	Maximum PLL Lock Time
62	t <sub>CLHAV</sub>	HLDA Valid Delay
63	t <sub>CHCZ</sub>	Command Lines Float Delay
64	t <sub>CHCV</sub>	Command Lines Valid Delay (after Float)
65	t <sub>AVWL</sub>	A Address Valid to WR Low
66	t <sub>AVRL</sub>	A Address Valid to RD Low
67	t <sub>CHCSV</sub>	CLKOUTA High to ECS/UCS Valid
68	t <sub>CHAV</sub>	CLKOUTA High to A Address Valid
69	tcicoa	X1 to CLKOUTA Skew
70	tсісов	X1 to CLKOUTB Skew
83 <sup>(a)</sup>	t <sub>COAOB</sub>	CLKOUTA to CLKOUTB Skew
87	t <sub>AVBL</sub>	A Address Valid to WHB, WLB Low
88 <sup>(a)</sup>	t <sub>CSHARYL</sub>	Chip Select to ARDY Low
89 <sup>(a)</sup>	t <sub>ARYHDV</sub>	ARDY Assert to Data Valid
90 <sup>(a)</sup>	t <sub>DSLDD</sub>	DS Low to Data Driven
91 <sup>(a)</sup>	t <sub>DSLDV</sub>	DS Low to Data Valid
92 <sup>(a)</sup>	t <sub>DSHDIR</sub>	DS High to Data Invalid—Read
93 <sup>(a)</sup>	t <sub>DSHDX</sub>	DS High to Data Bus Turn-off Time

No.	Parameter Symbol	Description
94 <sup>(a)</sup>	t <sub>RHDZ</sub>	RD High to Data Bus Turn-off Time
95 <sup>(a)</sup>	t <sub>ARYHDSH</sub>	ARDY High to DS High
96 <sup>(a)</sup>	t <sub>ARYLDSH</sub>	ARDY Low to DS High
97 <sup>(a)</sup>	t <sub>DVDSL</sub>	Data Valid to DS Low
98	t <sub>DSHDIW</sub>	DS High to Data Invalid—Write
99	t <sub>PLAL</sub>	PCS Active to ALE Inactive
101	t <sub>CHCAV</sub>	CLKOUTA Low to Column Address Valid
102	t <sub>CLRA</sub>	CLKOUTA Low to RAS Active
103	t <sub>CHRX</sub>	CLKOUTA High to RAS Inactive
104	t <sub>CHCA</sub>	CLKOUTA High to CAS Active
105	t <sub>CLCX</sub>	CLKOUTA Low to CAS Inactive
106	t <sub>CHRA</sub>	CLKOUTA High to RAS Active
107	t <sub>CLRX</sub>	CLKOUTA Low to RAS Inactive
108	t <sub>RP0W</sub>	RAS Inactive Pulse Width (0 Wait States)
109	t <sub>RP1W</sub>	RAS Inactive Pulse Width (1 Wait State)
110	t <sub>RD0W</sub>	RAS To Column Address Delay Time with 0 Wait States
111	t <sub>RD1W</sub>	RAS to Column Address Delay Time with 1 or More Wait States

# Numerical Key to Switching Parameter Symbols (continued)

#### Note:

a Specs 83 and 88–97 are defined but not used at this time. Additionally, the following parameters are not defined nor used at this time: 56, 60, and 71–78.

# SWITCHING CHARACTERISTICS over COMMERCIAL and INDUSTRIAL operating ranges Read Cycle (20 MHz and 25 MHz)

			Preliminary					
		20 MHz		25 MHz				
No.	Symbol	Description	Min	Max	Min	Max	Unit	
Genera	I Timing Re	quirements		•				
1	t <sub>DVCL</sub>	Data in Setup	10		10		ns	
2	t <sub>CLDX</sub>	Data in Hold <sup>(c)</sup>	3		3		ns	
Genera	I Timing Re	sponses					-	
3	t <sub>CHSV</sub>	Status Active Delay	0	25	0	20	ns	
4	t <sub>CLSH</sub>	Status Inactive Delay	0	25	0	20	ns	
5	t <sub>CLAV</sub>	AD Address Valid Delay and BHE	0	25	0	20	ns	
6	t <sub>CLAX</sub>	Address Hold	0	25	0	20	ns	
8	t <sub>CHDX</sub>	Status Hold Time	0		0		ns	
9	t <sub>CHLH</sub>	ALE Active Delay		25		20	ns	
10	t <sub>LHLL</sub>	ALE Width	$t_{CLCL}$ -10=40		t <sub>CLCL</sub> -10=30		ns	
11	t <sub>CHLL</sub>	ALE Inactive Delay		25		20	ns	
12	t <sub>AVLL</sub>	AD Address Valid to ALE Low <sup>(a)</sup>	t <sub>CLCH</sub> -2		t <sub>CLCH</sub> -2		ns	
13	t <sub>LLAX</sub>	AD Address Hold from ALE Inactive <sup>(a)</sup>	t <sub>CHCL</sub> -2		t <sub>CHCL</sub> -2		ns	
14	t <sub>AVCH</sub>	AD Address Valid to Clock High	0	1.5	0		ns	
15	t <sub>CLAZ</sub>	AD Address Float Delay	t <sub>CLAX</sub> =0	25	t <sub>CLAX</sub> =0	20	ns	
16	t <sub>CLCSV</sub>	MCS/PCS Active Delay	0, 19	25	0	20	ns	
17	t <sub>CXCSX</sub>	MCS/PCS Hold from Command Inactive <sup>(a)</sup>	t <sub>CLCH</sub> -2	0.	t <sub>CLCH</sub> -2		ns	
18	t <sub>CHCSX</sub>	MCS/PCS Inactive Delay	0	25	0	20	ns	
19	t <sub>DXDL</sub>	DEN Inactive to DT/R Low <sup>(a)</sup>	0		0		ns	
20	t <sub>CVCTV</sub>	Control Active Delay 1 <sup>(b)</sup>	0	25	0	20	ns	
21	t <sub>CVDEX</sub>	DEN Inactive Delay	0	25	0	20	ns	
22	t <sub>CHCTV</sub>	Control Active Delay 2 <sup>(b)</sup>	0	25	0	20	ns	
23	t <sub>LHAV</sub>	ALE High to Address Valid	20		15		ns	
99	t <sub>PLAL</sub>	PCS Active to ALE Inactive	15	28	15	24	ns	
Read C	ycle Timing	Responses						
24	t <sub>AZRL</sub>	AD Address Float to RD Active	0		0		ns	
25	t <sub>CLRL</sub>	RD Active Delay	0	25	0	20	ns	
26	t <sub>RLRH</sub>	RD Pulse Width	2t <sub>CLCL</sub> -15=85		2t <sub>CLCL</sub> -15=65		ns	
27	t <sub>CLRH</sub>	RD Inactive Delay	0	25	0	20	ns	
28	t <sub>RHLH</sub>	RD Inactive to ALE High <sup>(a)</sup>	t <sub>CLCH</sub> -3		t <sub>CLCH</sub> -3		ns	
29	t <sub>RHAV</sub>	RD Inactive to AD Address Active <sup>(a)</sup>	$t_{CLCL}$ -10=40		$t_{CLCL}$ -10=30		ns	
41	t <sub>DSHLH</sub>	DS Inactive to ALE Active	t <sub>CLCH</sub> -2=21		t <sub>CLCH</sub> -2=16		ns	
59	t <sub>RHDX</sub>	RD High to Data Hold on AD Bus <sup>(c)</sup>	0		0		ns	
66	t <sub>AVRL</sub>	A Address Valid to RD Low <sup>(a)</sup>	t <sub>CLCL</sub> + t <sub>CHCL</sub> -3		t <sub>CLCL</sub> + t <sub>CHCL</sub> -3		ns	
67	t <sub>CHCSV</sub>	CLKOUTA High to LCS/UCS Valid	0	25	0	20	ns	
68	t <sub>CHAV</sub>	CLKOUTA High to A Address Valid	0	25	0	20	ns	

#### Notes:

All timing parameters are measured at 1.5 V with 50 pF loading on CLKOUTA, unless otherwise noted. All output test conditions are with  $C_L$  = 50 pF. For switching tests,  $V_{IL}$  = 0.45 V and  $V_{IH}$  = 2.4 V, except at X1 where  $V_{IH}$  =  $V_{CC}$  – 0.5 V.

a Equal loading on referenced pins.

- b This parameter applies to the  $\overline{DEN}$ ,  $\overline{DS}$ ,  $\overline{INTA1}$ – $\overline{INTA0}$ ,  $\overline{WR}$ ,  $\overline{WHB}$ , and  $\overline{WLB}$  signals.
- c If either spec 2 or spec 59 is met with respect to data hold time, the part will function correctly.

# SWITCHING CHARACTERISTICS over COMMERCIAL operating ranges

# Read Cycle (33 MHz and 40 MHz)

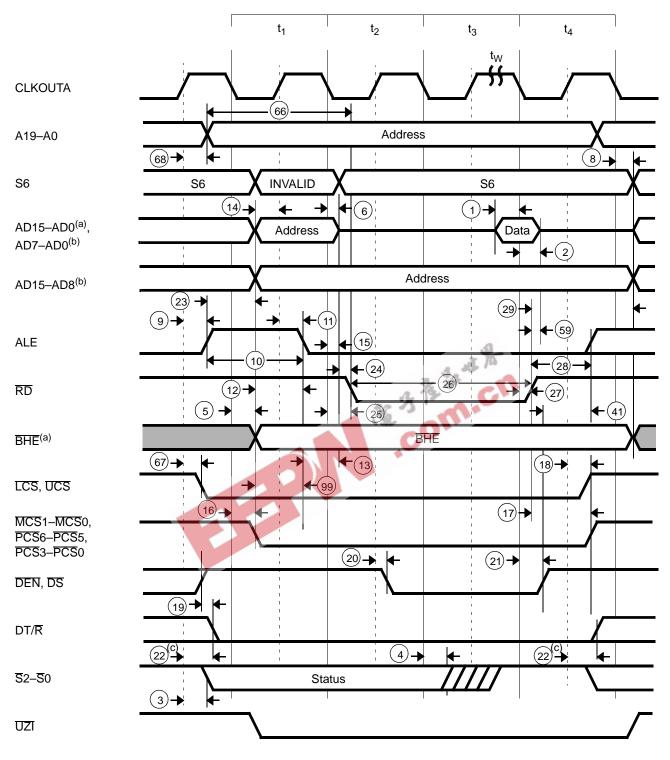
		Preliminary					
		33 MHz		40 MHz		1	
No.	Symbol	Description	Min	Max	Min	Max	Unit
Genera	al Timing R	equirements					
1	t <sub>DVCL</sub>	Data in Setup	8		5		ns
2	t <sub>CLDX</sub>	Data in Hold <sup>(c)</sup>	3		2		ns
Genera	al Timing R	esponses					
3	t <sub>CHSV</sub>	Status Active Delay	0	15	0	12	ns
4	t <sub>CLSH</sub>	Status Inactive Delay	0	15	0	12	ns
5	t <sub>CLAV</sub>	AD Address Valid Delay and BHE	0	15	0	12	ns
6	t <sub>CLAX</sub>	Address Hold	0	15	0	12	ns
8	t <sub>CHDX</sub>	Status Hold Time	0		0		ns
9	t <sub>CHLH</sub>	ALE Active Delay		15		12	ns
10	t <sub>LHLL</sub>	ALE Width	t <sub>CLCL</sub> -10=20		t <sub>CLCL</sub> -5=20		ns
11	t <sub>CHLL</sub>	ALE Inactive Delay	0101	15		12	ns
12	t <sub>AVLL</sub>	AD Address Valid to ALE Low <sup>(a)</sup>	t <sub>CLCH</sub> -2		t <sub>CLCH</sub> -2		ns
13	t <sub>LLAX</sub>	AD Address Hold from ALE Inactive <sup>(a)</sup>	t <sub>CHCL</sub> -2		t <sub>CHCL</sub> -2		ns
14	t <sub>AVCH</sub>	AD Address Valid to Clock High	0	3	0		ns
15	t <sub>CLAZ</sub>	AD Address Float Delay	t <sub>CLAX</sub> =0	15	t <sub>CLAX</sub> =0	12	ns
16	t <sub>CLCSV</sub>	MCS/PCS Active Delay	0	15	0	12	ns
17	t <sub>CXCSX</sub>	MCS/PCS Hold from Command Inactive <sup>(a)</sup>	t <sub>CLCH</sub> -2		t <sub>CLCH</sub> -2		ns
18	tCHCSX	MCS/PCS Inactive Delay	0	15	0	12	ns
19	t <sub>DXDL</sub>	DEN Inactive to DT/R Low <sup>(a)</sup>	0		0		ns
20	t <sub>CVCTV</sub>	Control Active Delay 1 <sup>(b)</sup>	0	15	0	12	ns
21	t <sub>CVDEX</sub>	DEN Inactive Delay	0	15	0	12	ns
22	t <sub>CHCTV</sub>	Control Active Delay 2 <sup>(b)</sup>	0	15	0	12	ns
23	t <sub>LHAV</sub>	ALE High to Address Valid	10		7.5		ns
99	t <sub>PLAL</sub>	PCS Active to ALE Inactive	12	20	10	18	ns
Read C		g Responses					1
24	t <sub>AZRL</sub>	AD Address Float to RD Active	0		0		ns
25	t <sub>CLRL</sub>	RD Active Delay	0	15	0	10	ns
26	t <sub>RLRH</sub>	RD Pulse Width	2t <sub>CLCL</sub> -15=45		$2t_{CLCL}-10=40$		ns
27	t <sub>CLRH</sub>	RD Inactive Delay	0	15	0	12	ns
28	t <sub>RHLH</sub>	RD Inactive to ALE High <sup>(a)</sup>	t <sub>CLCH</sub> -3		t <sub>CLCH</sub> -2		ns
29	t <sub>RHAV</sub>	RD Inactive to AD Address Active <sup>(a)</sup>	t <sub>CLCL</sub> -10=20		t <sub>CLCL</sub> -5=20		ns
41	t <sub>DSHLH</sub>	DS Inactive to ALE Active	t <sub>CLCH</sub> -2=11.5		t <sub>CLCH</sub> -2=9.25		
59	t <sub>RHDX</sub>	RD High to Data Hold on AD Bus <sup>(c)</sup>	0		0		ns
66	t <sub>AVRL</sub>	A Address Valid to RD Low <sup>(a)</sup>	t <sub>CLCL</sub> + t <sub>CHCL</sub> -3		t <sub>CLCL</sub> +t <sub>CHCL</sub> -1.25		ns
67	t <sub>CHCSV</sub>	CLKOUTA High to LCS/UCS Valid	0	15	0	10	ns
68	t <sub>CHAV</sub>	CLKOUTA High to A Address Valid	0	15	0	10	ns

#### Notes:

All timing parameters are measured at 1.5 V with 50 pF loading on CLKOUTA, unless otherwise noted. All output test conditions are with  $C_L$ =50 pF. For switching tests,  $V_{IL}$ =0.45 V and  $V_{IH}$ =2.4 V, except at X1 where  $V_{IH}$ = $V_{CC}$ -0.5 V.

- a Equal loading on referenced pins.
- b This parameter applies to the  $\overline{DEN}$ ,  $\overline{DS}$ ,  $\overline{INTA1}$ – $\overline{INTA0}$ ,  $\overline{WR}$ ,  $\overline{WHB}$ , and  $\overline{WLB}$  signals.
- c If either spec 2 or spec 59 is met with respect to data hold time, the part will function correctly.

# **READ CYCLE WAVEFORMS**



#### Notes:

- a Am186ED/EDLV microcontrollers in 16-bit mode
- b Am186ED/EDLV microcontrollers in 8-bit mode
- c Changes in t phase preceding next bus cycle if followed by read, INTA, or halt.

# SWITCHING CHARACTERISTICS over COMMERCIAL and INDUSTRIAL operating ranges Write Cycle (20 MHz and 25 MHz)

			Preliminary					
		Parameter	20 MHz		25 MHz		1	
No.			Min	Max	Min	Max	Unit	
Genera	al Timing R	esponses						
3	t <sub>CHSV</sub>	Status Active Delay	0	25	0	20	ns	
4	t <sub>CLSH</sub>	Status Inactive Delay	0	25	0	20	ns	
5	t <sub>CLAV</sub>	AD Address Valid Delay and BHE	0	25	0	20	ns	
6	t <sub>CLAX</sub>	Address Hold	0	25	0	20	ns	
7	t <sub>CLDV</sub>	Data Valid Delay	0	15	0	15	ns	
8	t <sub>CHDX</sub>	Status Hold Time	0		0		ns	
9	t <sub>CHLH</sub>	ALE Active Delay		25		20	ns	
10	t <sub>LHLL</sub>	ALE Width	t <sub>CLCL</sub> -10=40		t <sub>CLCL</sub> -10=30		ns	
11	t <sub>CHLL</sub>	ALE Inactive Delay		25		20	ns	
12	t <sub>AVLL</sub>	AD Address Valid to ALE Low <sup>(a)</sup>	t <sub>CLCH</sub> -2		t <sub>CLCH</sub> -2		ns	
13	t <sub>LLAX</sub>	AD Address Hold from ALE Inactive <sup>(a)</sup>	t <sub>CHCL</sub> -2		t <sub>CHCL</sub> -2		ns	
14	t <sub>AVCH</sub>	AD Address Valid to Clock High	0		0		ns	
16	t <sub>CLCSV</sub>	MCS/PCS Active Delay	0	25	0	20	ns	
17	t <sub>CXCSX</sub>	MCS/PCS Hold from Command Inactive <sup>(a)</sup>	t <sub>CLCH</sub> -2	. A.T	t <sub>CLCH</sub> -2		ns	
18	t <sub>CHCSX</sub>	MCS/PCS Inactive Delay	0	25	0	20	ns	
19	t <sub>DXDL</sub>	DEN Inactive to DT/R Low <sup>(a)</sup>	0,12	S S	0		ns	
20	t <sub>CVCTV</sub>	Control Active Delay 1 <sup>(b)</sup>	0	15	0	15	ns	
21	t <sub>CVDEX</sub>	DS Inactive Delay	0	25	0	20	ns	
22	t <sub>CHCTV</sub>	Control Active Delay 2	0	25	0	20	ns	
23	t <sub>LHAV</sub>	ALE High to Address Valid	20		15		ns	
99	t <sub>PLAL</sub>	PCS Active to ALE Inactive	15	28	15	24	ns	
Write C	Cycle Timin	g Responses						
30	t <sub>CLDOX</sub>	Data Hold Time	0		0		ns	
31	t <sub>CVCTX</sub>	Control Inactive Delay <sup>(b)</sup>	0	25	0	20	ns	
32	t <sub>WLWH</sub>	WR Pulse Width	$2t_{CLCL} - 10 = 90$		$2t_{CLCL}-10=70$		ns	
33	t <sub>WHLH</sub>	WR Inactive to ALE High <sup>(a)</sup>	t <sub>CLCH</sub> -2		t <sub>CLCH</sub> -2		ns	
34	t <sub>WHDX</sub>	Data Hold after WR <sup>(a)</sup>	$t_{CLCL} - 10 = 40$		t <sub>CLCL</sub> -10=30		ns	
35	t <sub>WHDEX</sub>	WR Inactive to DEN Inactive <sup>(a)</sup>	t <sub>CLCH</sub> -3		t <sub>CLCH</sub> -3		ns	
41	t <sub>DSHLH</sub>	DS Inactive to ALE Active	t <sub>CLCH</sub> -2=21		t <sub>CLCH</sub> -2=16		ns	
65	t <sub>AVWL</sub>	A Address Valid to WR Low	t <sub>CLCL</sub> +t <sub>CHCL</sub> -3		t <sub>CLCL</sub> +t <sub>CHCL</sub> -3		ns	
67	t <sub>CHCSV</sub>	CLKOUTA High to LCS/UCS Valid	0	25	0	20	ns	
68	t <sub>CHAV</sub>	CLKOUTA High to A Address Valid	0	25	0	20	ns	
87	t <sub>AVBL</sub>	A Address Valid to WHB, WLB Low	t <sub>CHCL</sub> -3	25	t <sub>CHCL</sub> -3	20	ns	
98	t <sub>DSHDIW</sub>	DS High to Data Invalid—Write	35		30		ns	

#### Notes:

All timing parameters are measured at 1.5 V with 50 pF loading on CLKOUTA, unless otherwise noted. All output test conditions are with  $C_L$  = 50 pF. For switching tests,  $V_{IL}$  = 0.45 V and  $V_{IH}$  = 2.4 V, except at X1 where  $V_{IH}$  =  $V_{CC}$  – 0.5 V.

a Testing is performed with equal loading on referenced pins.

b This parameter applies to the DEN, DS, INTA1–INTA0, WR, WHB, and WLB signals.

# SWITCHING CHARACTERISTICS over COMMERCIAL operating ranges

# Write Cycle (33 MHz and 40 MHz)

			Preliminary					
		33 MHz		40 MHz				
No.			Min	Max	Min	Max	Unit	
Genera	al Timing R	esponses						
3	t <sub>CHSV</sub>	Status Active Delay	0	15	0	12	ns	
4	t <sub>CLSH</sub>	Status Inactive Delay	0	15	0	12	ns	
5	t <sub>CLAV</sub>	AD Address Valid Delay and BHE	0	15	0	12	ns	
6	t <sub>CLAX</sub>	Address Hold	0		0		ns	
7	t <sub>CLDV</sub>	Data Valid Delay	0	15	0	12	ns	
8	t <sub>CHDX</sub>	Status Hold Time	0		0		ns	
9	t <sub>CHLH</sub>	ALE Active Delay		15		12	ns	
10	t <sub>LHLL</sub>	ALE Width	$t_{CLCL}$ -10=20		t <sub>CLCL</sub> -5=20		ns	
11	t <sub>CHLL</sub>	ALE Inactive Delay		15		12	ns	
12	t <sub>AVLL</sub>	AD Address Valid to ALE Low <sup>(a)</sup>	t <sub>CLCH</sub> -2		t <sub>CLCH</sub> -2		ns	
13	t <sub>LLAX</sub>	AD Address Hold from ALE Inactive <sup>(a)</sup>	t <sub>CHCL</sub> -2		t <sub>CHCL</sub> -2		ns	
14	t <sub>AVCH</sub>	AD Address Valid to Clock High	0		0		ns	
16	t <sub>CLCSV</sub>	MCS/PCS Active Delay	0	15	0	12	ns	
17	t <sub>CXCSX</sub>	MCS/PCS Hold from Command Inactive <sup>(a)</sup>	t <sub>CLCH</sub> -2		t <sub>CLCH</sub> -2		ns	
18	t <sub>CHCSX</sub>	MCS/PCS Inactive Delay	0	15	0	12	ns	
19	t <sub>DXDL</sub>	DEN Inactive to DT/R Low <sup>(a)</sup>	0, 19		0		ns	
20	t <sub>CVCTV</sub>	Control Active Delay 1 <sup>(b)</sup>	0	15	0	12	ns	
21	t <sub>CVDEX</sub>	DS Inactive Delay	0	15	0	12	ns	
22	t <sub>CHCTV</sub>	Control Active Delay 2	0	15	0	12	ns	
23	t <sub>LHAV</sub>	ALE High to Address Valid	10		7.5		ns	
99	t <sub>PLAL</sub>	PCS Active to ALE Inactive	12	20	10	18	ns	
Write C	Cycle Timin	g Responses						
30	t <sub>CLDOX</sub>	Data Hold Time	0		0		ns	
31	t <sub>CVCTX</sub>	Control Inactive Delay <sup>(b)</sup>	0	15	0	12	ns	
32	t <sub>WLWH</sub>	WR Pulse Width	2t <sub>CLCL</sub> -10=50		$2t_{CLCL} - 10 = 40$		ns	
33	t <sub>WHLH</sub>	WR Inactive to ALE High <sup>(a)</sup>	t <sub>CLCH</sub> -2		t <sub>CLCH</sub> -2		ns	
34	t <sub>WHDX</sub>	Data Hold after WR <sup>(a)</sup>	$t_{CLCL}$ -10=20		$t_{CLCL} - 10 = 15$		ns	
35	t <sub>WHDEX</sub>	WR Inactive to DEN Inactive <sup>(a)</sup>	t <sub>CLCH</sub> -3		t <sub>CLCH</sub> -3		ns	
41	t <sub>DSHLH</sub>	DS Inactive to ALE Active	t <sub>CLCH</sub> -2=11.5		t <sub>CLCH</sub> -2=9.25		ns	
65	t <sub>AVWL</sub>	A Address Valid to WR Low	t <sub>CLCL</sub> +t <sub>CHCL</sub> -3		t <sub>CLCL</sub> +t <sub>CHCL</sub> -1.25		ns	
67	t <sub>CHCSV</sub>	CLKOUTA High to LCS/UCS Valid	0	15	0	10	ns	
68	t <sub>CHAV</sub>	CLKOUTA High to A Address Valid	0	15	0	10	ns	
87	t <sub>AVBL</sub>	A Address Valid to WHB, WLB Low	t <sub>CHCL</sub> -3	15	t <sub>CHCL</sub> -1.25	12	ns	
98	t <sub>DSHDIW</sub>	DS High to Data Invalid—Write	20		15		ns	

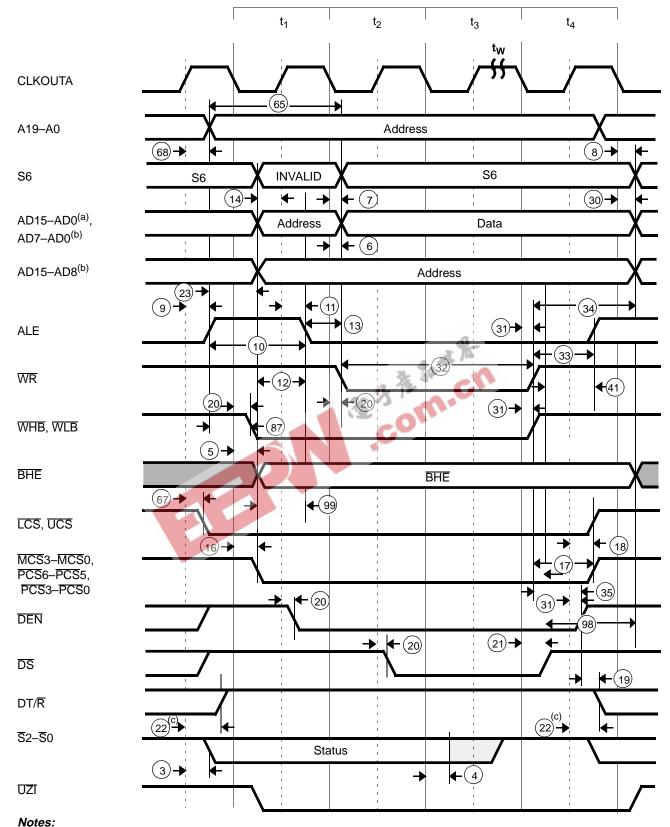
#### Notes:

All timing parameters are measured at 1.5 V with 50 pF loading on CLKOUTA, unless otherwise noted. All output test conditions are with  $C_L$ =50 pF. For switching tests,  $V_{IL}$ =0.45 V and  $V_{IH}$ =2.4 V, except at X1 where  $V_{IH}$ = $V_{CC}$  – 0.5 V.

a Testing is performed with equal loading on referenced pins.

b This parameter applies to the DEN, DS, INTA1–INTA0, WR, WHB, and WLB signals.

#### WRITE CYCLE WAVEFORMS



#### a Am186ED/EDLV microcontrollers in 16-bit mode

b Am186ED/EDLV microcontrollers in 8-bit mode

c Changes in t phase preceding next bus cycle if followed by read, INTA, or halt

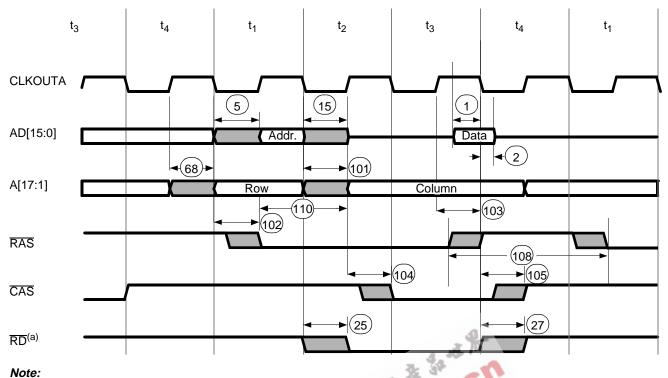
# SWITCHING CHARACTERISTICS over COMMERCIAL and INDUSTRIAL operating ranges DRAM

						Prelin	ninary				
		Parameter	20	MHz	25 I	MHz	33 I	MHz	40	MHz	
No.	Symbol	Description	Min	Max	Min	Max	Min	Max	Min	Max	Unit
Gene	ral Timing	Responses									
101	t <sub>CHCAV</sub>	CLKOUTA Low to Column Address Valid	0	25	0	20	0	15	0	12	ns
102	t <sub>CLRA</sub>	CLKOUTA Low to RAS Active	3	25	3	20	3	15	3	12	ns
103	t <sub>CHRX</sub>	CLKOUTA High to RAS Inactive	3	25	3	20	3	15	3	12	ns
104	t <sub>CHCA</sub>	CLKOUTA High to CAS Active	3	25	3	20	3	15	3	12	ns
105	t <sub>CLCX</sub>	CLKOUTA Low to CAS Inactive	3	25	3	20	3	15	3	12	ns
106	t <sub>CHRA</sub>	CLKOUTA High to RAS Active	3	25	3	20	3	15	3	12	ns
107	t <sub>CLRX</sub>	CLKOUTA Low to RAS Inactive	3	25	3	20	3	15	3	12	ns
108	t <sub>RP0W</sub>	RAS Inactive Pulse Width with 0 Wait States	60	-	50	—	40	—	30	—	ns
109	t <sub>RP1W</sub>	RAS Inactive Pulse Width with 1 or More Wait States	70	-	60	—	50	—	40	—	ns
110	t <sub>RD0W</sub>	RAS To Column Address Delay Time with 0 Wait States	25	—	20	—	15	—	15	—	ns
111	t <sub>RD1W</sub>	RAS to Column Address Delay Time with 1 or More Wait States	30	—	25		20		15	—	ns

As guaranteed by design, the following table shows the minimum time for RAS assertion to RAS assertion. These minimums correlate to DRAM spec t<sub>RC</sub>.

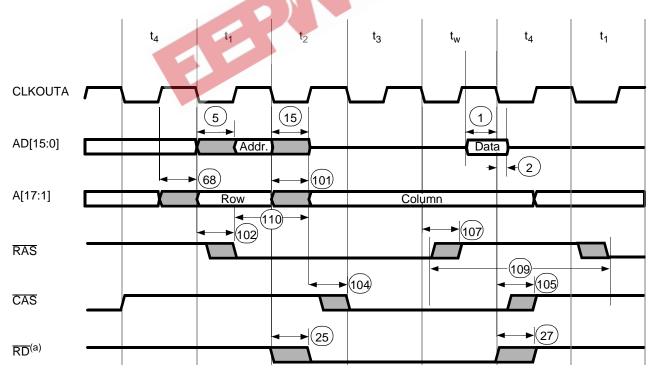
		Wait States			
		0	1	2	3
Frequency	40 MHz	90	110	130	150
	33 MHz	110	130	150	170
	25 MHz	130	150	170	190
Fre	20 MHz	150	170	190	210





a The RD output connects to the DRAM output enable (OE) pin for read operations.

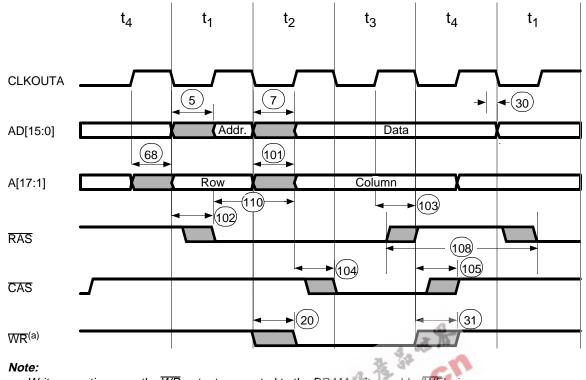
# DRAM Read Cycle Timing with Wait State(s)



#### Note:

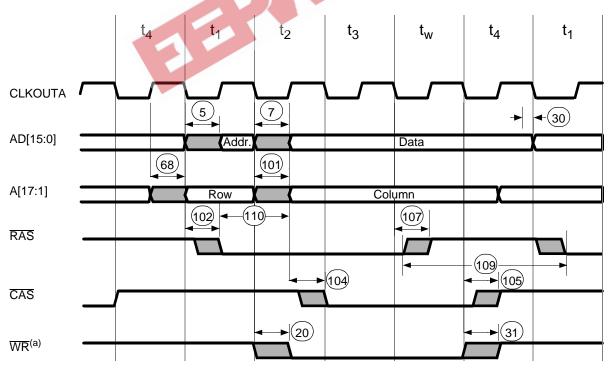
a The  $\overline{RD}$  output connects to the DRAM output enable ( $\overline{OE}$ ) pin for read operations.

# **DRAM Write Cycle Timing with No-Wait States**



a Write operations use the WR output connected to the DRAM write enable (WE) pin.

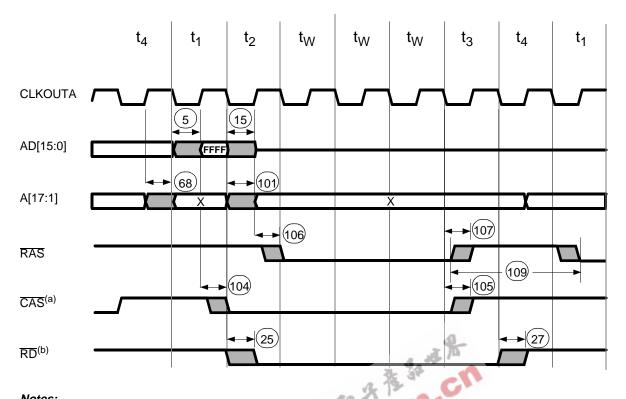
# DRAM Write Cycle Timing With Wait State(s)



#### Note:

a Write operations use the  $\overline{WR}$  output connected to the DRAM write enable ( $\overline{WE}$ ) pin.

### DRAM CAS-before-RAS Cycle Timing



- Notes: a CAS before RAS cycle timing is always 7 clocks, independent of wait state timing.
- The RD output connects to the DRAM output enable (OE) pin for read operations. b

1

### SWITCHING CHARACTERISTICS over COMMERCIAL and INDUSTRIAL operating ranges Interrupt Acknowledge Cycle (20 MHz and 25 MHz)

				Prelin	ninary		
		Parameter	20 MHz		25 MHz		
No.	Symbol	Description	Min	Max	Min	Max	Unit
Genera	I Timing Re	quirements				_	
1	t <sub>DVCL</sub>	Data in Setup	10		10		ns
2	t <sub>CLDX</sub>	Data in Hold	3		3		ns
Genera	I Timing Re	sponses					
3	t <sub>CHSV</sub>	Status Active Delay	0	25	0	20	ns
4	t <sub>CLSH</sub>	Status Inactive Delay	0	25	0	20	ns
7	t <sub>CLDV</sub>	Data Valid Delay	0	25	0	20	ns
8	t <sub>CHDX</sub>	Status Hold Time	0		0		ns
9	t <sub>CHLH</sub>	ALE Active Delay		25		20	ns
10	t <sub>LHLL</sub>	ALE Width	$t_{CLCL} - 10 = 40$		$t_{CLCL} - 10 = 30$		ns
11	t <sub>CHLL</sub>	ALE Inactive Delay		25		20	ns
12	t <sub>AVLL</sub>	AD Address Invalid to ALE Low <sup>(a)</sup>	t <sub>CLCH</sub> -2		t <sub>CLCH</sub> -2		ns
15	t <sub>CLAZ</sub>	AD Address Float Delay	t <sub>CLAX</sub> =0	25	t <sub>CLAX</sub> =0	20	ns
19	t <sub>DXDL</sub>	DEN Inactive to DT/R Low <sup>(a)</sup>	0		0		ns
20	t <sub>CVCTV</sub>	Control Active Delay 1 <sup>(b)</sup>	0	25	0	20	ns
21	t <sub>CVDEX</sub>	DEN Inactive Delay	0 🚜	<b>2</b> 5	0	20	ns
22	t <sub>CHCTV</sub>	Control Active Delay 2 <sup>(c)</sup>	0 % 1	25	0	20	ns
23	t <sub>LHAV</sub>	ALE High to Address Valid	20	U.	15		ns
31	t <sub>CVCTX</sub>	Control Inactive Delay <sup>(b)</sup>	0	25	0	20	ns
68	t <sub>CHAV</sub>	CLKOUTA High to A Address Valid	0	25	0	20	ns

#### Notes:

All timing parameters are measured at 1.5 V with 50 pF loading on CLKOUTA, unless otherwise noted. All output test conditions are with  $C_L$  = 50 pF. For switching tests,  $V_{IL}$  = 0.45 V and  $V_{IH}$  = 2.4 V, except at X1 where  $V_{IH}$  =  $V_{CC}$  = 0.5 V.

a Testing is performed with equal loading on referenced pins.

b This parameter applies to the INTA1–INTA0 signals.

c This parameter applies to the  $\overline{DEN}$  and  $DT/\overline{R}$  signals.

### SWITCHING CHARACTERISTICS over COMMERCIAL operating ranges Interrupt Acknowledge Cycle (33 MHz and 40 MHz)

				Prelin	ninary		
		Parameter	33 MHz		40 MHz		
No.	Symbol	Description	Min	Max	Min	Max	Unit
Genera	I Timing Re	quirements					
1	t <sub>DVCL</sub>	Data in Setup	8		5		ns
2	t <sub>CLDX</sub>	Data in Hold	3		2		ns
Genera	l Timing Re	sponses					
3	t <sub>CHSV</sub>	Status Active Delay	0	15	0	12	ns
4	t <sub>CLSH</sub>	Status Inactive Delay	0	15	0	12	ns
7	t <sub>CLDV</sub>	Data Valid Delay	0	15	0	12	ns
8	t <sub>CHDX</sub>	Status Hold Time	0		0		ns
9	t <sub>CHLH</sub>	ALE Active Delay		15		12	ns
10	t <sub>LHLL</sub>	ALE Width	$t_{CLCL} - 10 = 20$		t <sub>CLCL</sub> -5=20		ns
11	t <sub>CHLL</sub>	ALE Inactive Delay		15		12	ns
12	t <sub>AVLL</sub>	AD Address Invalid to ALE Low <sup>(a)</sup>	t <sub>CLCH</sub>		t <sub>CLCH</sub>		ns
15	t <sub>CLAZ</sub>	AD Address Float Delay	t <sub>CLAX</sub> =0	15	t <sub>CLAX</sub> =0	12	ns
19	t <sub>DXDL</sub>	DEN Inactive to DT/R Low <sup>(a)</sup>	0		0		ns
20	t <sub>CVCTV</sub>	Control Active Delay 1 <sup>(b)</sup>	0	15	0	12	ns
21	t <sub>CVDEX</sub>	DEN Inactive Delay	0 🚜	15	0	12	ns
22	t <sub>CHCTV</sub>	Control Active Delay 2 <sup>(c)</sup>	0 3 1	15	0	12	ns
23	t <sub>LHAV</sub>	ALE High to Address Valid	10	se.	7.5		ns
31	t <sub>CVCTX</sub>	Control Inactive Delay <sup>(b)</sup>	0	15	0	12	ns
68	t <sub>CHAV</sub>	CLKOUTA High to A Address Valid	0	15	0	10	ns

#### Notes:

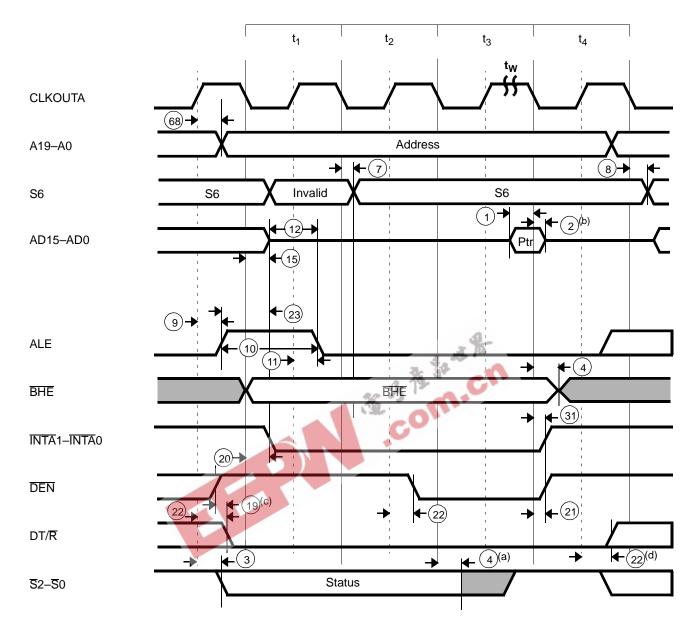
All timing parameters are measured at 1.5 V with 50 pF loading on CLKOUTA, unless otherwise noted. All output test conditions are with  $C_L$  = 50 pF. For switching tests,  $V_{IL}$  = 0.45 V and  $V_{IH}$  = 2.4 V, except at X1 where  $V_{IH}$  =  $V_{CC}$  = 0.5 V.

a Testing is performed with equal loading on referenced pins.

*b* This parameter applies to the INTA1–INTA0 signals.

c This parameter applies to the  $\overline{DEN}$  and  $DT/\overline{R}$  signals.

### INTERRUPT ACKNOWLEDGE CYCLE WAVEFORMS



#### Notes:

a The status bits become inactive in the state preceding t<sub>4</sub>.

- *b* The data hold time lasts only until the interrupt acknowledge signal deasserts, even if the interrupt acknowledge transition occurs prior to  $t_{CLDX}$  (min).
- *c* This parameter applies for an interrupt acknowledge cycle that follows a write cycle.
- d If followed by a write cycle, this change occurs in the state preceding that write cycle.

## SWITCHING CHARACTERISTICS over COMMERCIAL and INDUSTRIAL operating ranges Software Halt Cycle (20 MHz and 25 MHz)

				Prelin	ninary		
		Parameter	20 MHz		25 MHz		
No.	Symbol	Description	Min	Max	Min	Max	Unit
Genera	al Timing R	esponses					
3	t <sub>CHSV</sub>	Status Active Delay	0	25	0	20	ns
4	t <sub>CLSH</sub>	Status Inactive Delay	0	25	0	20	ns
5	t <sub>CLAV</sub>	AD Address Invalid Delay and BHE	0	25	0	20	ns
9	t <sub>CHLH</sub>	ALE Active Delay		25		20	ns
10	t <sub>LHLL</sub>	ALE Width	$t_{CLCL} - 10 = 40$		$t_{CLCL} - 10 = 30$		ns
11	t <sub>CHLL</sub>	ALE Inactive Delay		25		20	ns
19	t <sub>DXDL</sub>	DEN Inactive to DT/R Low <sup>(a)</sup>	0		0		ns
22	t <sub>CHCTV</sub>	Control Active Delay 2 <sup>(b)</sup>	0	25	0	20	ns
68	t <sub>CHAV</sub>	CLKOUTA High to A Address Invalid	0	25	0	20	ns

#### Notes:

All timing parameters are measured at 1.5 V with 50 pF loading on CLKOUTA, unless otherwise noted. All output test conditions are with  $C_L$ =50 pF. For switching tests,  $V_{IL}$ =0.45 V and  $V_{IH}$ =2.4 V, except at X1 where  $V_{IH}$ = $V_{CC}$ -0.5 V.

- a Testing is performed with equal loading on referenced pins.
- b This parameter applies to the DEN signal.

## SWITCHING CHARACTERISTICS over COMMERCIAL operating ranges

# Software Halt Cycle (33 MHz and 40 MHz)

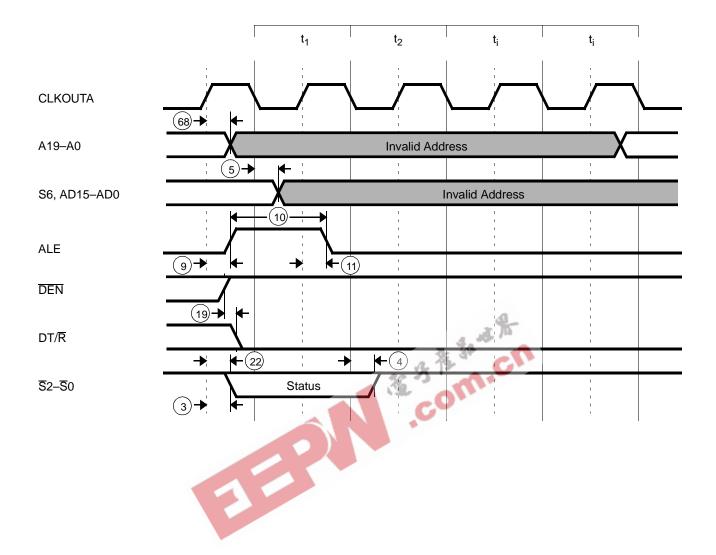
				Prelin	ninary		1
		Parameter	33 MHz		40 MHz		1
No.	Symbol	Description	Min	Max	Min	Max	Unit
Genera	al Timing Re	sponses					
3	t <sub>CHSV</sub>	Status Active Delay	0	15	0	12	ns
4	t <sub>CLSH</sub>	Status Inactive Delay	0	15	0	12	ns
5	t <sub>CLAV</sub>	AD Address Invalid Delay and BHE	0	15	0	12	ns
9	t <sub>CHLH</sub>	ALE Active Delay		15		12	ns
10	t <sub>LHLL</sub>	ALE Width	$t_{CLCL}$ -10=20		t <sub>CLCL</sub> -5=20		ns
11	t <sub>CHLL</sub>	ALE Inactive Delay		15		12	ns
19	t <sub>DXDL</sub>	DEN Inactive to DT/R Low <sup>(a)</sup>	0		0		ns
22	t <sub>CHCTV</sub>	Control Active Delay 2 <sup>(b)</sup>	0	15	0	12	ns
68	t <sub>CHAV</sub>	CLKOUTA High to A Address Invalid	0	15	0	10	ns

#### Notes:

All timing parameters are measured at 1.5 V with 50 pF loading on CLKOUTA, unless otherwise noted. All output test conditions are with  $C_L$  = 50 pF. For switching tests,  $V_{IL}$  = 0.45 V and  $V_{IH}$  = 2.4 V, except at X1 where  $V_{IH}$  =  $V_{CC}$  = 0.5 V.

- a Testing is performed with equal loading on referenced pins.
- b This parameter applies to the DEN signal.

### SOFTWARE HALT CYCLE WAVEFORMS



### SWITCHING CHARACTERISTICS over COMMERCIAL and INDUSTRIAL operating ranges Clock (20 MHz and 25 MHz)

				Prelin	ninary		
		Parameter	20 MHz		25 MHz		
No.	Symbol	Description	Min	Max	Min	Max	Unit
CLKIN	Requireme	ents					
36	t <sub>CKIN</sub>	X1 Period <sup>(a)</sup>	50	60	40	60	ns
37	t <sub>CLCK</sub>	X1 Low Time (1.5 V) <sup>(a)</sup>	15		15		ns
38	t <sub>CHCK</sub>	X1 High Time (1.5 V) <sup>(a)</sup>	15		15		ns
39	t <sub>CKHL</sub>	X1 Fall Time (3.5 to 1.0 V) <sup>(a)</sup>		5		5	ns
40	t <sub>CKLH</sub>	X1 Rise Time (1.0 to 3.5 V) <sup>(a)</sup>		5		5	ns
CLKOU	UT Timing				·		
42	t <sub>CLCL</sub>	CLKOUTA Period	50		40		ns
43	t <sub>CLCH</sub>	CLKOUTA Low Time (C <sub>L</sub> =50 pF)	0.5t <sub>CLCL</sub> -2=23		0.5t <sub>CLCL</sub> -2=18		ns
44	t <sub>CHCL</sub>	CLKOUTA High Time (C <sub>L</sub> =50 pF)	0.5t <sub>CLCL</sub> -2=23		0.5t <sub>CLCL</sub> -2=18		ns
45	t <sub>CH1CH2</sub>	CLKOUTA Rise Time (1.0 to 3.5 V)		3		3	ns
46	t <sub>CL2CL1</sub>	CLKOUTA Fall Time (3.5 to 1.0 V)		3		3	ns
61	t <sub>LOCK</sub>	Maximum PLL Lock Time		1		1	ms
69	t <sub>CICOA</sub>	X1 to CLKOUTA Skew		15		15	ns
70	t <sub>CICOB</sub>	X1 to CLKOUTB Skew	A.	25	C	25	ns

#### Notes:

All timing parameters are measured at 1.5 V with 50 pF loading on CLKOUTA, unless otherwise noted. All output test conditions are with  $C_L$  = 50 pF. For switching tests,  $V_{IL}$  = 0.45 V and  $V_{IH}$  = 2.4 V, except at X1 where  $V_{IH}$  =  $V_{CC}$  – 0.5 V.

a The specifications for CLKIN are applicable to the normal PLL and CLKDIV2 modes.

The PLL should be used for operations from 16.667 MHz to 40 MHz. For operations below 16.667 MHz, the CLKDIV2 mode should be used.

Because the CLKDIV2 input frequency is two times the system frequency, the specifications for twice the frequency should be used for CLKDIV2 mode. For example, use the 20 MHz CLKIN specifications for 10 MHz operation.

### SWITCHING CHARACTERISTICS over Commercial operating ranges

### Clock (33 MHz and 40 MHz)

			Preli	minary		
	Parameter	33 MHz		40 MHz		
Symbol	Description	Min	Max	Min	Max	Unit
Requireme	nts					
t <sub>CKIN</sub>	X1 Period <sup>(a)</sup>	30	60	25	60	ns
t <sub>CLCK</sub>	X1 Low Time (1.5 V) <sup>(a)</sup>	10		7.5		ns
	X1 High Time (1.5 V) <sup>(a)</sup>	10		7.5		ns
t <sub>CKHL</sub>	X1 Fall Time (3.5 to 1.0 V) <sup>(a)</sup>		5		5	ns
t <sub>CKLH</sub>	X1 Rise Time (1.0 to 3.5 V) <sup>(a)</sup>		5		5	ns
JT Timing		·				
t <sub>CLCL</sub>	CLKOUTA Period	30		25		ns
t <sub>CLCH</sub>	CLKOUTA Low Time (C <sub>L</sub> =50 pF)	0.5t <sub>CLCL</sub> -1.5 =13.5		0.5t <sub>CLCL</sub> -1.25 =11.25		ns
t <sub>CHCL</sub>	CLKOUTA High Time (C <sub>L</sub> =50 pF)	0.5t <sub>CLCL</sub> -1.5 =13.5		0.5t <sub>CLCL</sub> -1.25 = 11.25		ns
t <sub>CH1CH2</sub>	CLKOUTA Rise Time (1.0 to 3.5 V)		3		3	ns
t <sub>CL2CL1</sub>	CLKOUTA Fall Time (3.5 to 1.0 V)		3		3	ns
t <sub>LOCK</sub>	Maximum PLL Lock Time		1		1	ms
t <sub>CICOA</sub>	X1 to CLKOUTA Skew		15	A	15	ns
t <sub>CICOB</sub>	X1 to CLKOUTB Skew		25	T	25	ns
	tckin           tckin           tclck           tchck           tckhL           tckLH           JT Timing           tclch           tclch           tclch           tclch           tclcl           tclch           tclch           tclch           tclch           tclcl           tclcl           tclcl           tclcl           tclcl           tclcl           tclcok           tclcok           tclcok           tclcok           tclcok	SymbolDescriptionRequirements $t_{CKIN}$ X1 Period <sup>(a)</sup> $t_{CLCK}$ X1 Low Time $(1.5 V)^{(a)}$ $t_{CHCK}$ X1 High Time $(1.5 V)^{(a)}$ $t_{CHCK}$ X1 Fall Time $(3.5 to 1.0 V)^{(a)}$ $t_{CKHL}$ X1 Fall Time $(3.5 to 1.0 V)^{(a)}$ $t_{CKLH}$ X1 Fall Time $(1.0 to 3.5 V)^{(a)}$ JT Timing $t_{CLCL}$ CLKOUTA Period $t_{CLCH}$ CLKOUTA Low Time $(C_L=50 pF)$ $t_{CH1CH2}$ CLKOUTA High Time $(1.0 to 3.5 V)$ $t_{CL2CL1}$ CLKOUTA Rise Time $(1.0 to 3.5 V)$ $t_{CL2CL1}$ CLKOUTA Fall Time $(3.5 to 1.0 V)$ $t_{LOCK}$ Maximum PLL Lock Time $t_{CICOA}$ X1 to CLKOUTA Skew	SymbolDescriptionMinRequirements $t_{CKIN}$ X1 Period <sup>(a)</sup> 30 $t_{CLCK}$ X1 Low Time $(1.5 V)^{(a)}$ 10 $t_{CLCK}$ X1 Low Time $(1.5 V)^{(a)}$ 10 $t_{CHCK}$ X1 High Time $(1.5 V)^{(a)}$ 10 $t_{CHCK}$ X1 Fall Time $(3.5 to 1.0 V)^{(a)}$ 10 $t_{CKHL}$ X1 Fall Time $(3.5 to 1.0 V)^{(a)}$ 10 $t_{CKLH}$ X1 Rise Time $(1.0 to 3.5 V)^{(a)}$ 10JT Timing $t_{CLCL}$ CLKOUTA Period30 $t_{CLCH}$ CLKOUTA Low Time $(C_L=50 \text{ pF})$ $0.5t_{CLCL}-1.5 = 13.5$ $t_{CHCL}$ CLKOUTA High Time $(C_L=50 \text{ pF})$ $0.5t_{CLCL}-1.5 = 13.5$ $t_{CH1CH2}$ CLKOUTA Rise Time $(1.0 to 3.5 V)$ $t_{CL2CL1}$ CLKOUTA Fall Time $(3.5 to 1.0 V)$ $t_{LOCK}$ Maximum PLL Lock Time $t_{CICOA}$ X1 to CLKOUTA Skewt_{CICOA}X1 to CLKOUTA Skew	Parameter         33 MHz           Symbol         Description         Min         Max           Requirements         X1 Period <sup>(a)</sup> 30         60 $t_{CKIN}$ X1 Period <sup>(a)</sup> 30         60 $t_{CLCK}$ X1 Low Time $(1.5 V)^{(a)}$ 10 $(1.5 V)^{(a)}$ 10 $t_{CHCK}$ X1 High Time $(1.5 V)^{(a)}$ 10 $(1.5 V)^{(a)}$ $(5 V)$	Symbol         Description         Min         Max         Min           Requirements $t_{CKIN}$ X1 Period <sup>(a)</sup> 30         60         25 $t_{CLCK}$ X1 Low Time (1.5 V) <sup>(a)</sup> 10         7.5 $t_{CLCK}$ X1 High Time (1.5 V) <sup>(a)</sup> 10         7.5 $t_{CHCK}$ X1 High Time (3.5 to 1.0 V) <sup>(a)</sup> 10         7.5 $t_{CKHL}$ X1 Fall Time (3.5 to 1.0 V) <sup>(a)</sup> 5 $JT$ $t_{CKLH}$ X1 Rise Time (1.0 to 3.5 V) <sup>(a)</sup> 5 $JT$ $JT$ $JT$ $t_{CLCL}$ CLKOUTA Period         30         25 $0.5t_{CLCL}-1.25 = 11.25$ $0.5t_{CLCL}-1.25 = 11.25$ $t_{CLCH}$ CLKOUTA Low Time (CL=50 pF) $0.5t_{CLCL}-1.5 = 13.5$ $0.5t_{CLCL}-1.25 = 11.25$ $t_{CHCL}$ CLKOUTA High Time (3.5 to 1.0 V)         3 $3$ $t_{CL2CL1}$ $CLKOUTA$ Fall Time (3.5 to 1.0 V)         3 $t_{CL2CL1}$ CLKOUTA Fall Time (3.5 to 1.0 V)         3 $1$ $t_{CL2CL1}$ $t_{CL2CL1}$ CLKOUTA Fall Time (3.5 to 1.0 V)         3 $1$ $t_{CL2CL1}$ $t_{CL2CL1}$ CLKOUTA Skew         15	Parameter         33 MHz         40 MHz           Symbol         Description         Min         Max         Min         Max           Requirements $t_{CKIN}$ X1 Period <sup>(a)</sup> 30         60         25         60 $t_{CKIN}$ X1 Period <sup>(a)</sup> 30         60         25         60 $t_{CLCK}$ X1 Low Time (1.5 V) <sup>(a)</sup> 10         7.5         60 $t_{CHCK}$ X1 High Time (1.5 V) <sup>(a)</sup> 10         7.5         60 $t_{CHCK}$ X1 Fall Time (3.5 to 1.0 V) <sup>(a)</sup> 10         7.5         5 $t_{CKHL}$ X1 Fall Time (3.5 to 1.0 V) <sup>(a)</sup> 5         5         5 $t_{CLCL}$ CLKOUTA Period         30         25         5 $t_{CLCL}$ CLKOUTA Low Time (CL=50 pF) $0.5t_{CLCL}-1.5 = 13.5$ $0.5t_{CLCL}-1.25 = 11.25$ 6 $t_{CHCL}$ CLKOUTA High Time (3.5 to 1.0 V)         3         3         3         3 $t_{CLCL}$ CLKOUTA Rise Time (1.0 to 3.5 V)         3         3         3         3 $t_{CLCL}$ CLKOUTA High Time (3.5 to 1.0 V)         3         3         3

#### Notes:

All timing parameters are measured at 1.5 V with 50 pF loading on CLKOUTA, unless otherwise noted. All output test conditions are with  $C_L$  = 50 pF. For switching tests,  $V_{IL}$  = 0.45 V and  $V_{IH}$  = 2.4 V, except at X1 where  $V_{IH}$  =  $V_{CC}$  = 0.5 V.

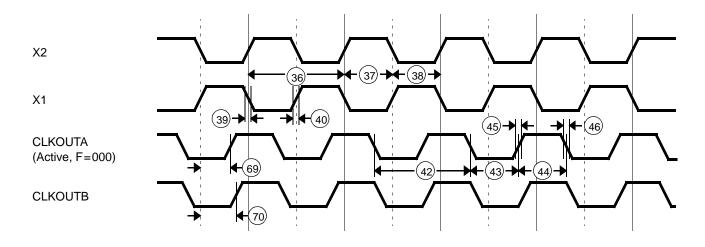
31

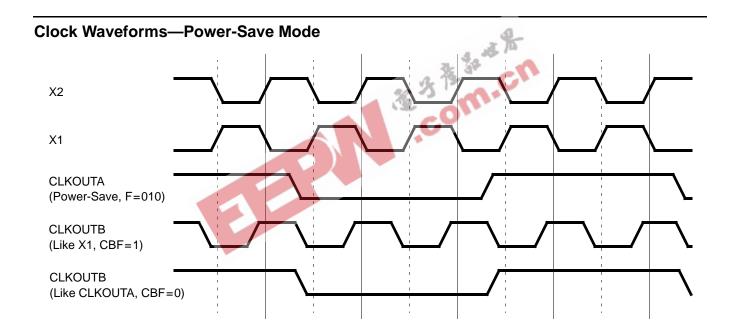
a The specifications for CLKIN are applicable to the normal PLL and CLKDIV2 modes.

The PLL should be used for operations from 16.667 MHz to 40 MHz. For operations below 16.667 MHz, the CLKDIV2 mode should be used.

Because the CLKDIV2 input frequency is two times the system frequency, the specifications for twice the frequency should used for CLKDIV2 mode. For example, use the 20 MHz CLKIN specifications for 10 MHz operation.

### CLOCK WAVEFORMS Clock Waveforms—Active Mode





### SWITCHING CHARACTERISTICS over COMMERCIAL and INDUSTRIAL operating ranges Ready and Peripheral (20 MHz and 25 MHz)

			Prelimi	nary	Prelimi	nary	
		Parameter	20 M	Hz	25 MI	Ηz	
No.	Symbol	Description	Min	Max	Min	Max	Unit
Ready	and Peripher	al Timing Requirements					
47	t <sub>SRYCL</sub>	SRDY Transition Setup Time <sup>(a)</sup>	10		10		ns
48	t <sub>CLSRY</sub>	SRDY Transition Hold Time <sup>(a)</sup>	3		3		ns
49	t <sub>ARYCH</sub>	ARDY Resolution Transition Setup Time <sup>(b)</sup>	10		10		ns
50	t <sub>CLARX</sub>	ARDY Active Hold Time <sup>(a)</sup>	4		4		ns
51	t <sub>ARYCHL</sub>	ARDY Inactive Holding Time	6		6		ns
52	t <sub>ARYLCL</sub>	ARDY Setup Time <sup>(a)</sup>	15		15		ns
53	t <sub>INVCH</sub>	Peripheral Setup Time <sup>(b)</sup>	10		10		ns
54	t <sub>INVCL</sub>	DRQ Setup Time <sup>(b)</sup>	10		10		ns
Periphe	eral Timing R	esponses					
55	t <sub>CLTMV</sub>	Timer Output Delay		25		20	ns

Notes:

All timing parameters are measured at 1.5 V with 50 pF loading on CLKOUTA, unless otherwise noted. All output test conditions are with  $C_L$  =50 pF. For switching tests,  $V_{IL}$  = 0.45 V and  $V_{IH}$  = 2.4 V, except at X1 where  $V_{IH}$  =  $V_{CC}$  - 0.5 V. t on the

This timing must be met to guarantee proper operation. а

This timing must be met to guarantee recognition at the clock edge. b

#### SWITCHING CHARACTERISTICS over COMMERCIAL operating ranges

### Ready and Peripheral (33 MHz and 40 MHz)

				Prelim	inary		
		Parameter	33 MI	Ηz	40 MH	z	
No.	Symbol	Description	Min	Max	Min	Max	Unit
Ready a	and Peripher	al Timing Requirements					
47	t <sub>SRYCL</sub>	SRDY Transition Setup Time <sup>(a)</sup>	8		5		ns
48	t <sub>CLSRY</sub>	SRDY Transition Hold Time <sup>(a)</sup>	3		2		ns
49	t <sub>ARYCH</sub>	ARDY Resolution Transition Setup Time <sup>(b)</sup>	8		5		ns
50	t <sub>CLARX</sub>	ARDY Active Hold Time <sup>(a)</sup>	4		3		ns
51	t <sub>ARYCHL</sub>	ARDY Inactive Holding Time	6		5		ns
52	t <sub>ARYLCL</sub>	ARDY Setup Time <sup>(a)</sup>	10		5		ns
53	t <sub>INVCH</sub>	Peripheral Setup Time <sup>(b)</sup>	8		5		ns
54	t <sub>INVCL</sub>	DRQ Setup Time <sup>(b)</sup>	8		5		ns
Periphe	eral Timing R	esponses					
55	t <sub>CLTMV</sub>	Timer Output Delay		15		12	ns

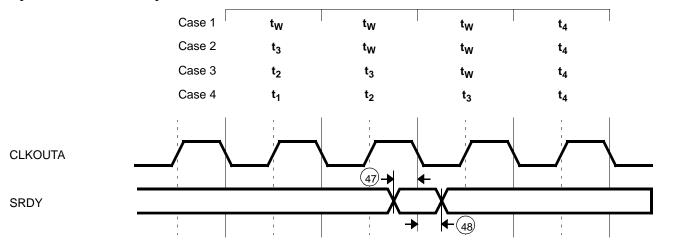
#### Notes:

All timing parameters are measured at 1.5 V with 50 pF loading on CLKOUTA, unless otherwise noted. All output test conditions are with  $C_I = 50$  pF. For switching tests,  $V_{II} = 0.45$  V and  $V_{IH} = 2.4$  V, except at X1 where  $V_{IH} = V_{CC} - 0.5$  V.

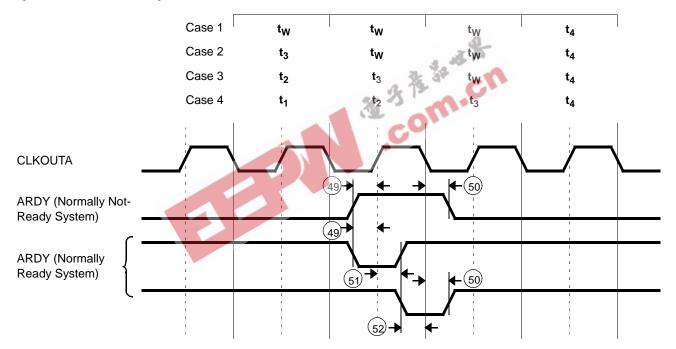
This timing must be met to guarantee proper operation. а

This timing must be met to guarantee recognition at the clock edge. b

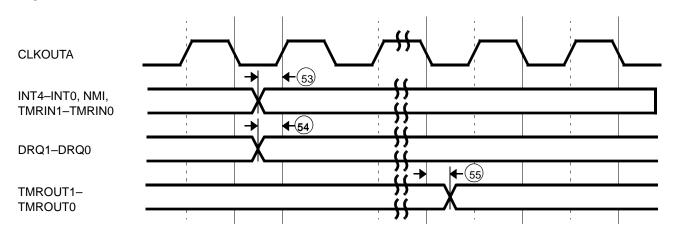
### SYNCHRONOUS, ASYNCHRONOUS, and PERIPHERAL WAVEFORMS Synchronous Ready Waveforms



### **Asynchronous Ready Waveforms**



### **Peripheral Waveforms**



### SWITCHING CHARACTERISTICS over COMMERCIAL and INDUSTRIAL operating ranges Reset and Bus Hold (20 MHz and 25 MHz)

				Prelim	inary		
		Parameter	20 M	Hz	25 M	Hz	
No.	Symbol	Description	Min	Max	Min	Max	Unit
Reset a	and Bus Hol	d Timing Requirements					
5	t <sub>CLAV</sub>	AD Address Valid Delay and BHE	0	25	0	20	ns
15	t <sub>CLAZ</sub>	AD Address Float Delay	0	25	0	20	ns
57	t <sub>RESIN</sub>	RES Setup Time	10		10		ns
58	t <sub>HVCL</sub>	HOLD Setup <sup>(a)</sup>	10		10		ns
Reset a	and Bus Hol	d Timing Responses					
62	t <sub>CLHAV</sub>	HLDA Valid Delay	0	25	0	20	ns
63	t <sub>CHCZ</sub>	Command Lines Float Delay		25		20	ns
64	t <sub>CHCV</sub>	Command Lines Valid Delay (after Float)		25		20	ns

# SWITCHING CHARACTERISTICS over COMMERCIAL operating ranges

### Reset and Bus Hold (33 MHz and 40 MHz)

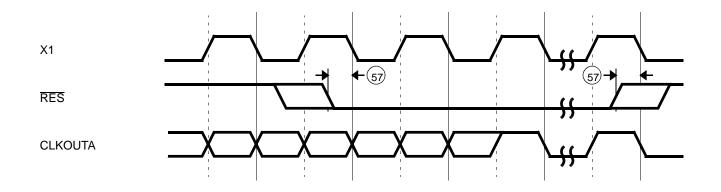
				Prelin	ninary		
		Parameter	33 MH	z P	40 MI	Hz	
No.	Symbol	Description	Min	Max	Min	Max	Unit
Reset	and Bus Hol	d Timing Requirements	3	0			
5	t <sub>CLAV</sub>	AD Address Valid Delay and BHE 🛛 🛁 🚿	0	15	0	12	ns
15	t <sub>CLAZ</sub>	AD Address Float Delay	0	15	0	12	ns
57	t <sub>RESIN</sub>	RES Setup Time	8		5		ns
58	t <sub>HVCL</sub>	HOLD Setup <sup>(a)</sup>	8		5		ns
Reset	and Bus Hol	d Timing Responses					
62	t <sub>CLHAV</sub>	HLDA Valid Delay	0	15	0	12	ns
63	t <sub>CHCZ</sub>	Command Lines Float Delay		15		12	ns
64	t <sub>CHCV</sub>	Command Lines Valid Delay (after Float)		15		12	ns

### Notes:

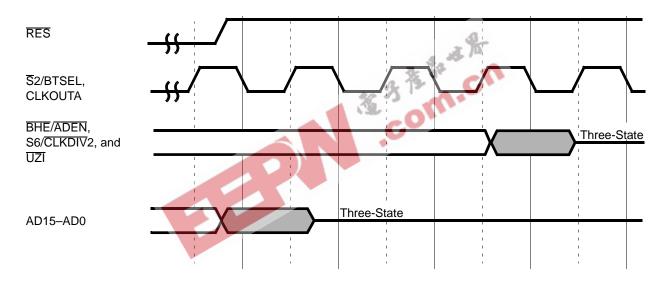
All timing parameters are measured at 1.5 V with 50 pF loading on CLKOUTA, unless otherwise noted. All output test conditions are with  $C_L$  = 50 pF. For switching tests,  $V_{IL}$  = 0.45 V and  $V_{IH}$  = 2.4 V, except at X1 where  $V_{IH}$  =  $V_{CC}$  = 0.5 V.

a This timing must be met to guarantee recognition at the next clock.

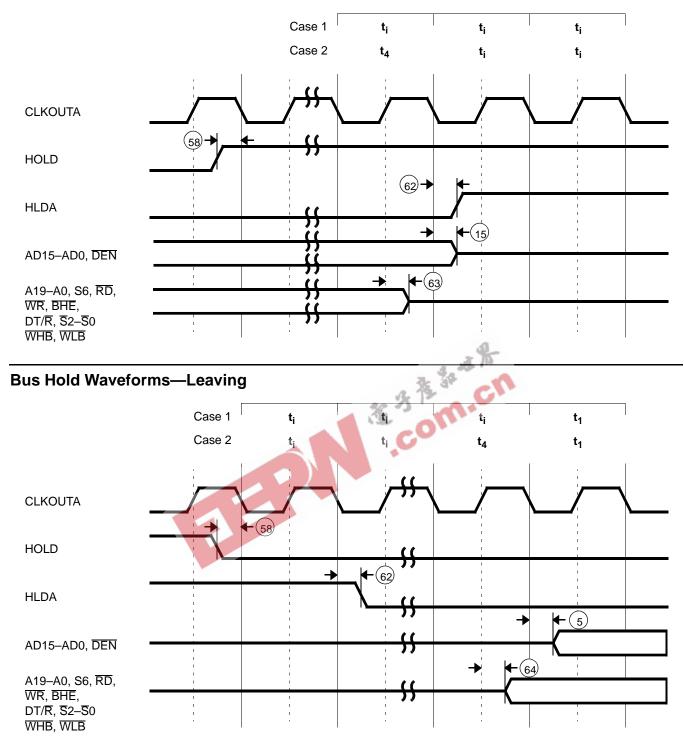
### RESET and BUS HOLD WAVEFORMS Reset Waveforms



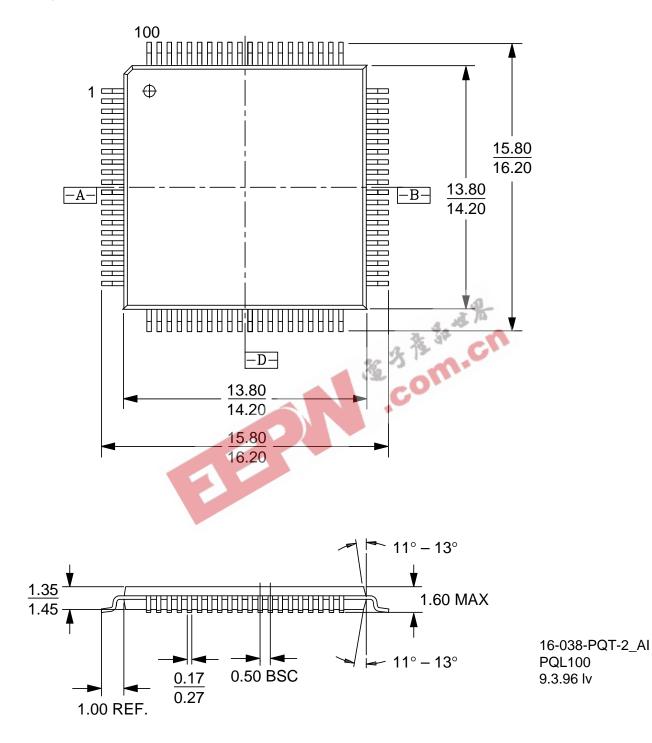
### Signals Related to Reset Waveforms



### **Bus Hold Waveforms—Entering**



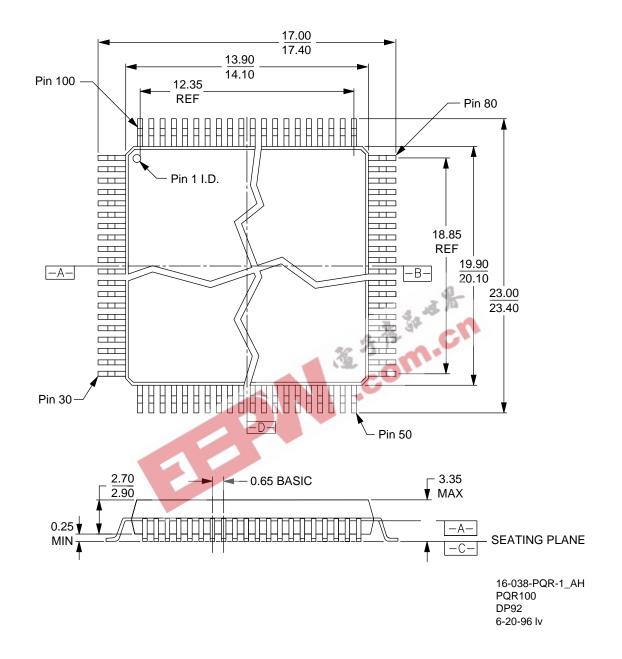
### TQFP PHYSICAL DIMENSIONS PQL 100, Trimmed and Formed Thin Quad Flat Pack



#### Notes:

- 1. All measurements are in millimeters, unless otherwise noted.
- 2. Not to scale; for reference only.

### PQFP PHYSICAL DIMENSIONS PQR 100, Trimmed and Formed Plastic Quad Flat Pack



#### Notes:

- 1. All measurements are in millimeters, unless otherwise noted.
- 2. Not to scale; for reference only.

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